

MITSUBISHI

PROGRAMMABLE CONTROLLER

MELSEC-K

Instruction Manual

type MELSEC-K0J2P

 MITSUBISHI
ELECTRIC

CONTENTS

1. GENERAL DESCRIPTION	3 ~ 4
-------------------------------------	-------

2. EQUIPMENT LIST	5 ~ 10
--------------------------------	--------

2.1 Equipment List	6
2.2 Peripheral Equipment List	8

3. SPECIFICATION	11 ~ 36
-------------------------------	---------

3.1 Common Specifications	12
3.2 Performance Specifications	13
3.2.1 CPU performance specifications	13
3.2.2 Optical data link specifications	19
3.2.3 Memory specifications	21
3.2.4 I/O specifications	22
3.2.5 Terminal arrangement	27
3.2.6 Extension power supply unit specifications	30
3.2.7 Extension unit specifications	31
3.2.8 Extension cable specifications	31
3.2.9 Switch unit specifications	32
3.2.10 Battery specifications	32
3.2.11 Fuse specifications	32
3.3 External Dimensions	33

4. SYSTEM CONFIGURATION	38 ~ 48
--------------------------------------	---------

4.1 Independent System	38
4.1.1 Extension system by use of type KOJ2-E56 extension unit	38
4.1.2 Extension System by use of Type KOJ1-E32, E56 and KOJ2-E56 extension units	39
4.2 Optical Data Link Unit	41
4.2.1 System configuration	41
4.2.2 Link I/O numbers	43

5. HANDLING	49 ~ 72
--------------------------	---------

5.1 Nomenclature and Explanation	50
5.1.1 Basic unit	50
5.1.2 Extension units (KOJ2-E56, KOJ1-E32)	52
5.2 Loading	55
5.2.1 Loading procedure	55
5.2.2 Memory loading and setting	56
5.2.3 Setting of extension unit number	57
5.2.4 Loading of extension power supply unit	58
5.2.5 Loading of battery	58

5.2.6	Connection of extension cable	59
5.2.7	Connection of optical cable	60
5.2.8	Mounting to panel	61
5.2.9	Wiring	62
5.2.10	Troubles and corrective actions of I/O circuits	65
5.3	Operating Procedures	69
5.3.1	Test run flow chart	69
5.3.2	Daily operation	70
5.3.3	Error code list	72

6. MAINTENANCE AND INSPECTION 73 ~ 86

6

6.1	Daily Inspection	74
6.2	Periodic Inspection	75
6.3	Troubleshooting	76
6.3.1	Troubleshooting flow chart	76
6.3.2	Flow chart used when program cannot be written	77
6.3.3	"POWER" LED is not lit	78
6.3.4	Flow chart used when "RUN" LED is not lit	80
6.3.5	Flow chart used when "RUN" LED flickers	81
6.3.6	Flow chart for I/O section	82
6.4	Change of Battery	83
6.4.1	Life of battery	83
6.4.2	Battery changing procedure	84
6.5	Change of Fuse	85

7. INSTRUCTIONS FOR SPECIFICATIONS 87 ~ 92

7

7.1	Watch DOG Timer (WDT)	88
7.2	Accuracy of Timer	89
7.3	Maximum Counting Speed of Counter	90
7.4	Latch Function	91

8. HANDLING INSTRUCTIONS 93 ~ 94

8

8.1	Programmable Controller Unit	94
8.2	Memory	94
8.3	Battery	94
8.4	Optical Fiber Cable	94

APPENDIX 95 ~ 106

1.	COMPARISON BETWEEN K0J1, K0J1H and K0J2, K0J2P	96
2.	PROCESS TIME	99
3.	CONTACT LIFE OF RELAY CONTACT OUTPUT	103
4.	USAGE OF EXTERNAL FAILURE MONITOR UNIT (K0J1-EX0N)	104

1. GENERAL DESCRIPTION

1. GENERAL DESCRIPTION 3 ~ 4

1. GENERAL DESCRIPTION

Like the KOJ2, the KOJ2P is an A4-size, highly economical, high-function and small-scaled programmable controller and has the following features:

- (1) The number of inputs/outputs can be extended from 56 points of the basic unit to a maximum of 280 points.
- (2) The maximum program capacity is 4096 steps. 1024 or 4096 steps can be selected for the RAM, and 2048 or 4096 steps can be selected for the ROM.
- (3) In addition to the sequence instructions (18 types) and data instructions (8 types), the KOJ2 is provided with 19 types of application instructions including the addition, subtraction, multiplication and division of BCD six digits.
- (4) Using the K3 or KGPC as a master channel (master programmable controller), the KOJ2P can constitute a programmable controller system which consists of a maximum of 32 channels of local programmable controllers and remote I/O units through connection by optical fiber cables, and therefore, is applicable to a wide range of system control from small to large scale.

2. EQUIPMENT LIST

2.	EQUIPMENT LIST	5 ~ 10
2.1	Equipment List	6
2.2	Peripheral Equipment List	8

2. EQUIPMENT LIST

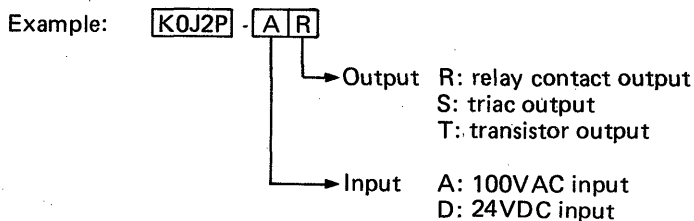
2. EQUIPMENT LIST

2.1 Equipment List

Unit Division	Description	Type Name		Remarks
Basic unit	Basic unit	K0J2P-AR	Input: 32 points Output: 24 points Total: 56 points	*1 Input A: 100VAC, 10mA Photocoupler insulation D: 24VDC, 10mA Photocoupler insulation Output R: Relay contact output 200VAC/24VDC, 2A S: Triac output 200VAC, 1A T: Transistor output 24VDC, 0.5A All points indicated by LEDs Terminal block connection
		K0J2P-AS		
		K0J2P-DR		
		K0J2P-DS		
		K0J2P-DT		
Extension unit	32-point extension unit (with extension cable K0J61CBL) *4	K0J1-E32AR	Input: 16 points Output: 16 points Total: 32 points	
		K0J1-E32AS		
		K0J1-E32DR		
		K0J1-E32DS		
		K0J1-E32DT		
	56-point extension unit (with extension cable K0J-61CBL)	K0J1-E56AR	Input: 32 points Output: 24 points Total: 56 points	
		K0J1-E56AS		
		K0J1-E56DR		
		K0J1-E56DS		
		K0J1-E56DT		
		K0J2-E56AR		
		K0J2-E56AS		
		K0J2-E56DR		
		K0J2-E56DS		
		K0J2-E56DT		
Memory	EP-ROM	2KROM	For 2K steps	Select required memory and load it into socket. (RAM for 1K step is standard-equipped.)
		4KROM	For 4K steps	
	IC-RAM	4KRAM	For 4K steps	
Extension power supply	Power supply for extension unit	K0J1-PW	100VAC input, 24VDC 1A output *5	
Extension cable	Extension cable used between KOJs	K0J-61CBL	500mm length	100VAC input, 24VDC 1A output *5
		K0J-61CBL2	1000mm length	
Fuse *2	For power supply	MN51NR	Encased in glass tube, 250V, 2A	
	For triac (S) output	MP75	Plug type, 7.5A	
Battery *3	Lithium battery	K6BAT	For IC-RAM, standard-equipped for basic unit, commonly used for K0, 1, 2 and 3.	
Switch	Switch unit	K0SW	For simulation input, 16 points/unit	

Table 2.1 List of Equipment

*1: The last two letters of type names of basic units and extension units indicate inputs/outputs.



*2: A fuse is provided for each unit as spare.

*3: If the memory is ROM, a battery is required for back up for power failure.

*4: When the 32-point extension unit is used, the system configuration is restricted. (See Section 4.1.2.)

*5: The extension power supply can be loaded only to Type E56 extension unit.

2. EQUIPMENT LIST

MELSEC-K

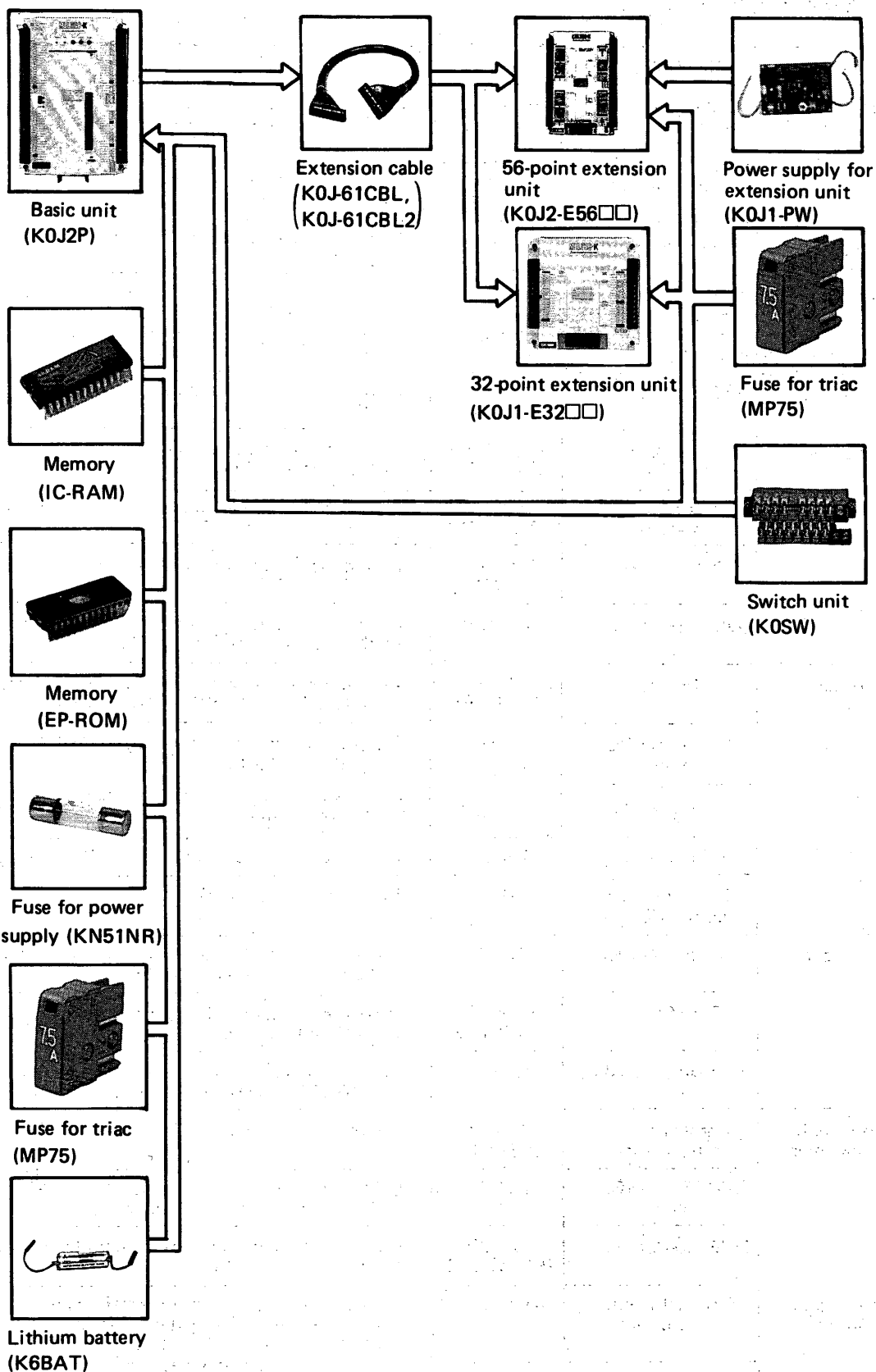


Fig. 2.1 Equipment

2. EQUIPMENT LIST

MELSEC-K

2.2 Peripheral Equipment List

Unit	Description	Type	Remarks
Programming unit with CRT	Graphic programming panel GPP	K7GPP (K7GPPE)	Programming unit with CRT, used together with K6GPF (K6GPFE) and K63CBL.
		K8GPP (K8GPPE)	
	GPP interface unit	K6GPF (K6GPFE)	Interface used for connection of main unit CPU and GPP or K6PSB.
	GPF cable	K63CBL	Cable for connection of K6GPF (K6GPFE) and GPP, length 3m
Support base	Peripheral equipment support base	K6PSB	Two peripheral units can be loaded, used together with K6GPF (K6GPFE) and K63CBL.
Programming unit	Programming unit	K7PU (K7PUE)	Program I/O unit loaded into main unit CPU or K6PSB
P-ROM writer	P-ROM writer unit	K6WU (K6WUE)	Loaded into main unit CPU, GPP, or K6PSB, for 2KROM
Audio cassette	Audio cassette interface	K6MTF (K6MTFE)	Interface for commercially available audio cassette, with dedicated cable.
Data cassette	Data cassette interface	K7MTF (K7MTFE)	Interface for connection of main unit CPU, GPP, or K6PSB and K7MT (K7MTE)
	Data cassette	K7MT (K7MTE)	Data cassette for industrial use. Tape for this unit is CT-300 by TEAC and is commercially available.
	Data cassette cable	K63CBL	Cable for connection of K7MT (K7MTE) and K7MTF (K7MTFE), same as GPF cable.
Printer	Printer	K6PR (K6PRE)	For circuit diagram of program and hard copy of list, used together with K6PRF (K7PRFE) and K65CBL.
	Printer interface unit	K6PRF (K7PRFE)	Interface of connection of K6PR (K6PRE) and main unit, GPP, or K6PSB.
	Printer cable	K65CBL	Cable for connection of K6PR (K6PRE) and K6PRF (K7PRFE), length 3m.
	Printer paper	K6PR-Y	9-inch paper, available in units of 2000 sheets.
	Ink ribbon for K6PR (K6PRE)	K6PR-R	Replacement ink ribbon
Handy recorder	Handy recorder	K6PRT	Equipped with P-ROM writer, printer interface, and audio cassette interface functions.
	HGP interface unit	K6HGPF (K6HGPF E)	Interface for connection of main unit CPU and K6PRT or K6HGP (K6HGPE)
	K6HGP (K6HGPE) cable	K70CBL	Cable for connection of K6HGP (K6HGPE) or K6PRT and K6HGPF (K6HGPF E), length 2m.
Handy graphic programmer	Handy graphic programmer	K6HGP (K6HGPE)	Handy graphic programming unit with LCD.
	K6HGP (K6HGPE) cable	K70CBL	Cable for connection of K6HGP (K6HGPE) or K6PRT and K6HGPF (K6HGPF E), length 2 m.
	HGP interface unit	K6HGPF (K6HGPF E)	Interface for connection of main unit CPU and K6PRT or K6HGP (K6HGPE)
External failure monitor*	External failure monitor unit	K0J2-EX0N	Capable of displaying external failure number in decimal three digits. Number is displayed by connecting K6FD-J.
	External failure number display unit	K6FD-J	Connected with K0J2-EX0N, capable of displaying failure numbers of 100 ~ 999.

Table 2.2 Peripheral Equipment

*: External failure monitors (K0J2-EX0N and K6FD-J) will be available soon.

2. EQUIPMENT LIST

MELSEC-K

2

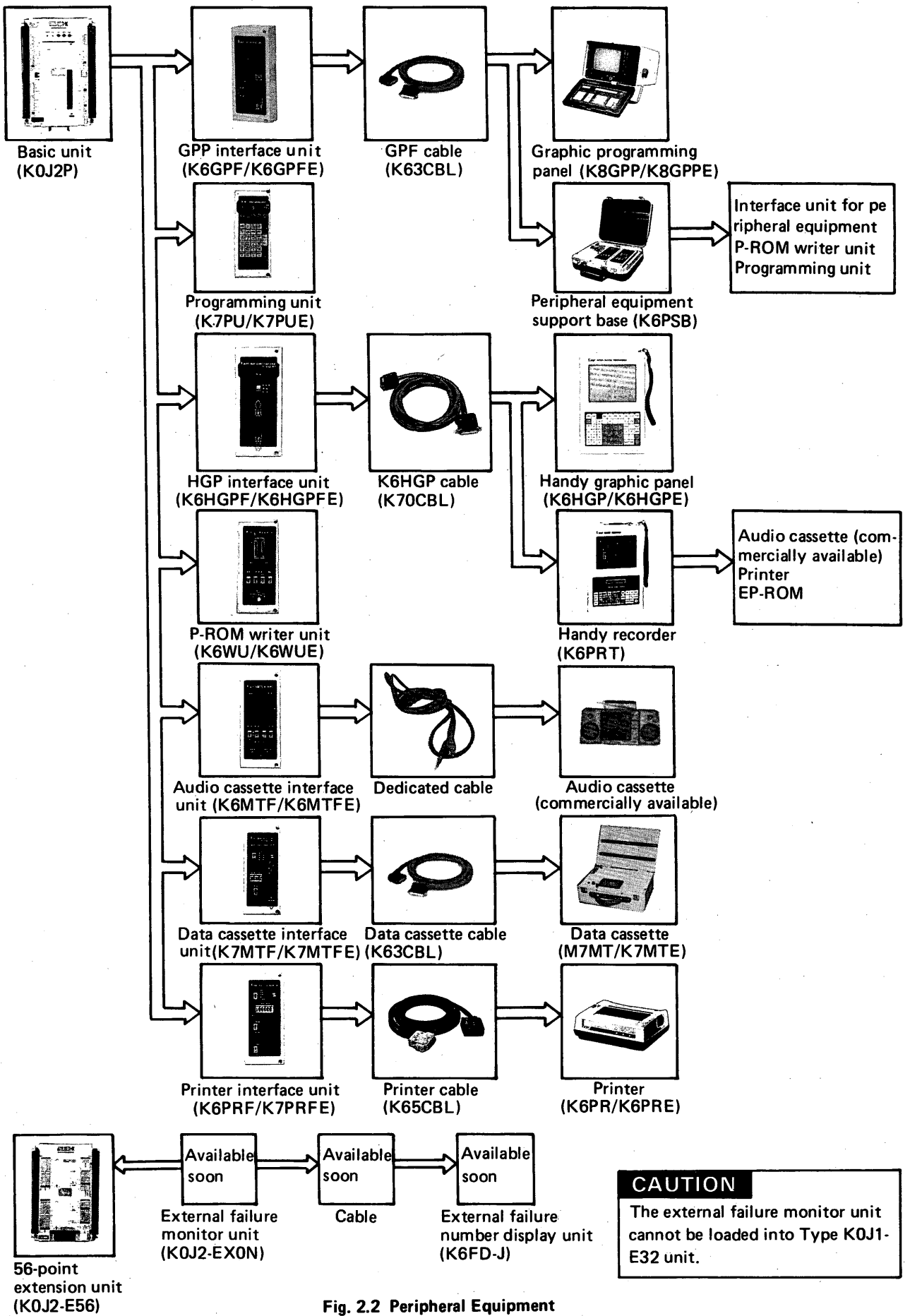


Fig. 2.2 Peripheral Equipment

MEMO

A series of horizontal dashed lines for writing.

3. SPECIFICATIONS

- 3. SPECIFICATIONS 11 ~ 36
 - 3.1 Common Specifications12
 - 3.2 Performance Specifications13
 - 3.2.1 CPU performance specifications13
 - 3.2.2 Optical data link specifications19
 - 3.2.3 Memory specifications21
 - 3.2.4 I/O specifications22
 - 3.2.5 Terminal arrangement27
 - 3.2.6 Extension power supply unit specifications30
 - 3.2.7 Extension unit specifications31
 - 3.2.8 Extension cable specifications31
 - 3.2.9 Switch unit specifications32
 - 3.2.10 Battery specifications32
 - 3.2.11 Fuse specifications32
 - 3.3 External Dimensions33

3

3. SPECIFICATIONS

MELSEC-K

3. SPECIFICATION

3.1 Common Specifications

Item		Specifications
Power Supply	Applied voltage	100–110VAC, 85 ~ 110%, single phase 50/60Hz ± 2Hz
	Power Consumption	66VA, current: maximum 0.9A, inrush current 20A, 10mS (110VAC 60Hz)
Operating ambient temperature		0 ~ 55°C (32 ~ 132°F)
Storing ambient temperature		-10 ~ 75°C (14 ~ 167°F)
Operating ambient humidity		10 ~ 90% RH, free of dew condensation
Storing ambient humidity		10 ~ 90% RH, free of dew condensation
Vibration resistance		Conforms to class 3, IIB, JIS C 00911 (16.7 Hz, 3-mm double amplitude, 2 hrs.)
Shock resistance		Conforms to JIS C 0912 (10 g x 3 times in X, Y, Z, directions)
Noise resistance		1000 Vp-p noise voltage, 1μs noise width, 25 ~ 60 Hz noise frequency by noise simulator
Dielectric withstand voltage	1500VAC for 1 minute	Across 100VAC external I/O terminals and case
		Across 100VAC external I/O terminals and 24VDC external I/O terminals
		Across 100VAC power supply voltage terminals and case
		Across 24VDC external I/O terminals and case.
Insulation	5MΩ or larger by 500VDC insulation resistance meter	Across 100VAC external I/O terminals and case
		Across 100VAC external I/O terminals and 24VDC external I/O terminals
		Across 100VAC power supply voltage terminals and case
		Across 24VDC external I/O terminals and case
Grounding		Class 3 grounding. Grounding may not be required when it is impossible.
Operating ambience		Particularly dust and corrosive gas should be minimal.
Cooling method		Self-cooling

Note: Before voltage withstand test, disconnect the grounded terminal. Also, apply voltage to batch of 100V AC power supply terminals.

Table 3.1 Common Specifications

3. SPECIFICATIONS

MELSEC-K

3

3.2 Performance Specifications

3.2.1 CPU performance specifications

(1) Performance specifications

Item		Specifications			
Control method		Stored program, repeated operation			
I/O control method		Input and output are provided each time during repeated operation.			
Programming language		Dedicated language to sequence control (relay symbol type, used together with logic symbolic language)			
Instruction	Number of instruction	26 types of basic instructions (sequence instructions + data instructions) + 19 types of application instructions			
	Word length	16 bits/step			
Sequence instruction execution time		5.6 μ s/step/step on average. (*1)			
Data instruction execution time		See Section 2 of APPENDIX.			
Program capacity and memory *1			IC-RAM	EP-ROM	<ul style="list-style-type: none"> • Select required memory and load it into socket. (*: RAM for 1K step is standard-equipped.) • RAM is backed up by lithium battery. Total power failure guarantee period: 300 days *2
		1024 steps	*	—	
		2048 steps	—	2KROM	
		4096 steps	4KRAM	4KROM	
Number of I/O points		Basic unit: input – 32 points, output – 24 points		Maximum number of inputs/outputs: 280 points	
		E32 extension unit: input – 16 points, output – 16 points			
		E56 extension unit: input – 32 points, output – 24 points			
Number of temporary memories		250 points (M0 ~ M249)	M250 (off at initial receiving) M251 (off during link communication) M252 (empty: not usable) M253 (on at link communication error) M254 (on at battery error) M255 (on during run)		
Timer/counter (built-in)	Number of points	128 points (T/C0 ~ 127 including timers and counters)			
	Timer specifications	T0 ~ T95: 0.1 ~ 999.9 sec setup time; 0.1 sec setup time increments; on delay T96 ~ T127: 0.01 ~ 99.99 sec setup time; 0.01 sec setup time increments; on delay			
	Counter specifications	1 ~ 9999 setting range			
Shift register	Number of usable points	249 bits (M1 ~ M249) excluding those used for temporary memory.			
	Specifications	With temporary memories combined in units of one bit, up to 249 bits are possible (data shift is also possible).			
Data register	Specifications	96 points (D0 ~ 95), 16 bits for 1 data, maximum of four digits can be handled in units of four bits.			
	Data input/output	Four I/O points make up one digit. Usable jointly with process input/output. Decimal one ~ four digits in the range of 0 ~ 9999.			
Power failure latch range		Power failure latch is possible by LATCH key switch of basic unit. M128 ~ 249, T/C64 ~ 111, D64 ~ 95			
Allowable instantaneous stop time		20mS (at the time of independent use)			
Self-diagnostic function		Watch dog error monitor (WDT = 200mS), error machine code detection, power supply error detection, RUN signal is output by program from exterior.			

Note: *1: The memory is used for independent system and local programmable controller of data link system, and is not required for remote I/O unit.

*2: For replacement of battery, see Section 6.4.

3. SPECIFICATIONS

MELSEC-K

(2) List of devices

	Device	Description	Number	Number of Points	Remarks
1	X	Input	X00 ~ 1F X80 ~ 9F XC0 ~ DF X180 ~ 19F X1C0 ~ 1DF X100 ~ 17F	} 160 points 128 points	Numbers allotted to basic unit Numbers allotted to extension 1 Numbers allotted to extension 2 Numbers allotted to extension 3 Numbers allotted to extension 4 For data link
2	Y	Output	Y20 ~ 37 YA0 ~ B7 YE0 ~ F7 YA0 ~ 1B7 Y1E0 ~ 1F7 Y100 ~ 17F	} 120 points 128 points	Numbers allotted to basic unit Numbers allotted to extension 1 Numbers allotted to extension 2 Numbers allotted to extension 3 Numbers allotted to extension 4 For data link
3	M	Temporary memory	M0 ~ 249	250 points	○M254: Turns on when battery voltage reduces. ○M255: Turns on when output of self-diagnostic result is normal during run. Turns off at stop, error and power-off.
4	T	Timer	0 ~ 127 for both T and C	128 points	○T and C are numbered in series like T0, T1, C2, T3, C4 The same number cannot be used for T and C. ○T0 ~ 95 (96 points) are 100ms timers. T96 ~ 127 (32 points) are 10ms timers.
5	C	Counter			
6	F	Function number	F0 ~ 126	118 points	○F0 ~ 99: external failure memories ○F100 ~ 104, 108 ~ 119, 126: application instructions
7	D	Data register	D0 ~ 95	96 points	D100 and following numbers are for special application.
8	K	Constant	K0 ~ 9999		○Numeric constant: 0 ~ 9999 ○Master control: 0 ~ 63 ○Digit designation: 1 ~ 4 ○Jump destination step number: 3 ~ 4095

Table 3.3 Device List

3. SPECIFICATIONS

(3) Instruction list

No.	Instruction Symbol (Name)	Function	Drawing Representation	No.	Instruction Symbol (Name)	Function	Drawing Representation
1	LD Load	Logic operation start (Contact a operation start)	 X.Y.M.T.C.F	10	MC Master control	Master control start	 Kn n=0~63
2	LDI Load inverse	NOT logic operation start (Contact b operation start)	 X.Y.M.T.C.F	11	MCR Master control reset	Master control reset	 n=0~63
3	AND AND	Logical product (Contact a series connection)	 X.Y.M.T.C.F	12	SET Set	Set of Y, M, F	 SET Y.M.F
4	ANI AND inverse	Logic NAND (Contact b series connection)	 X.Y.M.T.C.F	13	RST Reset	Reset of Y, M, F Reset of counter temporary value	 RST Y.M.F.C
5	OR OR	Logical add (Contact a parallel connection)	 X.Y.M.T.C.F	14	SFT Shift	1-bit shift of temporary value	 SET M
6	ORI OR inverse	Logic NOR (Contact b parallel connection)	 X.Y.M.T.C.F	15	CJ Conditional jump	Conditional jump Jump to latter step number when input signal is on	 K Jump destination number
7	ANB AND block	Logic block AND (Series connection between blocks)	 X.Y.M.T.C.F	16	PLS Pulse	Pulse Pulses for 1 cycle of program is generated at rise of input signal	 PLS M
8	ORB OR block	Logic block OR (Parallel connection between blocks)	 X.Y.M.T.C.F	17	NOP NOP	No operation	For program delete or space
9	OUT OUT	Coil output (Y, M) Timer output (T) Counter output (C) Function No. output (F)	 Y.M.T.C.F	18	END END	Program end	Return to step 0 Be sure to enter END at the end of program.

Table 3.4 Sequence Instruction List

Note: *1: T and C set values can be specified for constant K and data register D.

*2: OUT T, C and CJ are 2-word instructions. All others are 1-word instructions.

No.	Instruction Symbol (Name)	Function	Drawing Representation	No.	Instruction Symbol (Name)	Function	Drawing Representation
1	MOV Move	Data transfer S→D	 *5 *1 *2 MOV S D Y.M.T.C.F	5	+ Plus	Addition D+S→D *4	 *5 *1 *2 + S D
2	> Larger	Magnitude comparison S>D	 *5 *6 *1 *2 > S D Y.M.T.C.F	6	- Minus	Subtraction D-S→D *4	 *5 *1 *2 - S D
3	< Smaller	Magnitude comparison S<D	 *5 *6 *1 *2 < S D Y.M.T.C.F	7	BCD BCD	BIN→BCD conversion S→BCD conversion →D	 *5 *1 *2 BCD S D
4	= Equal	Coincidence S=D	 *5 *6 *1 *2 = S D Y.M.T.C.F	8	BIN Binary	BCD→BIN conversion S→BIN conversion →D	 *5 *1 *2 BIN S D

Table 3.5 Data Instructions

Note: *1: S stands for source.

*2: D stands for destination.

*3: All data instructions are 3-word instructions.

*4: Negative numbers are not handled.

*5: Instruction data operation is initiated when input signal is on.

*6: These instructions are used for series contact a, while others are for coils.

3. SPECIFICATIONS

	S	D							Instruction	Description
		K	D	T	C	X	Y	M		
MOV BCD BIN +, -									MOV Km Dn	Constant set : constant Km (0 ~ 9999) is set to Dn.
									MOV Dm Dn	Transfer : Content of Dm is transferred to Dn.
									MOV Dm T,Cn	Change of T, C temporary value : Content of Dm is written into T, C temporary value.
									MOV Dm KnY,M	Batch output : Dm content is output in blocks in units of 4 points up to 16 points.
									MOV T,Cm Dn	Read of T, C temporary value : T, C temporary value is transferred to Dn.
									MOV KmX,M Dn	Batch input : X, M content is inputted to Dn in blocks in units of 4 points up to 16 points.
									MOV Km KnY	Pattern output to Y : Bit pattern is output to Y in blocks in units of 4 points up to 16 points.
									MOV KmX KnM	Batch input of X to M : X is inputted to M in blocks in units of 4 points up to 16 points.
									MOV KmY Dn	Output pattern save of Y : Y is transferred to Dn in units of 4 points up to 16 points.
									BCD Dm Dn	Binary data of data register is converted into BCD.
>,<= +, -									BCD T,Cm Dn	T, C temporary value is read and converted into BCD.
									BIN Dm Dn	BCD data of data register is converted into binary.
									BIN KmX Dn	BCD data of input is converted into binary and inputted in blocks.
									BCD T,Cm KnY	T, C temporary value (binary) is converted into BCD and output directly to Y.
									BCD Dm KnY	Binary data of Dm is converted into BCD and output directly to Y.
									+ Km Dn	Constant addition : Km (0 ~ 9999) + Dn content is done and the result is stored into Dn.
									+ Dm Dn	Addition : Dn content + Dm content is done and the result is stored into Dn.
									- Km Dn	Constant subtraction : Dn content - Km (0 ~ 9999) is done and the result is stored into Dn.
									- Dm Dn	Subtraction : Dn content - Dm content is done and the result is stored into Dn.
									> Dm Dn	Magnitude comparison : Dm content > Dn content is judged.
								< Km Dn	Magnitude comparison : Constant Km (0 ~ 9999) < Dn content is judged.	
								= Dm Dn	Coincidence judgement : Dm content = Dn content is judged.	
								>,<= Km T,Cn	Direct comparison of T, C temporary value and reference value (Km).	
								>,<= Km KnY	Comparison of output pattern and reference pattern (Km).	

Table 3.6 S, D Instruction List of Data Instructions

CAUTION

Note that when programming is performed by use of K6GPP, K7GPP, K6PU or K7PU (unit having a legend plate which does not indicate "DATE" as shown below), only the S and D combinations of programmable data instructions shown in the following tables can be used.

□□ K3 □

→ Version

→ Year and month of manufacture

MOV

S	D						
	K	D	T	C	X	Y	M
K		○					
D		○	○	○		○	○
T			○				
C			○				
X			○				
Y							
M		○					

>,<=,+,-

D	K						
	D	T	C	X	Y	M	
K		○					
D		○					
T							
C							
X							
Y							
M							

BCD(○)
BIN(-)

S	D						
	K	D	T	C	X	Y	M
K							
D		○					
T			○				
C			○				
X					○		
Y						○	
M							

3. SPECIFICATIONS

Instruction	Function	Operation Result
OUT F100	Indirect inversion of 16-bit data	<p>Inversion</p> <p>• 1's complement • (D110) is data register number.</p>
OUT F101	BCD 6 digit Addition	<p>Augend Addend Addition result</p> <p>Upper Lower Upper Lower Upper Lower</p> <p>two digits four digits two digits four digits three digits four digits</p>
OUT F102	BCD 6 digit subtraction	<p>Minuend Subtrahend Subtraction result</p> <p>Upper Lower Upper Lower Upper Lower</p> <p>two digits four digits two digits four digits two digits four digits</p>
OUT F103	BCD 6 digit multiplication	<p>Multiplicand Multiplier Multiplication result</p> <p>Upper Lower Upper Lower Upper Middle Lower</p> <p>two digits four digits two digits four digits four digits four digits four digits</p>
OUT F104	BCD 6 digit division	<p>Dividend Divisor Division result</p> <p>Upper Lower Upper Lower Upper Lower</p> <p>two digits four digits two digits four digits two digits four digits</p>
OUT F108	4 ↔ 16 bit decode/encode	<p>Decoded/encoded data Decode/encode designation Decode/encode result</p> <p>* = decode 1 = encode</p>
OUT F109	16 bit check	<p>Check data Number of "1" bits</p> <p>The number of "1" bits in (D110) is checked and the number is stored in (D111).</p>
OUT F110	8-bit data association	<p>Value to be associated Association result</p>
OUT F111	16-bit data dissociation	<p>Value to be dissociated Dissociation result</p>
OUT F112	Indirect AND operation of 16-bit data	

Table 3.7 List of Application Instructions (Continued)

3. SPECIFICATIONS
















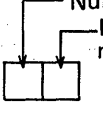
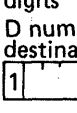
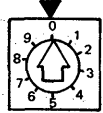
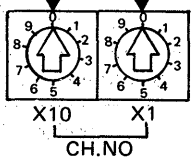
Instruction	Function	Operation Result		
OUT F113	Indirect OR operation of 16-bit data	 V	 →	
OUT F114	Batch shift of temporary memory M	Head number of M  D110	Number of D points to be shifted  D111	Designation of shift direction *0 = leftward shift 1 = rightward shift  D112 Head number of M is placed in (D110) and the number of points in (D111) is shifted once.
OUT F115	Batch shift of data resistor D	Head number of D  D110	Number of D points to be shifted  D111	Designation of shift direction *0 = leftward shift 1 = rightward shift  D112 Head number of D is placed in (D110) and the number of points in (D111) is shifted once.
OUT F116	Batch reset of data register D	Head number of D  D110	Number of D points to be reset  D111	Head number of D is placed in (D110) and the number of points in (D111) is reset.
OUT F117	Indirect reading of T, C, D	T, C, D number Three digits  →	Reading result 	*0 = T · C 1 = D
OUT F118	Indirect writing of T, C, D	T, C, D number Three digits  →	Writing result 	*0 = T · C 1 = D
OUT F119	Data transfer from Y to D	Number of digits and head number of Y 	D number of transfer destination 	Batch transfer from output Y to data register D. A maximum of 16 points are transferred in units of four points.
OUT F126	High-speed processing program call	Used for call of high-speed processing program (SET F126) in normally processed program and return to normally processed program (RST F126) at the end of high-speed processing program.		
RST F126	High-speed processing program return			

Table 3.7 List of Application Instructions

3. SPECIFICATIONS

3.2.2 Optical data link specifications

Item	Specifications																																															
Data link function	Slave channel function <ul style="list-style-type: none"> Remote I/O channel of remote I/O system Local programmable controller of local programmable controller system (selectable by the internal setting switch) 																																															
Programmable controller applicable to master channel (Number of connected slave channels)	KGPC, K3 A maximum of 32 channels: K0J2P can be used together with local programmable controller (KJ71P3) and remote I/O unit (KJ72P5) composed of K2 or K3.																																															
Transmission cable	Optical fiber cable (quartz glass)																																															
Maximum transmission cable length	Maximum 2 km between channels (between master channel and slave channel) (between slave channel and slave channel)																																															
Communication speed	500 k BPS																																															
Number of points for data link with master programmable controller	Remote I/O unit: maximum 280 points for X and Y Local programmable controller: 128 points for each of X and Y, maximum 256 points, maximum 24 points for D																																															
Test function	Master test, slave test (test can be made by selection of the mode setting switch)																																															
Automatic reconnection function	Provided (selectable by the internal setting switch)																																															
Setting	[Front digital switch]  0: ONLINE mode 1: OFFLINE mode 2: MASTER TEST mode 3: SLAVE TEST mode 4 ~ 9: Not used																																															
	[Front digital switch]  Specified by 0 ~ 32 0: independent programmable controller 1 ~ 32: channel numbers for remote I/O unit and local programmable controller																																															
	[Internal setting switch] <table border="1" style="display: inline-table; vertical-align: top;"> <tr> <td style="text-align: center;">1</td> <td>Empty</td> <td style="text-align: center;">▼</td> <td style="text-align: center;">Independent programmable controller</td> <td style="text-align: center;">Remote I/O</td> <td style="text-align: center;">Local programmable controller</td> </tr> <tr> <td style="text-align: center;">2</td> <td>Empty</td> <td></td> <td></td> <td></td> <td></td> </tr> <tr> <td style="text-align: center;">3</td> <td>-----</td> <td></td> <td style="text-align: center;">OFF</td> <td style="text-align: center;">ON</td> <td style="text-align: center;">OFF</td> </tr> <tr> <td style="text-align: center;">4</td> <td>-----</td> <td></td> <td style="text-align: center;">OFF</td> <td style="text-align: center;">OFF</td> <td style="text-align: center;">ON</td> </tr> <tr> <td style="text-align: center;">5</td> <td>Empty</td> <td></td> <td></td> <td></td> <td></td> </tr> <tr> <td style="text-align: center;">6</td> <td>Empty</td> <td></td> <td></td> <td></td> <td></td> </tr> <tr> <td style="text-align: center;">7</td> <td>Empty</td> <td style="text-align: center;">▼</td> <td style="text-align: center;">Automatic reconnection</td> <td colspan="2" style="text-align: center;">No automatic reconnection</td> </tr> <tr> <td style="text-align: center;">8</td> <td>-----</td> <td></td> <td style="text-align: center;">OFF</td> <td colspan="2" style="text-align: center;">ON</td> </tr> </table>	1	Empty	▼	Independent programmable controller	Remote I/O	Local programmable controller	2	Empty					3	-----		OFF	ON	OFF	4	-----		OFF	OFF	ON	5	Empty					6	Empty					7	Empty	▼	Automatic reconnection	No automatic reconnection		8	-----		OFF	ON
1	Empty	▼	Independent programmable controller	Remote I/O	Local programmable controller																																											
2	Empty																																															
3	-----		OFF	ON	OFF																																											
4	-----		OFF	OFF	ON																																											
5	Empty																																															
6	Empty																																															
7	Empty	▼	Automatic reconnection	No automatic reconnection																																												
8	-----		OFF	ON																																												
During suspension of data link	Remote I/O unit: all output points are turned OFF. Local programmable controller: all data link points are turned off. M251 turns ON, sequence processing is continued.																																															

Note: The ▼ mark in the table indicates factory-set state.

Table 3.8 Optical Data Link Specifications

3. SPECIFICATIONS

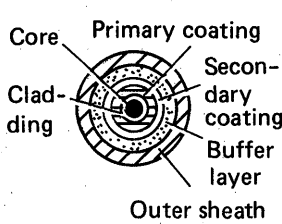
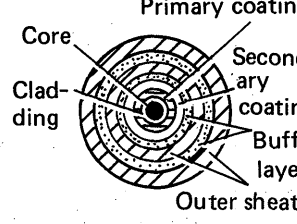
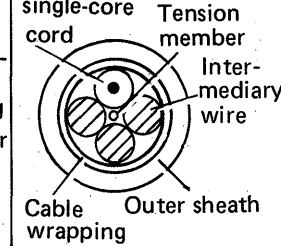
Item	Optical Single-core Cord (3 mm dia.)	Reinforced Optical Single-core Cord (5 mm dia.)	Optical Cable
Structure			
Finish OD	Approx. 3 mm	Approx. 5 mm	Approx. 11 mm
Allowable bending radius	20 mm	30 mm	110 mm
Allowable tension	30 kg	50 kg	60 kg
Weight	Approx. 10 g/m	Approx. 25 g/m	Approx. 100 g/m
Number of applicable cores	1 core	1 core	1 core
Application	For wiring inside panel	For wiring between indoor equipment	For wiring between outdoor equipment
Transmission loss	Maximum 3.5 dB/km ($\lambda = 0.85\mu\text{m}$)		
Transmission band	Maximum 220 MHz/km ($\lambda = 0.85\mu\text{m}$ band LD)		
Core	Quartz glass, diameter: $50 \pm 3\mu\text{m}$		
Cladding	Quartz glass, diameter: $125 \pm 3\mu\text{m}$		
Core eccentricity and ellipticity	Maximum 6%, respectively		
Primary coating	Silicone resin, approx. 0.4 mm dia.		
Secondary coating	Nylon, 0.9 ± 0.1 mm dia.		
Buffer layer	Nylon fiber		
Tension member	PE coated steel wire, approx. 2 mm dia.		
Intermediary wire	Polyethylene string, approx. 3 mm dia.		
Cable wrapping	Plastic tape		
Outer sheath	Black PVC		
Profile	GI		

Table 3.9 Specifications of Optical Fiber Cable

Note: 1. Designation of optical fiber cable

OF-010D-□ EO-□M

↑ Cable structure

↑ Cable length (specify in meters: 5 ~ 2000m)

A: optical single-core cord (3mm dia.)
B: reinforced optical single-core cord (5mm dia.)
C: optical cable (11mm dia.)

2. Designation of connection of connector to optical fiber cable

OD-9475B-□-□M-D

↑ Connection of connector – 1: only one end of cable,
2: both ends

↑ Cable length (specify in meters: 5 ~ 2000m)

3. SPECIFICATIONS

3.2.3 Memory specifications

	RAM		ROM	
	*	4KRAM	2KROM	4KROM
Type name	*	4KRAM	2KROM	4KROM
Capacity	1024 steps	4096 steps	2048 steps	4096 steps
Construction	IC chip	IC chip	IC chip	IC chip
Remarks	*Standard-equipped RAM	—————	ROM writer K6WU K6PRT	ROM writer K6PRT

Note: Applicable RAM and ROM are restricted to Mitsubishi's products.

Table 3.10 Memory Specifications

3. SPECIFICATIONS

MELSEC-K

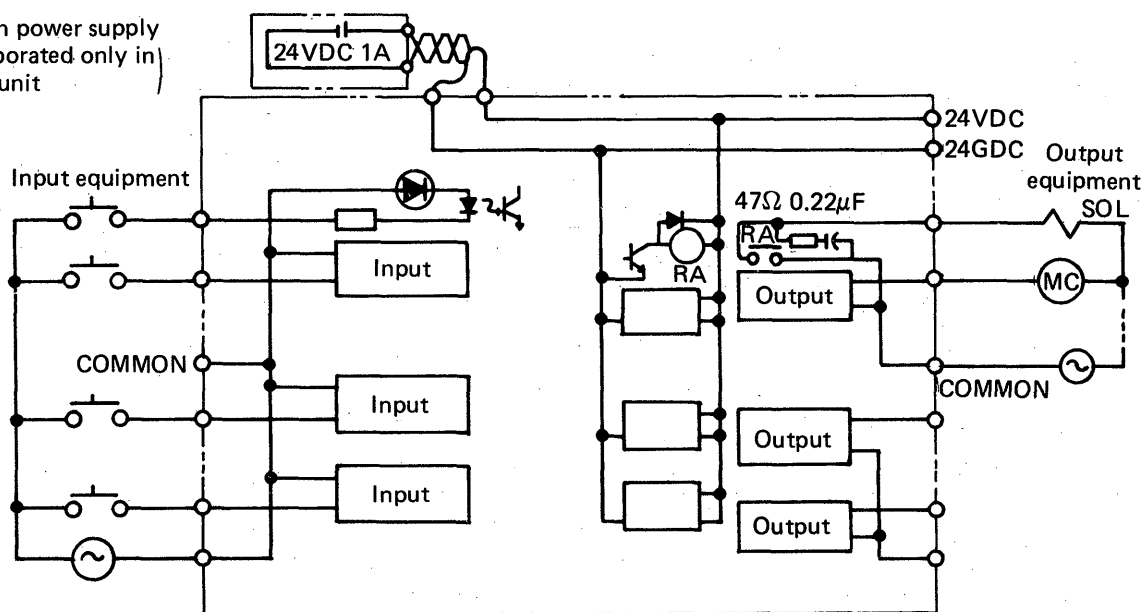
3.2.4 I/O specifications

MR52-AR

(1) Type AR (100VAC input, relay contact output)

Input Specifications			Output Specifications		
Insulation system	Photocoupler		Insulation system	Relay	
Operating indicator	All points indicated by light-emitting diodes		Operating indicator	All points indicated by light-emitting diodes	
Input voltage	85 ~ 121VAC		Maximum load voltage	250VAC/125VDC	
			Load power supply	1 point	2A (120VAC $\cos\phi=0.7$) 24VDC L/R=7mS)
Operating current	10mA (100VAC)			8 points	8A (all points simultaneous ON)
Operating voltage	OFF → ON	80VAC minimum	Maximum inrush load current	5A/points	
	ON → OFF	40VAC maximum			
Response time	OFF → ON	5 ~ 15mS	Response time	OFF → ON	5mS
	ON → OFF	15 ~ 30mS		ON → OFF	15mS
Input impedance	10kΩ		Contact life	Electrical	500 thousand times or more (110VAC 1.5A)
				Mechanical	20 million times or more
Common wiring	All points/common (provided with terminal block for bridging external wiring per 16 points)		Leak current	2mA (220VAC 60Hz)	
			Common wiring	8 points/common	
External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)		External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)	
Applicable solderless terminals	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)		Applicable solderless terminal	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)	
Applicable wire size	2mm ² maximum		Applicable wire size	2mm ² maximum	

Built-in power supply (incorporated only in basic unit)



Since the basic unit incorporates 24V DC power supply, it is not required to supply the relay power supply for output circuit from the exterior. Connect E32, E56 extension unit in the exterior so that power is supplied from the 24V DC supply terminal of basic unit.

Table 3.11 Type AR Specifications

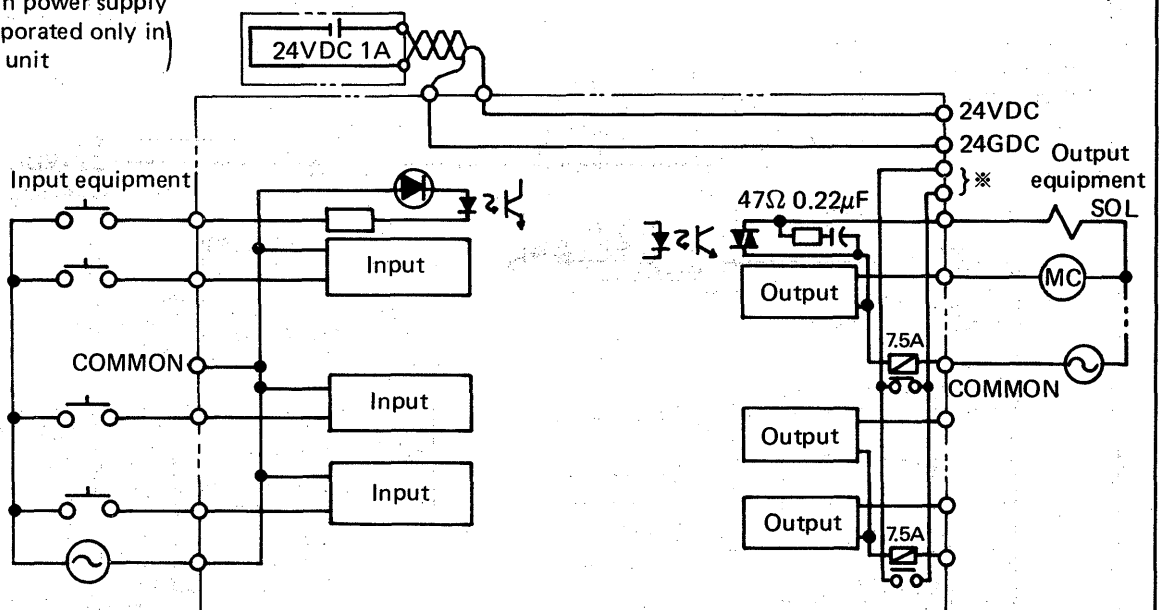
3. SPECIFICATIONS

(2) Type AS (100VAC input, triac output)

Input Specifications		Output Specifications			
Insulation system	Photocoupler	Insulation system	Photocoupler		
Operating indicator	All points indicated by light-emitting diodes	Operating indicator	All points indicated by light-emitting diodes		
Input voltage	85 ~ 121VAC	Load voltage	80 ~ 242VAC		
		Load power supply	1 point	1A	
Operating current	10mA (100VAC)		8 points	5A (8 points simultaneous ON)	
		Operating voltage	OFF → ON	80VAC minimum	Maximum inrush load current
ON → OFF	40VAC maximum		Minimum load current	30mA (25°C)	
Response time	OFF → ON	5 ~ 15mS			Response time
	ON → OFF	15 ~ 30mS	ON → OFF	1/2 cycle	
Input impedance	10kΩ	Fuse-blow alarm contact	125VAC Maximum current: 0.5A		
Common wiring	All points/common (provided with terminal block for bridging external wiring per 16 points)	Leak current	3mA (220VAC 60Hz)		
		Common wiring	8 points/common		
External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)	External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)		
Applicable solderless terminals	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)	Applicable solderless terminal	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)		
Applicable wire size	2mm ² maximum	Applicable wire size	2mm ² maximum		

Built-in power supply
(incorporated only in
basic unit)

※ Fuse-blow alarm output



The basic unit incorporates 24V DC power supply. When Type DR, AR, DT or DS is used, connect E32, E56 extension unit in the exterior so that power is supplied from the 24V DC supply terminal.

Table 3.12 Type AS Specifications

3. SPECIFICATIONS

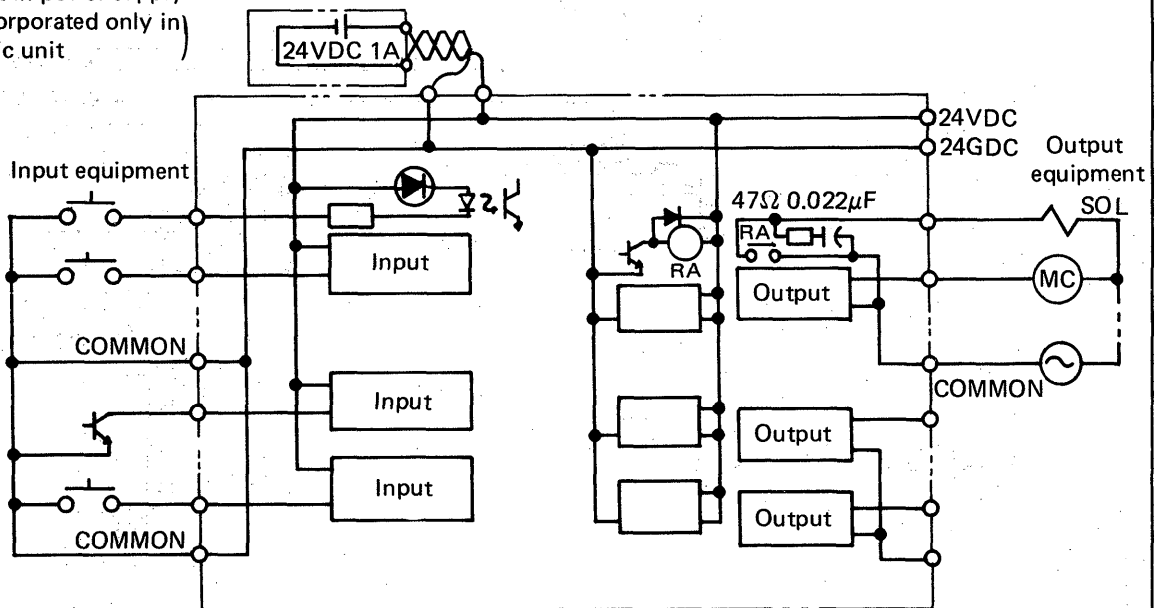
MELSEC-K

(3) Type DR (24VDC input, relay contact output)

MR-52DR

Input Specifications		Output Specifications	
Insulation system	Photocoupler	Insulation system	Relay
Operating indicator	All points indicated by light-emitting diodes	Operating indicator	All points indicated by light-emitting diodes
Input voltage	24VDC +10 ~ -10%	Maximum load voltage	250VAC/125VDC
	(Power supply built in basic unit is used)	Load power supply	1 point 2A (120VAC $\cos\phi=0.7$) 24VDC L/R=7mS
Input current	8.5 ~ 11mA (24VDC)		8 points 8A (8 points simultaneous ON)
Operating voltage	OFF → ON	8 ~ 10VDC	Maximum inrush load current
	ON → OFF	8 ~ 10VDC	
Response time	OFF → ON	9 ~ 15mS	Response time
	ON → OFF	9 ~ 15mS	OFF → ON 5mS ON → OFF 15mS
Input resistance	Approximately 2.4kΩ	Contact life	Electrical 500 thousand times or more (110VAC 1.5A)
Input system	Sink input (input current efflux system)		Mechanical 20 million times or more
Common wiring	32 points/common (provided with terminal block for bridging external wiring per 16 points)	Leak current	2mA (220VAC 60Hz)
		Common wiring	8 points/common
External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)	External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)
Applicable solderless terminals	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)	Applicable solderless terminal	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)
Applicable wire size	2mm ² maximum	Applicable wire size	2mm ² maximum

Built-in power supply (incorporated only in) basic unit



Since the basic unit incorporates 24V DC power supply, it is not required to supply the power supply for input circuit and the relay power supply for output circuit from the exterior. Connect E32, E56 extension unit in the exterior so that power is supplied from the 24VDC supply terminal of basic unit.

Table 3.13 Type DR Specifications

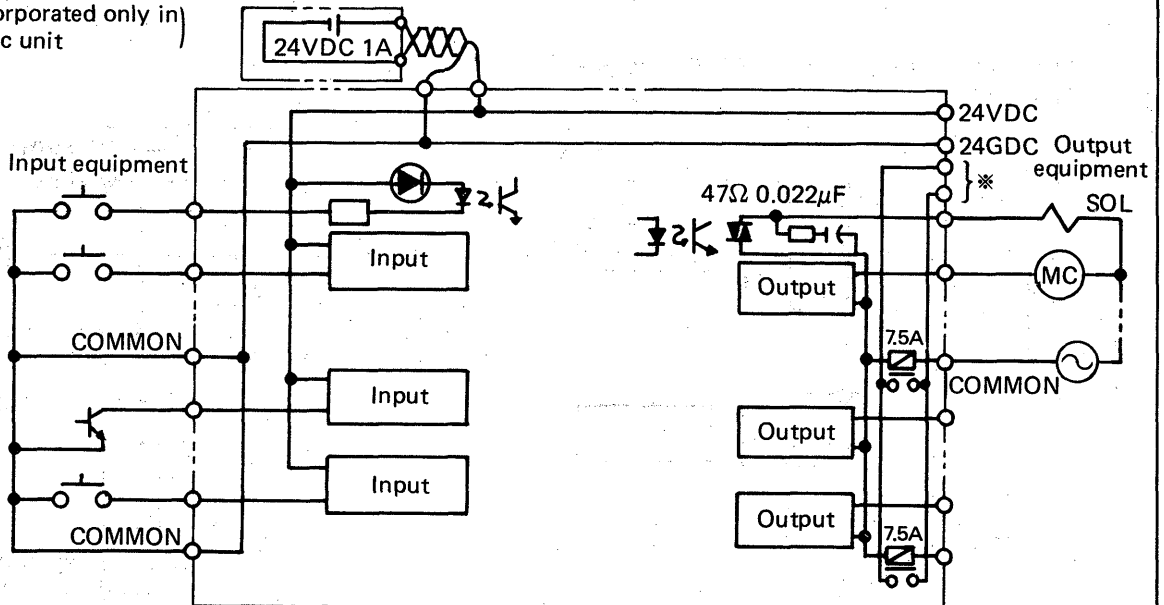
3. SPECIFICATIONS

(4) Type DS (24VDC input, triac output)

Input Specifications		Output Specifications			
Insulation system	Photocoupler	Insulation system	Photocoupler		
Operating indicator	All points indicated by light-emitting diodes	Operating indicator	All points indicated by light-emitting diodes		
Input voltage	24VDC +10 ~ -10%	Load voltage	80 ~ 242VAC		
	(Power supply built in basic unit is used)	Load power supply	1 point	1A	
Input current	8.5 ~ 11mA (24VDC)		8 points	5A (8 points simultaneous ON)	
Operating voltage	OFF → ON	8 ~ 10VDC	Maximum inrush load current	30A/point (1 cycle)	
	ON → OFF	8 ~ 10VDC	Minimum load current	30mA/point (25°C)	
Response time	OFF → ON	9 ~ 15mS	Response time	OFF → ON	1mS
	ON → OFF	9 ~ 15mS		ON → OFF	1/2 cycle
Input resistance	Approximately 2.4kΩ		Fuse-blow alarm contact	125VAC Maximum current: 0.5A	
Input system	Sink input (input current efflux system)			Leak current	3mA (220VAC 60Hz)
Common wiring	All points/common provided with terminal block for (bridging external wiring per 16 points)		Common wiring	8 points/common	
External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)		External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)	
Applicable solderless terminals	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)		Applicable solderless terminal	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)	
Applicable wire size	2mm ² maximum		Applicable wire size	2mm ² maximum	

Built-in power supply (incorporated only in basic unit)

* Fuse-blow alarm output



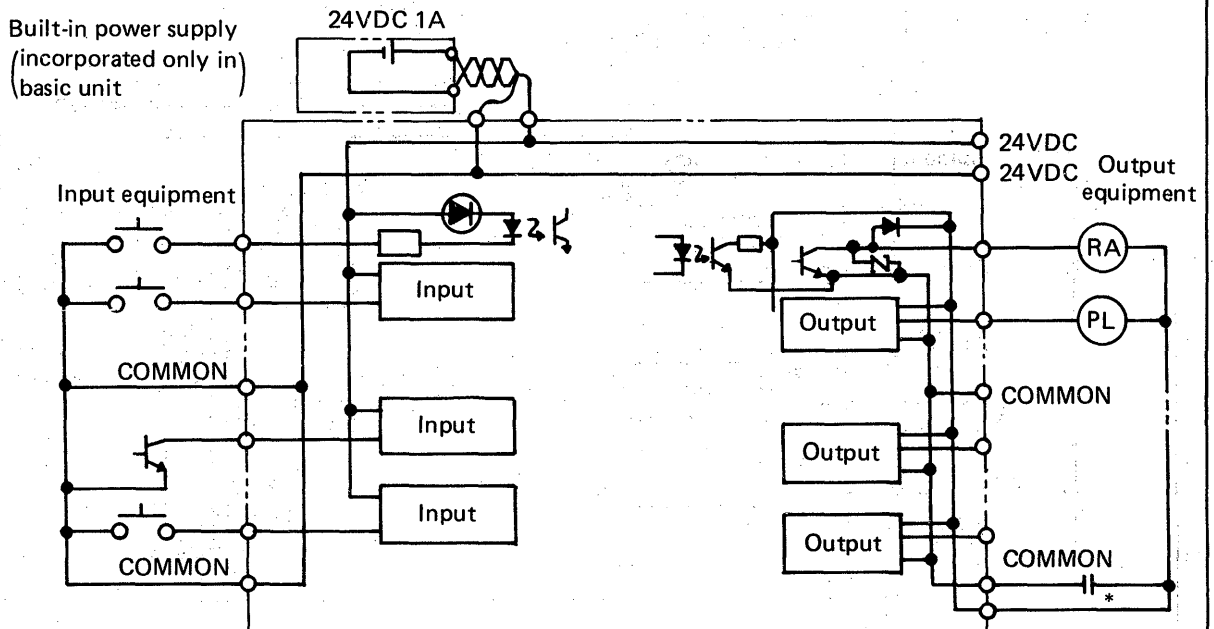
Since the basic unit incorporates 24V DC power supply, it is not required to supply the power supply for input circuit and the relay power supply for output circuit from the exterior. Connect E32, E56 extension unit in the exterior so that power is supplied from the 24V DC supply terminal of basic unit.

Table 3.14 Type DS Specifications

3. SPECIFICATIONS

(5) Type DT (24VDC input, transistor output)

Input Specifications		Output Specifications			
Insulation system	Photocoupler	Insulation system	Photocoupler		
Operating indicator	All points indicated by light-emitting diodes	Operating indicator	All points indicated by light-emitting diodes		
Input voltage	24VDC +10 ~ -10%	Rated load voltage	5/12/24VDC		
	(Power supply built in basic unit is used)	Maximum Load power supply	30VDC		
Input current	8.5 ~ 11mA (24VDC)	Load power supply	1 point	0.5A	
Operating voltage	OFF → ON		8 ~ 10VDC	8 points	4A (8 points simultaneous ON)
	ON → OFF	8 ~ 10VDC	Maximum inrush load current	15A (50mS)	
Response time	OFF → ON	9 ~ 15mS	Response time	OFF → ON	0.1mS
	ON → OFF	9 ~ 15mS		ON → OFF	0.5mS
Input resistance	Approximately 2.4kΩ	Maximum voltage drop at ON	1.5V		
Input system	Sink input (input current efflux system)	External supply unit	160mA/16 points (24VDC)		
Common wiring	All points/common (provided with terminal block for bridging external wiring per 16 points)	Common wiring	All points/common (provided with terminal block for bridging external wiring per 16 points)		
External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)	External connection system	20-point terminal block connector (terminal screw: M3 x 0.5 x 6)		
Applicable solderless terminals	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)	Applicable solderless terminal	1.25-3, 2-S3 (proper tightening torque: 7kg/cm)		
Applicable wire size	2mm ² maximum	Applicable wire size	2mm ² maximum		



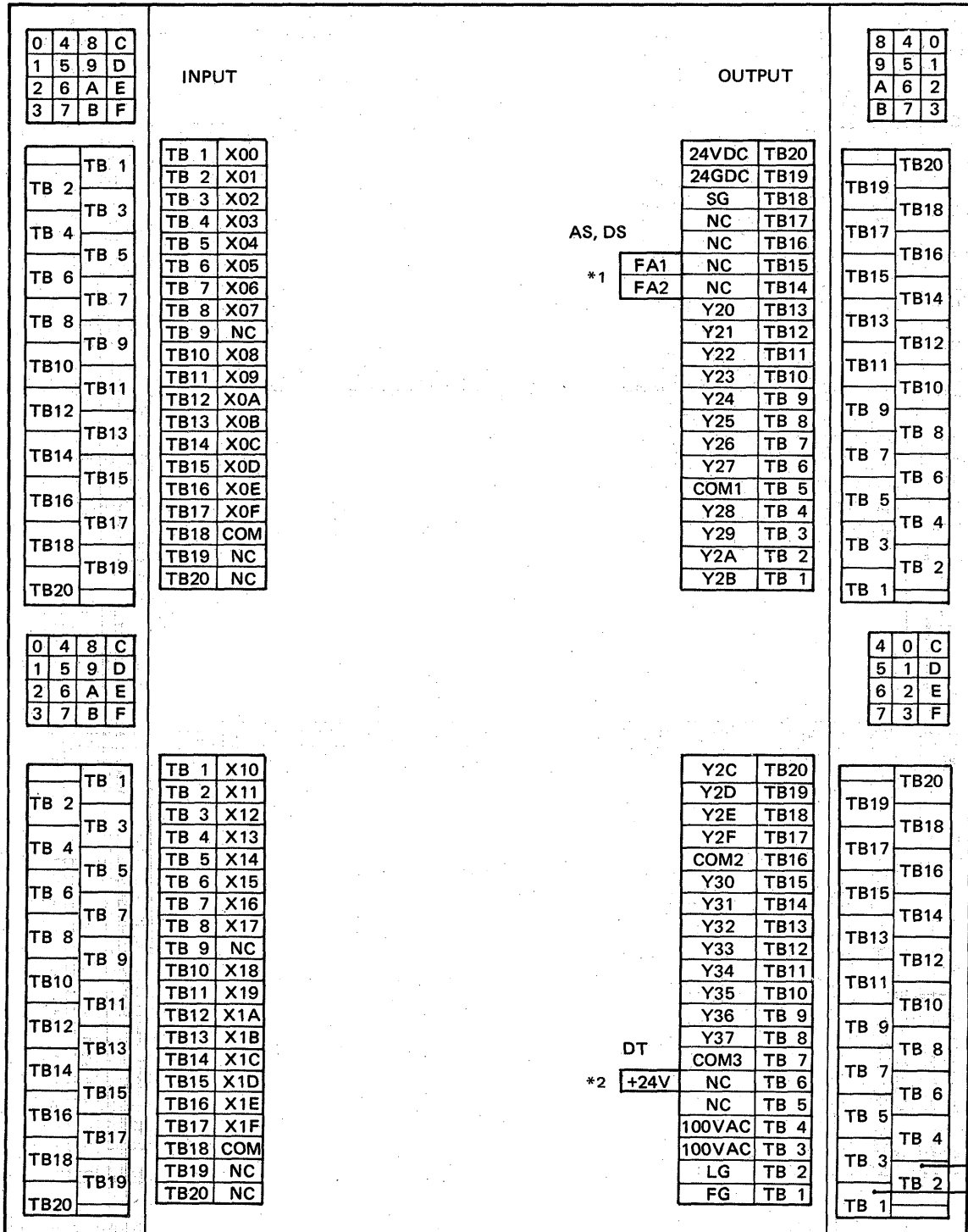
Since the basic unit incorporates 24V DC power supply, it is not required to supply the power supply for input circuit from the exterior. Connect E32, E56 extension unit in the exterior so that power is supplied from the 24VDC supply terminal of basic unit. The power supply with * mark is a power supply device in the exterior and used for load.

Table 3.15 Type DT Specifications

3. SPECIFICATIONS

3.2.5 Terminal arrangement

(1) Terminal arrangement of basic unit



*1: "Fuse-blow alarm output" for Type AS and DS

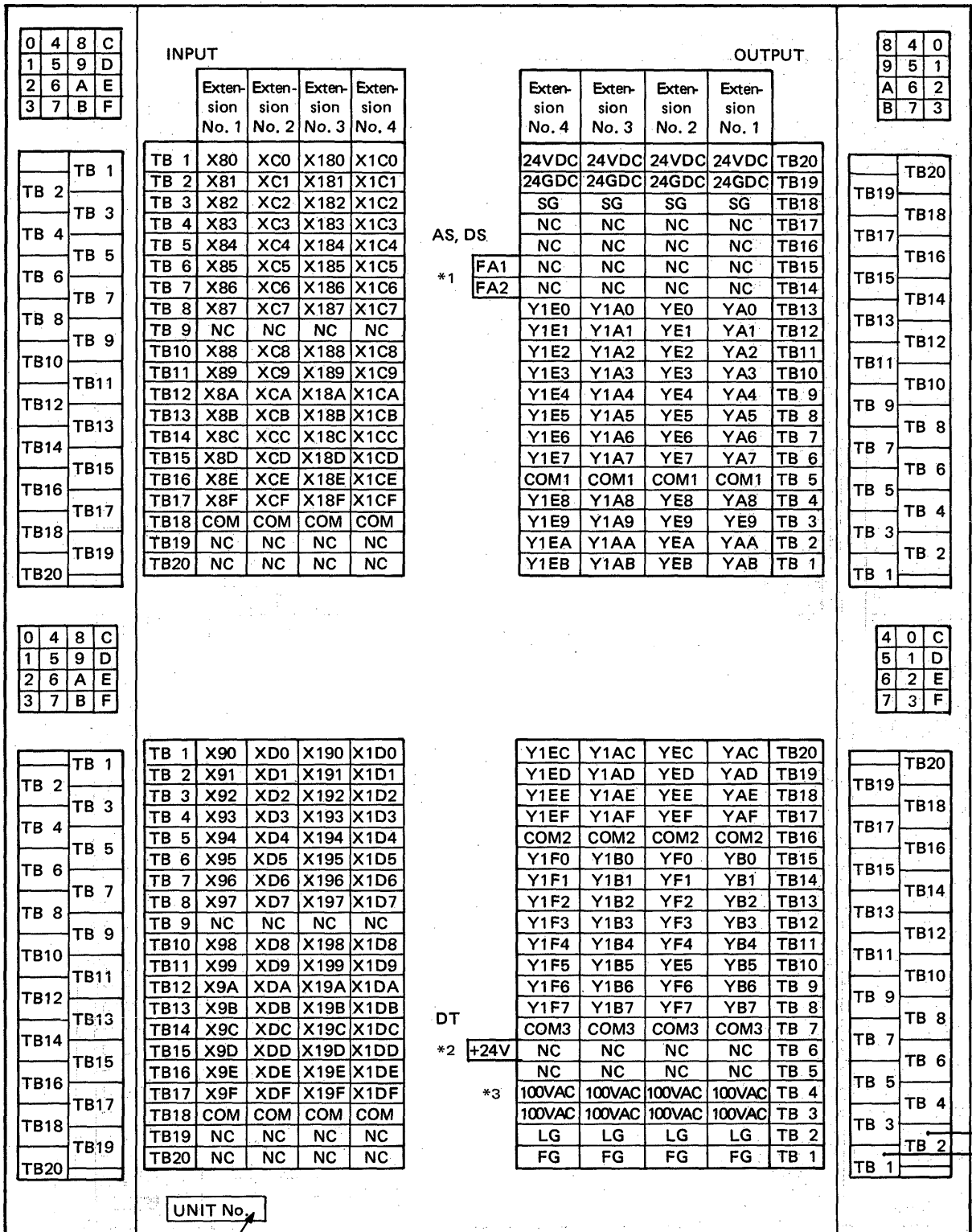
*2: Load power supply input for Type DT

Fig. 3.1 Terminal Arrangement of Basic Unit

3. SPECIFICATIONS

MELSEC-K

(2) Terminal arrangement of Type E56 extension unit

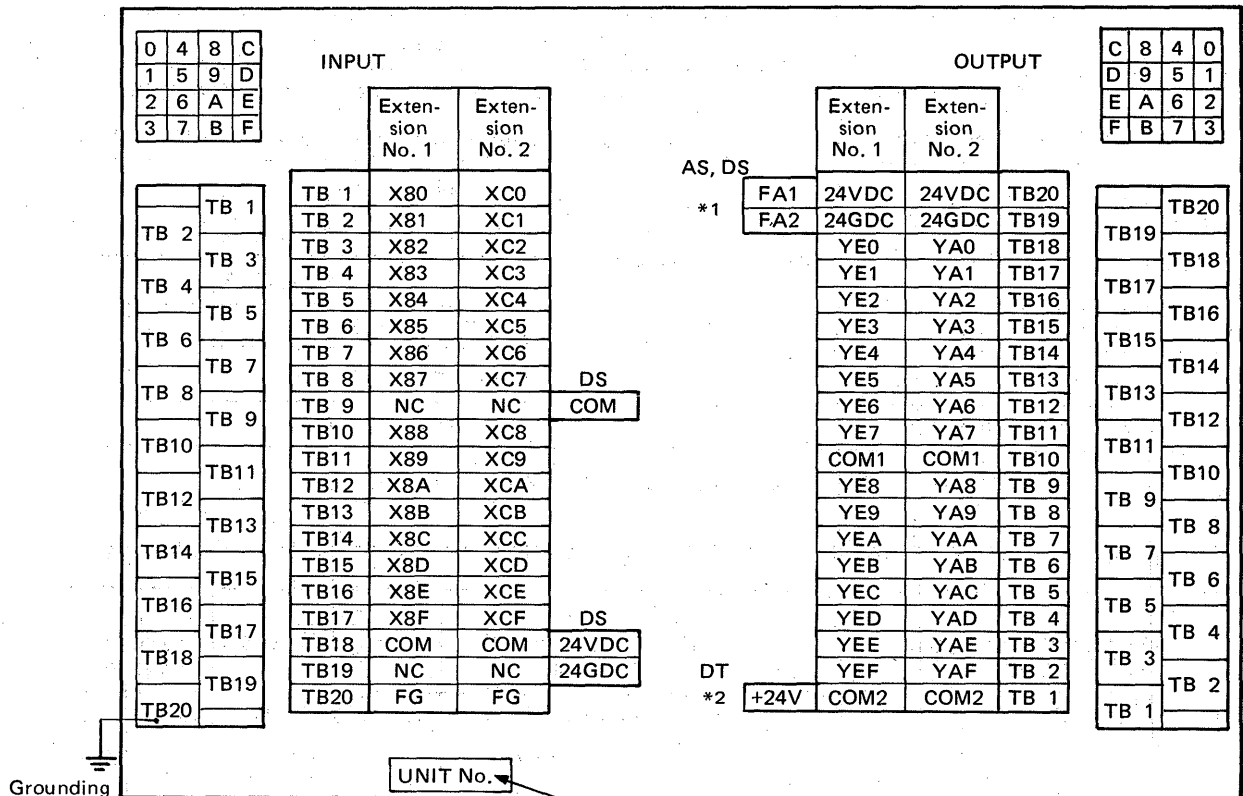


Imprinting area of extension unit number
 *1: "Fuse-blow alarm output" for Type AS and DS
 *2: Load power supply input for Type DT
 *3: Connect 100VAC power supply when extension power supply is loaded.

Fig. 3.2 Terminal Arrangement of Type E56 Extension Unit

3. SPECIFICATIONS

(3) Terminal arrangement of Type E32 extension unit



*1: "Fuse-blow alarm output" for Type AS and DS

*2: Load power supply input for Type DT

Imprinting area of extension unit number

Fig. 3.3 Terminal Arrangement of Type E32 Extension Unit

(4) Terminals of each unit and their applications

Terminal	Application
TB1 ~ 20	Terminal numbers. Take care because there are the same numbers.
Xm	Input number
Yn	Output number
NC	Abbreviation of No. Connection. An empty terminal which is not connected with interior. Can be used as a junction terminal.
COM	Abbreviation of Common. A common terminal to input or output.
24VDC	+ side of 24VDC of programmable controller interior.
24GDC	0V side of 24VDC of programmable controller interior.
100VAC	100VAC power supply input (Extension unit is connected only when extension power supply is loaded.)
LG	Grounding of line filter
FG	Grounding for prevention of noise
SG	0V terminal of internal power 5VDC. Do not ground.
FA1, 2	Fuse-blow alarm output which outputs fuse blow to exterior for protection of triac of Type AS and DS. Turns on when fuse is blown.
+24V	Connect +24V of power supply for load.

Table 3.16 Applications of Terminals

3. SPECIFICATIONS

3.2.6 Extension power supply unit specifications

Type name		K0J1-PW	
Input	Applied voltage	100 – 110VAC, 85 ~ 110%, single phase 50/60Hz ± 2Hz	
	Power consumption	66VA, current: maximum 0.9A, inrush current 20A, 10ms (110VAC 60Hz)	
Output	Voltage	24VDC	
	Current	Ambient temperature	45°C 1.0A 55°C 0.8A
External dimensions		120 x 170 mm	
Weight		0.5kg (1.1 lbs)	
Usable extension unit		Type E56 extension unit	

Table 3.17 Extension Power Supply Unit Specifications

*: To judge whether or not the extension power supply unit is required, refer to the table shown below.

Current consumption of 24VDC (at all I/O simultaneous ON)	I/O symbol	Current consumption of 24V per point	Current consumption of basic unit	Current consumption of E32 extension unit	Current consumption of E56 extension unit
	DR	Input current: 10mA Output current: 21mA	10mA x 32 + 21mA x 24 = 0.824A	10mA x 16 + 21mA x 16 = 0.496A	10mA x 32 + 21mA x 24 = 0.824A
	AR	Input current: – Output current: 21mA	21mA x 24 = 0.504A	21mA x 16 = 0.336A	21mA x 24 = 0.504A
	AS	Input current: – Output current: –	–	–	–
	DT	Input current: 10mA Output current: –	10mA x 32 = 0.32A	10mA x 16 = 0.16A	10mA x 32 = 0.32A
	DS	Input current: 10mA Output current: –	10mA x 32 = 0.32A	10mA x 16 = 0.16A	10mA x 32 = 0.32A
	Calculation example of current consumption of 24VDC	<p>Unit configuration</p> <p>Basic unit K0J2-DR 0.824A (0.495A)</p> <p>E56 Extension unit K0J2-E56DR 0.824A (0.495A)</p> <p>E32 Extension unit K0J1-E32DR 0.496A (0.30A)</p> <p>0.824A (0.495A) 1.32A (0.795A)</p> <p>When current consumption is calculated assuming that the simultaneous ON ratio of each unit is 60%, the result is as indicated in parenthesis. Therefore, add the K0J1-PW power supply unit to the E56 extension unit to supply power also to the E32 extension unit.</p>			

3.2.7 Extension unit specifications

		32-point Extension Unit	56-point Extension Unit
Type name		K0J1-E32□□□ *	K0J2-E56□□□ *
Extended unit	Basic unit	K0J1, K0J1H, K0J2, K0J2P	K0J1, K0J1H, K0J2, K0J2P
	Extension unit	K0J1-E32, K0J1-E56, K0J2-E56	K0J1-E32, K0J1-E56, K0J2-E56
Connection cable		K0J-61CBL, K0J-61CBL2	K0J-61CBL, K0J-61CBL2
Number of I/O points	Input	16 points	32 points
	Output	16 points	24 points
External dimensions		210 x 210 x 100 mm	210 x 300 x 100 mm
Weight		1.3kg (2.9 lbs)	1.6kg (3.5 lbs)

Note: (*) The last two letters of extension unit indicate I/O specifications. (See Section 2.1 "List of Equipment" and section 3.2.4 "I/O specifications".)

Table 3.18 Extension Unit Specifications

3.2.8 Extension cable specifications

Type Name	K0J-61CBL	K0J-61CBL2
Cable length	500 mm	1000 mm
Dielectric withstand voltage	500V AC for one minute	
Application	(1) Connection of K0J basic unit and extension unit (2) Connection of K0J extension unit and extension unit	

Table 3.19 Extension Cable Specifications

Note: One piece of Type K0J-61CBL extension cable is provided per extension unit.

3. SPECIFICATIONS

3.2.9 Switch unit specifications

Type name	K0SW
Number of switch points	16 points
Rated voltage	125V AC/DC, 250V AC/DC
Rated current	0.1A
Contact resistance	50mΩ or lower at 2 ~ 4V DC, 0.1A
Insulation resistance	1000Ω or higher at 500V DC
Dielectric withstand voltage	1000V AC/minute
Switch life	30000 times
Operating power	1 kg or less

Table 3.20 Switch Unit Specifications

3.2.10 Battery specifications

Type name	K6BAT
Rated voltage	3.6V
Battery guarantee period	Five years
Total power failure time	300 days (7200 hours)
Application	Back up of IC-RAM memory Back up of latch function

Table 3.21 Battery Specifications

3.2.11 Fuse specifications

Type name	MN51R	MP75
Application	For power supply	For triac output*
Shape	Encased in glass tube	Plug type
Rated voltage	250V	125V
Rated current	2A	7.5A
Melting characteristics	Within one hour at 160% of rated current Within two minutes at 200% of rated current	Within one hour at 135% of rated current Within one second at 250% of rated current

Note: *Fuse for triac (MP75) is used for protection of unit at the time of short-circuit.
Provide the fuse, which is used for protection of load, at the exterior in units of one point.

Table 3.22 Fuse Specifications

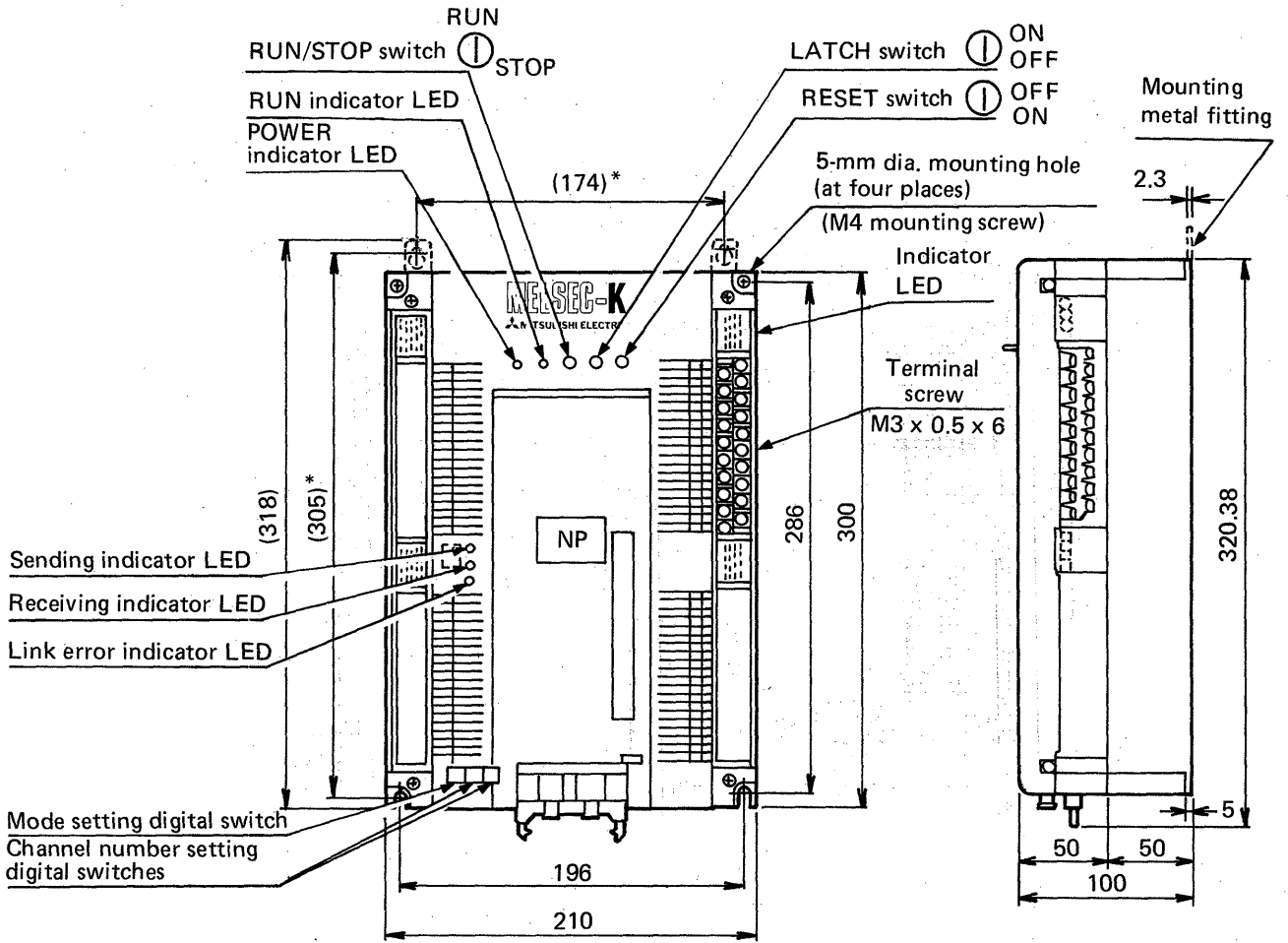
3. SPECIFICATIONS

MELSEC-K

3.3 External Dimensions

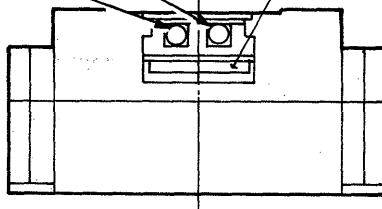
(1) Basic unit KOJ2P-□□

2.6 kg (5.7 lbs)

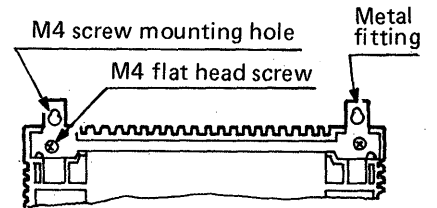


Connector for optical link (sending side)
 Connector for optical link (receiving side)

Connector for extension cable



Note: Upper mounting holes can be changed to * mark by changing the mounting positions of metal fittings.



By removing two M4 flat head screws, the metal fittings can be mounted as shown above.

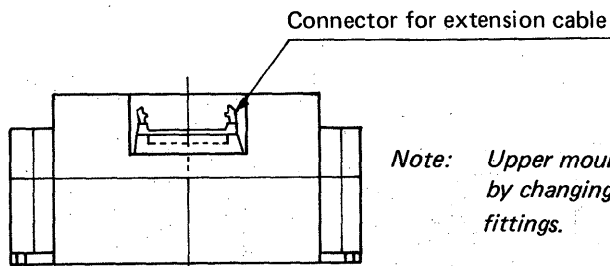
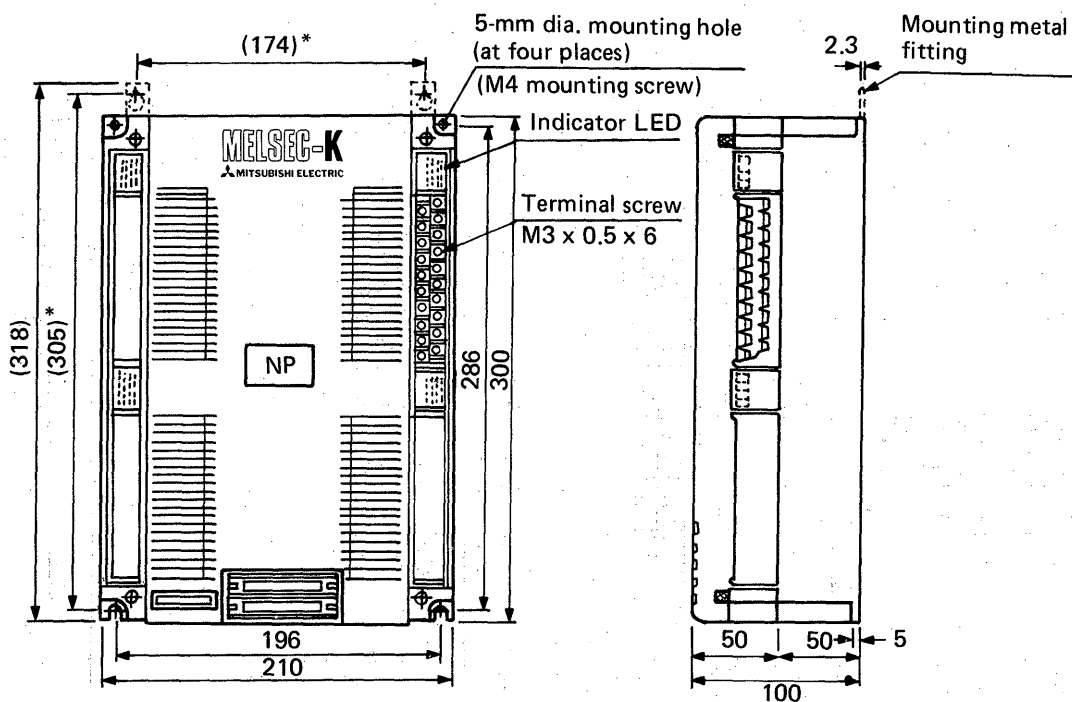
3. SPECIFICATIONS

MELSEC-K

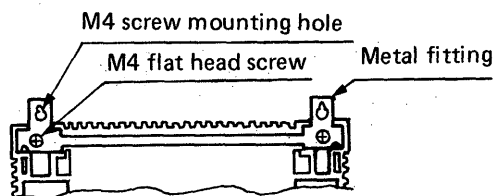
(2) Extension unit KOJ2-E56□□

2.2 kg (4.9 lbs)

3



*Note: Upper mounting holes can be changed to * mark by changing the mounting positions of metal fittings.*

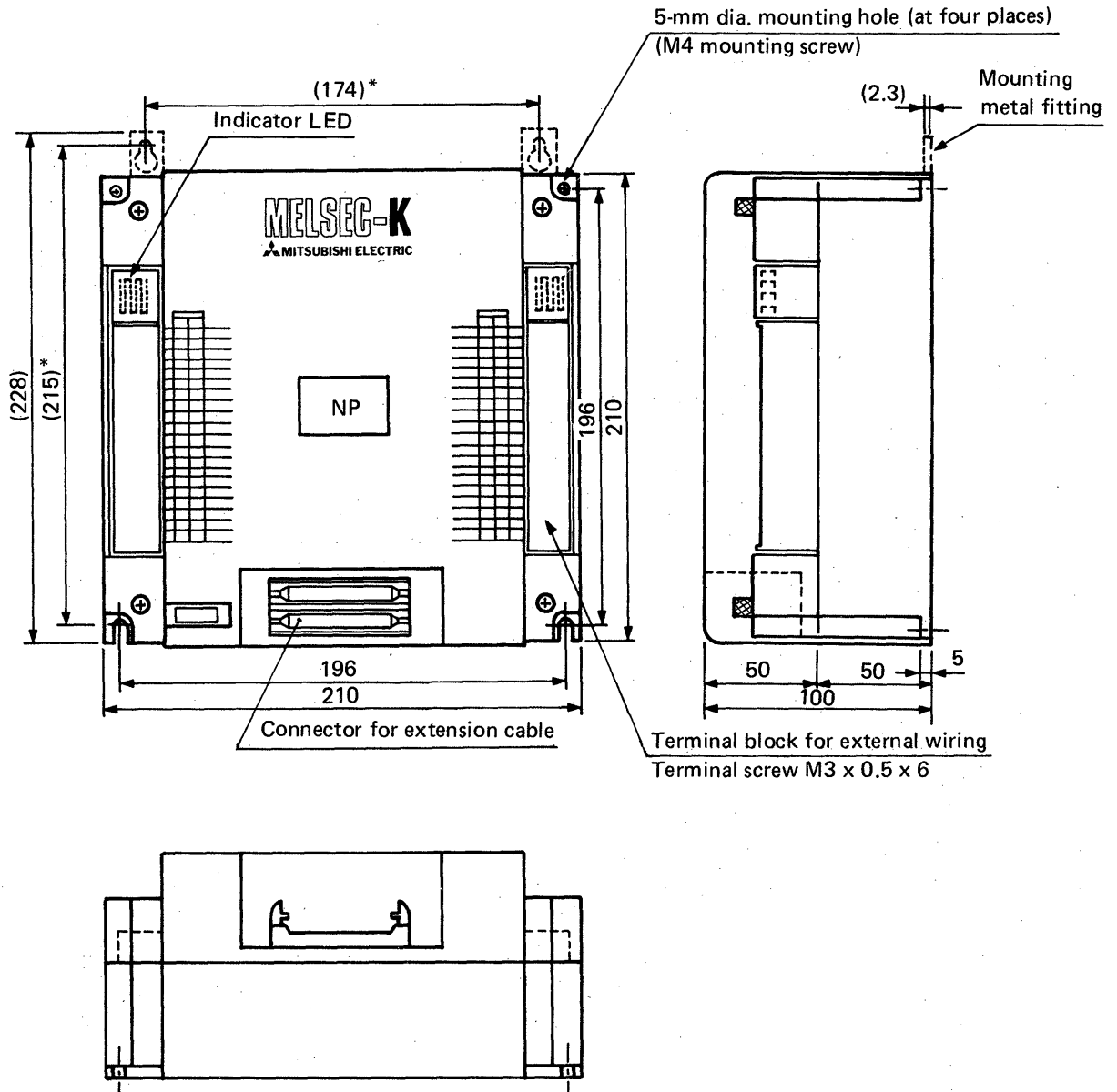


By removing two M4 flat head screws, the metal fittings can be mounted as shown above.

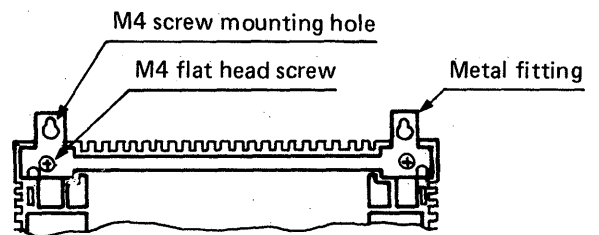
3. SPECIFICATIONS

MELSEC-K

(3) Extension unit K0J1-E32□□



*Note: Upper mounting holes can be changed to * mark by changing the mounting positions of metal fittings.*



By removing two M4 flat head screws, the metal fittings can be mounted as shown above.

MEMO

A series of horizontal dashed lines for writing a memo.

4. SYSTEM CONFIGURATION

4. SYSTEM CONFIGURATION	38 ~ 48
4.1 Independent System	38
4.1.1 Extension system by use of type K0J2-E56 extension unit	38
4.1.2 Extension System by use of Type K0J1-E32, E56 and K0J2-E56 extension units	39
4.2 Optical Data Link Unit	41
4.2.1 System configuration	41
4.2.2 Link I/O numbers	43

4. SYSTEM CONFIGURATION

4.1 Independent System

4.1.1 Extension system by use of Type K0J2-E56 extension unit

	1	2	3	4	5
Combination (Basic unit)					
(Extension unit)		<p>Extension unit setting pin (Set short-circuit pin at black position)</p>			
Number of maximum I/O points	56 points	112 points	168 points	224 points	280 points
Number of input points	32 points	64 points	96 points	128 points	160 points
Number of output points	24 points	48 points	72 points	96 points	120 points
Y numbers which can be used as temporary memory	Y numbers which are not used as output Y00~1F, Y38~BF YE0~FF, Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YE8~BF, YE0~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF8~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF8~FF Y180~19F, Y1B8~1BF, Y1E0~Y1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF8~FF Y180~19F, Y1B8~1BF, Y1F8~1FF
Loading of external failure monitor unit (K0J2-EXON)	Cannot be loaded	Can be loaded into only the unit located at the last stage.			
Optical data link	Link possible				

4

4. SYSTEM CONFIGURATION

MELSEC-K

4.1.2 Extension system by use of Type KOJ1-E32, E56 and KOJ2-E56 extension units

	1	2	3	4	5
Combination (Basic unit)					
(Extension unit)					
Number of maximum I/O points	88 points	112 points	120 points	144 points	144 points
Number of input points	48 points	64 points	64 points	80 points	80 points
Number of output points	40 points	48 points	56 points	64 points	64 points
Y numbers which can be used as temporary memory	Y numbers which are not used as output Y00~1F, Y38~9F YB0~BF, YE0~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YE0~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF0~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB0~BF, YF8~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF0~FF Y180~1BF, Y1E0~1FF
Loading of external failure monitor unit (KOJ2-EXON)	Cannot be loaded	Can be loaded into only the unit located at the last stage (KOJ1-E56)	Cannot be loaded	Can be loaded into only the unit located at the last stage (KOJ1-E56)	Cannot be loaded
Optical data link	Link possible				

4. SYSTEM CONFIGURATION

	6	7	8	9	10
Combination (Basic unit)					
(Extension unit)					
Number of maximum I/O points	168 points	200 points	224 points	200 points	224 points
Number of input points	96 points	112 points	128 points	112 points	128 points
Number of output points	72 points	88 points	96 points	88 points	96 points
Y numbers which can be used as temporary memory	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF8~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB0~BF, YF8~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF8~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF0~FF Y180~1BF, Y1E0~1FF	Y numbers which are not used as output Y00~1F, Y38~9F YB8~BF, YF8~FF Y180~1BF, Y1E0~1FF
Loading of external failure monitor unit (KOJ2-EXON)	Can be loaded into only the unit located at the last stage (KOJ1-E56)	Cannot be loaded	Can be loaded into only the unit located at the last stage (KOJ1-E56)	Cannot be loaded	Can be loaded into only the unit located at the last stage (KOJ1-E56)
Optical data link	Link possible			Link impossible as remote I/O unit	
Caution	<ol style="list-style-type: none"> The setting order of setting switches is different from the connecting order of extension units. The allocating order of I/O numbers is the same as the setting order of setting switches. Only one unit of Type KOJ1-E32 or E56 extension unit can be used. For other two units, use Type KOJ2-E56 extension unit. 				

4. SYSTEM CONFIGURATION

4.2 Optical Data Link System

4.2.1 System configuration

Using the K3CPU or KGPC as a master channel, a data link system can be constructed by optical fiber cables.

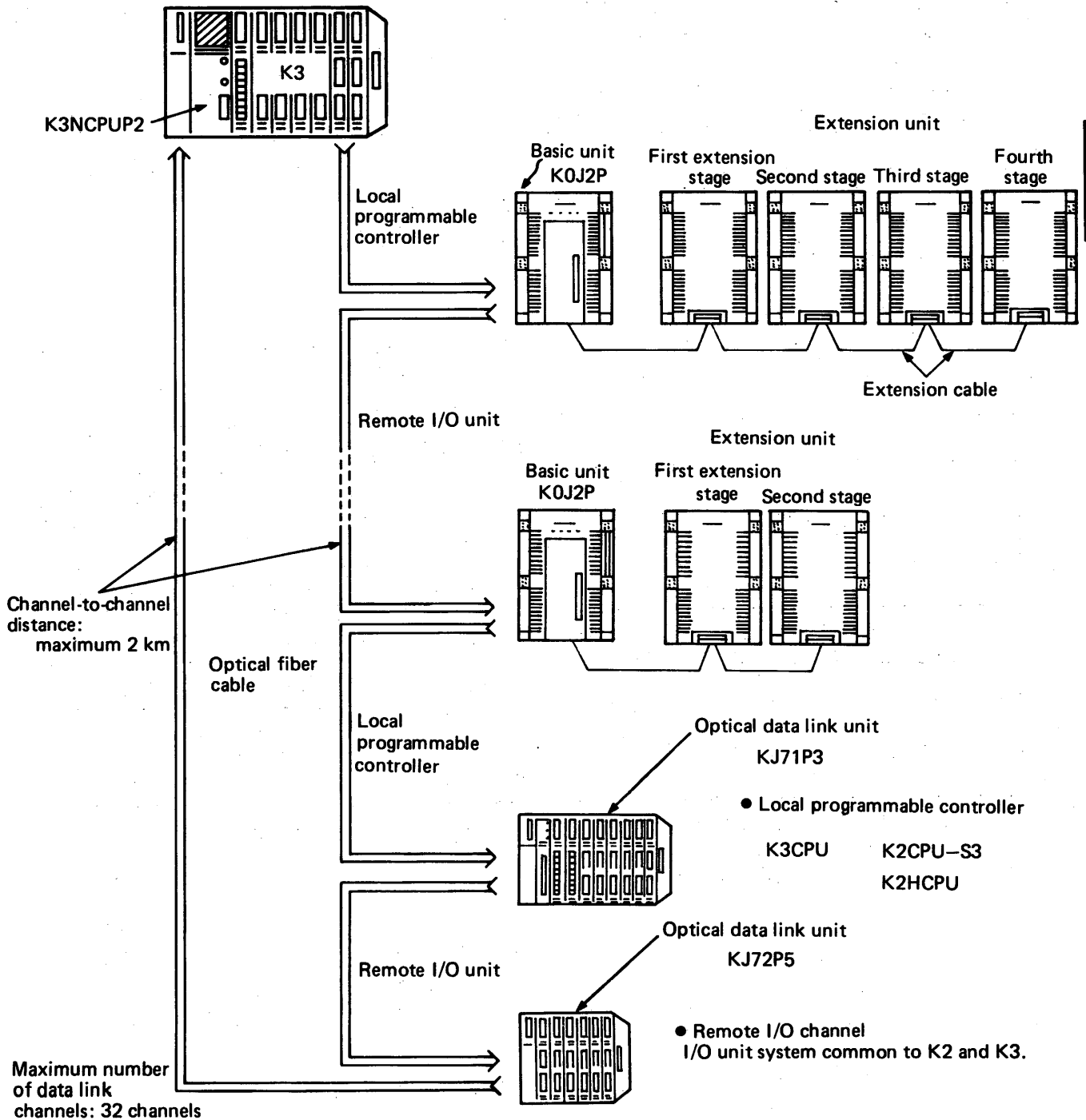


Fig. 4.1 Optical Data Link System Configuration Example

4. SYSTEM CONFIGURATION

- 1) A maximum of 32 channels can be linked as the slave channels (local programmable controllers) of a local programmable controller system which is designed to expand the total number of inputs/outputs and for integrated management and decentralized control.
- 2) A maximum of 32 channels can be linked as the slave channels (remote I/O units) of a remote I/O system which is designed to reduce long-distance I/O wiring work expenses.
- 3) A maximum of 32 channels can be linked, with the local programmable controllers and remote I/O units used together in the system.
- 4) The system can be linked with a local programmable controller which is composed of K3CPU, K2CPU-S3 or K2HCPU system (loaded with Type KJ71P3 data link unit).
- 5) The system can be linked with a remote I/O unit (loaded with Type KJ72P5 data link unit) which is composed of I/O units used commonly for K1, K2 and K3.
- 6) The channel-to-channel distance (optical fiber transmission route) is maximum 2 km.

*Note: When the K3 is utilized as a master channel, use Type K3CPUP2 CPU unit.
When the KGPC is utilized as a master channel, load Type K30LU1P2 link unit into the KGPC unit.*

Master programmable controller	K3	Number of X link points	Maximum 2048 points (X000 ~ 7FF)
		Number of Y link points	Maximum 2048 points (Y000 ~ 7FF)
	KGPC	Number of X link points	Maximum 2032 points (X000 ~ 7EF)
		Number of Y link points	Maximum 2032 points (Y000 ~ 7EF)
Local programmable controller* (K0J2P)	Number of X link points	Maximum 128 points (X100 ~ 17F)	
	Number of Y link points	Maximum 128 points (Y100 ~ 17F)	
Remote I/O unit (K0J2P)	Number of X link points	Maximum 160 points	
	Number of Y link points	Maximum 120 points	

Note: () the link I/O number of local programmable controller K0J2P are allotted separately from its own I/O numbers.*

Table 4.1 Number of Link Points and Link I/O Numbers

4. SYSTEM CONFIGURATION

4.2.2 Link I/O numbers

(1) KOJ2P is used as a local programmable controller

1) System configuration example

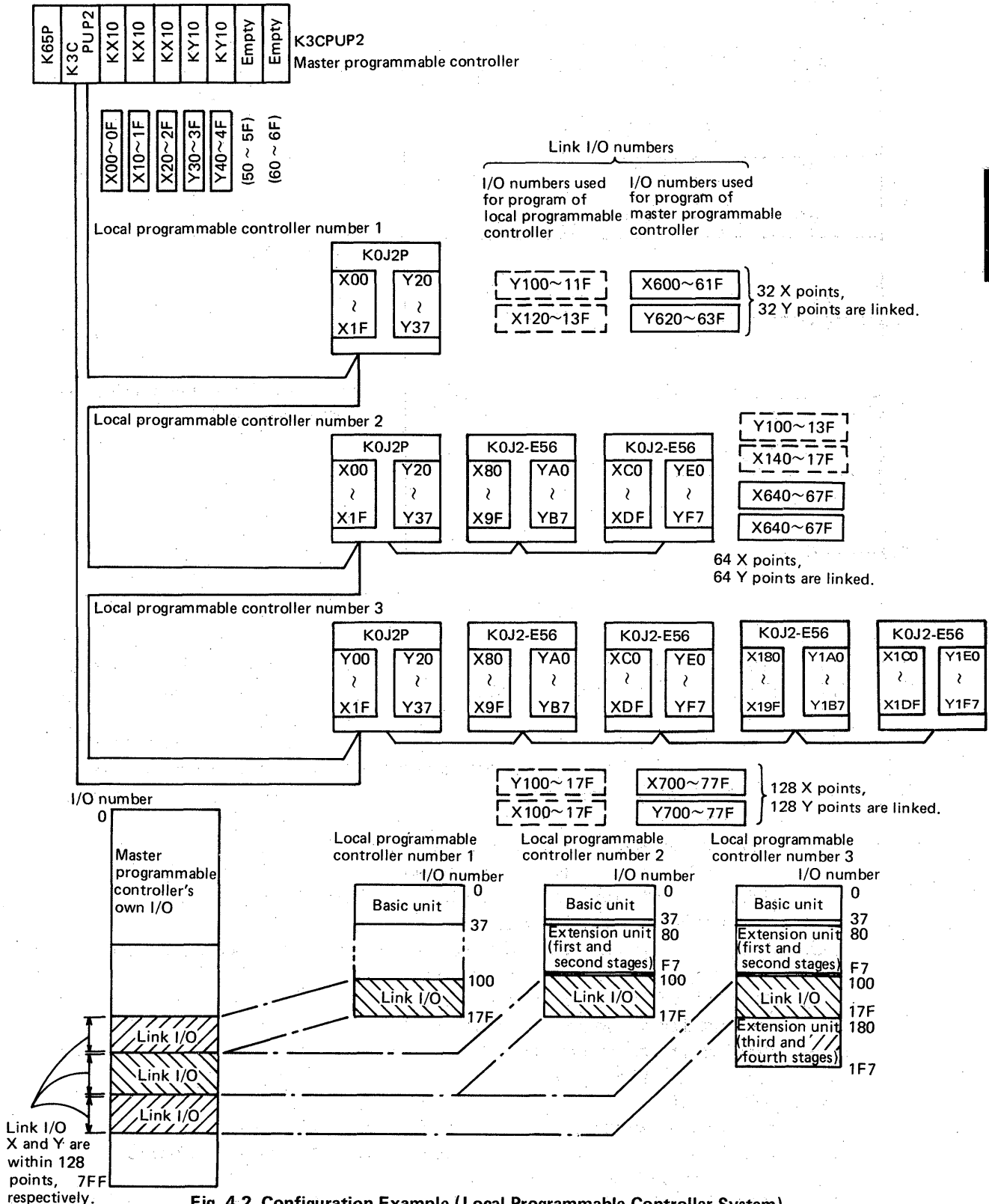


Fig. 4.2 Configuration Example (Local Programmable Controller System)

2) Link range designation: link range is specified by initial program.

Write the initial program at the beginning of the program of master programmable controller.

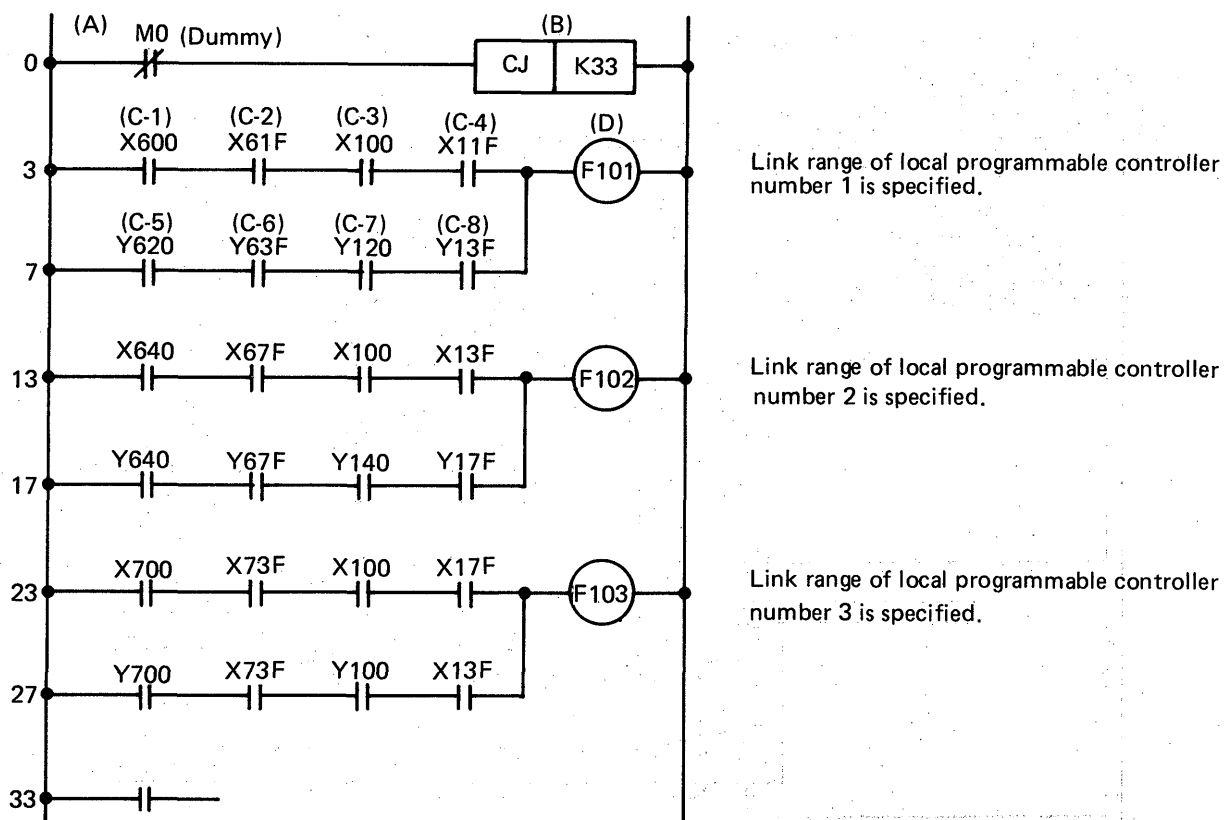


Fig. 4.3 Initial Program Example

- Note: (A) M0: Be sure to write a temporary memory M which is not used (dummy).
 (B) CJ K33: The jump destination of CJ (K33) should be the step number next to the last OUT F.
 (C-1) X600 is the head number of input signal from the programmable controller number 1 as seen from the master programmable controller. Use care so that this head number does not overlap the final number assigned to the master programmable controller.
 (C-2) X61F is the final number of input signal from the programmable controller number 1 as seen from the master programmable controller. The last digit of head number should be "0" and that of final number should be "F". (Be sure to specify these numbers in units of 16 points.)
 (C-3) X100 is the link head number corresponding to the link output number Y100 of local programmable controller number 1.
 (C-4) X11F is the link final number corresponding to the link output number Y11F of local programmable controller number 1.
 (C-5) Y620 is the head number of output signal to the local programmable controller number 1 as seen from the master programmable controller.
 (C-6) Y63F is the final number of output signal to the local programmable controller number 1 as seen from the master programmable controller.
 (C-7) Y120 is the link head number corresponding to the link input number X120 of local programmable controller number 1.
 (C-8) Y13F is the link final number corresponding to the link input number X13F of local programmable controller number 1.

(D) F101: The lower one digits of F101 indicates the local programmable controller number 1. In regards to number 2 and succeeding programmable controllers, specify in serial numbers like F102, F103,

I/O numbers used for master programmable controller	Handled by master programmable controller link card as below	I/O numbers used for local programmable controller
X600 ~ 61F ← Y620 ~ 63F →	X100 ~ 11F ← Y120 ~ 13F →	Y100 ~ 11F (output) Number 1 X120 ~ 13F (input)
X640 ~ 67F ← Y640 ~ 67F →	X100 ~ 13F ← Y140 ~ 17F →	Y100 ~ 13F (output) Number 2 X140 ~ 17F (input)
X700 ~ 77F ← Y700 ~ 77F →	X100 ~ 17F ← Y100 ~ 17F →	Y100 ~ 17F (output) Number 3 X100 ~ 17F (input)

Table 4.2 Link I/O Numbers

3) Data register link

When the K0J2P is used as a local programmable controller (local programmable controller system) data registers (D) can be linked in addition to the data link of X/Y between the master and local channels.

Link data registers	D0 ~ D95 (96 points)
Number of simultaneous link points	Maximum 24 points

Note: For details, see the "Instruction Manual for Optical Data Link System" for the master programmable controller.

4. SYSTEM CONFIGURATION

(4) KOJ2P is used as remote I/O unit

1) System configuration example

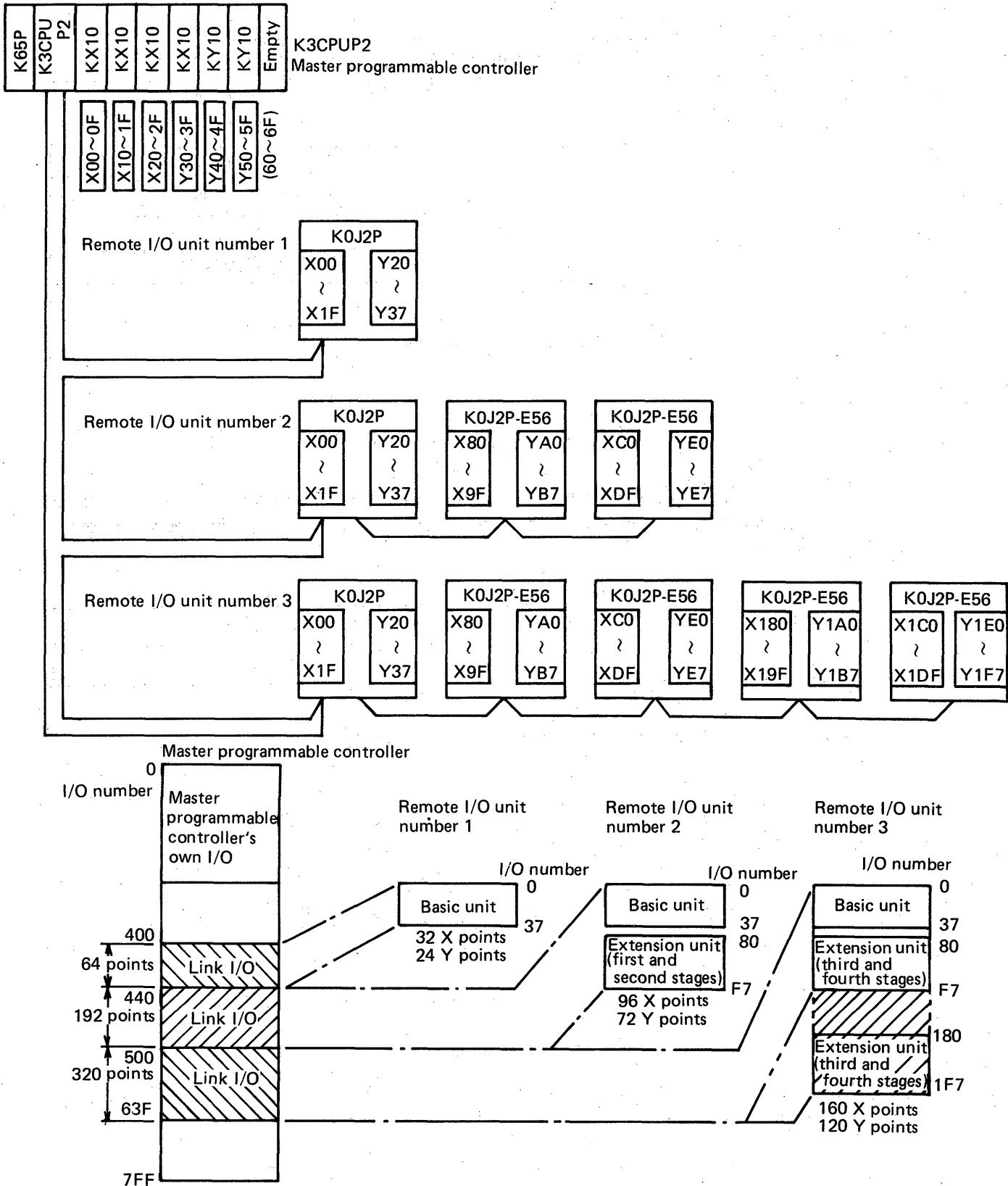


Fig. 4.4 Configuration Example (Remote I/O System)

2) Link range designation

Specify the link range by the initial program of master programmable controller in units of 32 points for each of the basic units and extension units, as indicated in the following table, depending on the remote I/O system configuration.

Therefore, any of the basic units and 32-point and 56-point extension units exclusively uses 32 I/O points (addresses) per unit.

Remote I/O Unit Configuration	Link Range Designation
Only basic unit (K0J1PE)	X0 ~ X1F, Y0 ~ Y1F
Basic unit + extension unit (first stage)	X0 ~ X3F, Y0 ~ Y3F
Basic unit + extension units (first and second stages)	X0 ~ X5F, Y0 ~ Y5F
Basic unit + extension units (first ~ third stages)	X0 ~ X7F, Y0 ~ Y7F
Basic unit + extension units (first ~ fourth stages)	X0 ~ X9F, Y0 ~ Y9F

Note that there are no real addresses for eight points of Y of basic unit and 56-point extension unit, and 16 points of X and Y of 32-point extension unit, respectively, in regards to the remote I/O unit.

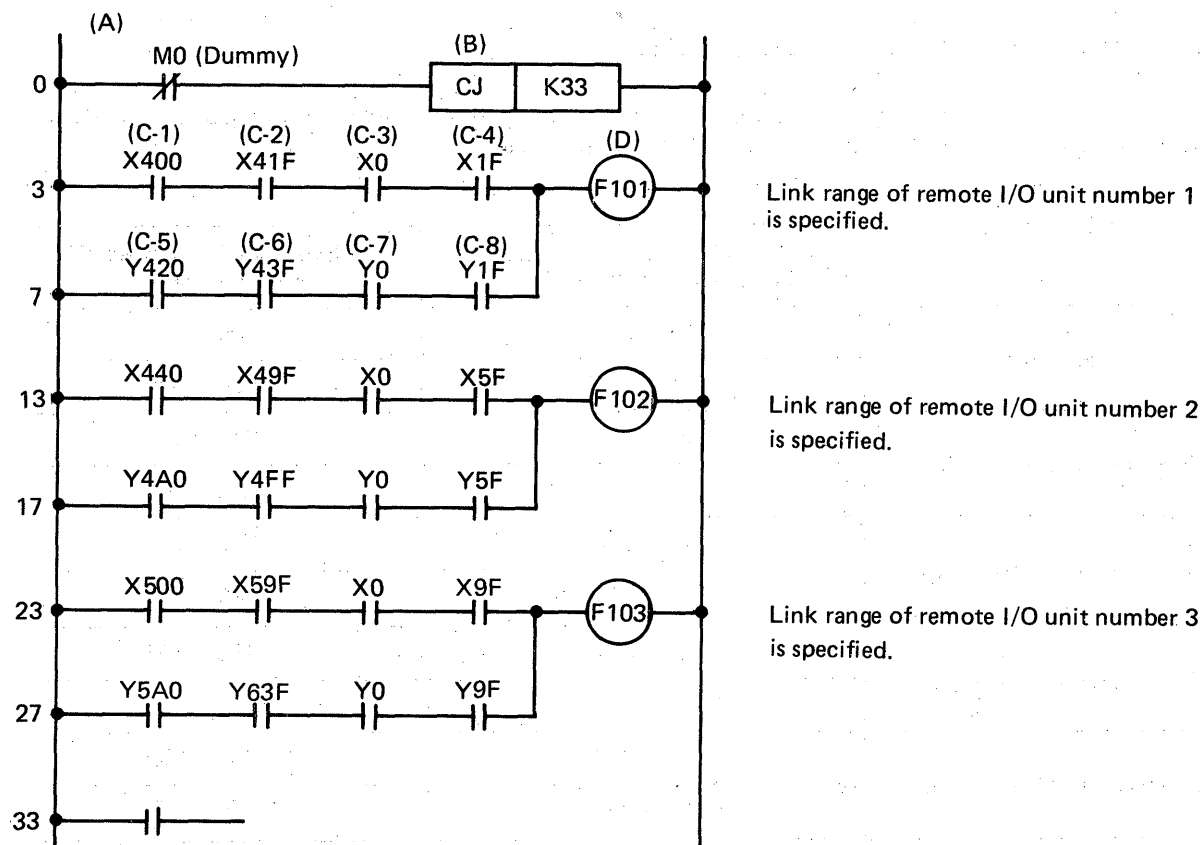


Fig. 4.5 Initial Program Example

4. SYSTEM CONFIGURATION

MELSEC-K

- Note: (A) M0: Be sure to write a temporary memory M which is not used (dummy).
- (B) CJ K33: The jump destination of CJ (K33) should be the step number next to the last OUT F.
- (C-1) X400 is the head number of input signal from the remote I/O unit number 1 as seen from the master programmable controller. Use care so that this head number does not overlap the final number assigned to the master programmable controller.
- (C-2) X41F is the final number of input signal from the remote I/O unit number 1 as seen from the master programmable controller.
- (C-3) Write X0 according to the regular format.
- (C-4) X1F indicates that the remote I/O unit number 1 is consists of only the basic unit.
- (C-5) Y420 is the head number of output signal to the remote I/O unit number 1 as seen from the master programmable controller. This head number should be a number which is equal to or higher than the head number of input signal.
- (C-6) Y43F is the final number of output signal to the remote I/O unit number 1 as seen from the master programmable controller.
- (C-7) Write Y0 according to the regular format.
- (C-8) Y1F indicates, like X1F, that the remote I/O unit number 1 is consists of only the basic unit.
- (D) F101: The lower one digits of F101 indicates the local programmable controller number 1. In regards to number 2 and succeeding programmable controllers, specify in serial numbers like F102, F103,

The X link range [(C-1) ~ (C-2)] and the Y link range [(C-5) ~ (C-6)] of master programmable controller may overlap each other. However, the head numbers of X and Y should be the same or X should be lower than Y [(C-1) ≤ (C-5)].

The I/O numbers used by the master programmable controller, which correspond to the existing I/O signals of remote I/O unit number 3, are as follows:

	I/O Numbers Used by Master Programmable Controller	Existing I/O Numbers of Remote I/O Unit
Basic unit	X500 ~ 51F	X00 ~ 1F
	Y5A0 ~ 5B7	Y20 ~ 37
Extension unit First stage	X520 ~ 53F	X80 ~ 9F
	Y5C0 ~ 5D7	YA0 ~ B7
Extension unit Second stage	X540 ~ 55F	XC0 ~ DF
	Y5E0 ~ 5F7	YE0 ~ F7
Extension unit Third stage	X560 ~ 57F	X180 ~ 19F
	X600 ~ 617	Y1A0 ~ 1B7
Extension unit Fourth stage	X580 ~ 59F	X1C0 ~ 1DF
	Y620 ~ 637	Y1E0 ~ 1F7

5. HANDLING

5. HANDLING	49 ~ 72
5.1 Nomenclature and Explanation	50
5.1.1 Basic unit	50
5.1.2 Extension units (K0J2-E56, K0J1-E32)	52
5.2 Loading	55
5.2.1 Loading procedure	55
5.2.2 Memory loading and setting	56
5.2.3 Setting of extension unit number	57
5.2.4 Loading of extension power supply unit	58
5.2.5 Loading of battery	58
5.2.6 Connection of extension cable	59
5.2.7 Connection of optical cable	60
5.2.8 Mounting to panel	61
5.2.9 Wiring	62
5.2.10 Troubles and corrective actions of I/O circuits	65
5.3 Operating Procedures	69
5.3.1 Test run flow chart	69
5.3.2 Daily operation	70
5.3.3 Error code list	72

5. HANDLING

5.1 Nomenclature and Explanation

5.1.1 Basic unit

(1) Front view of basic unit

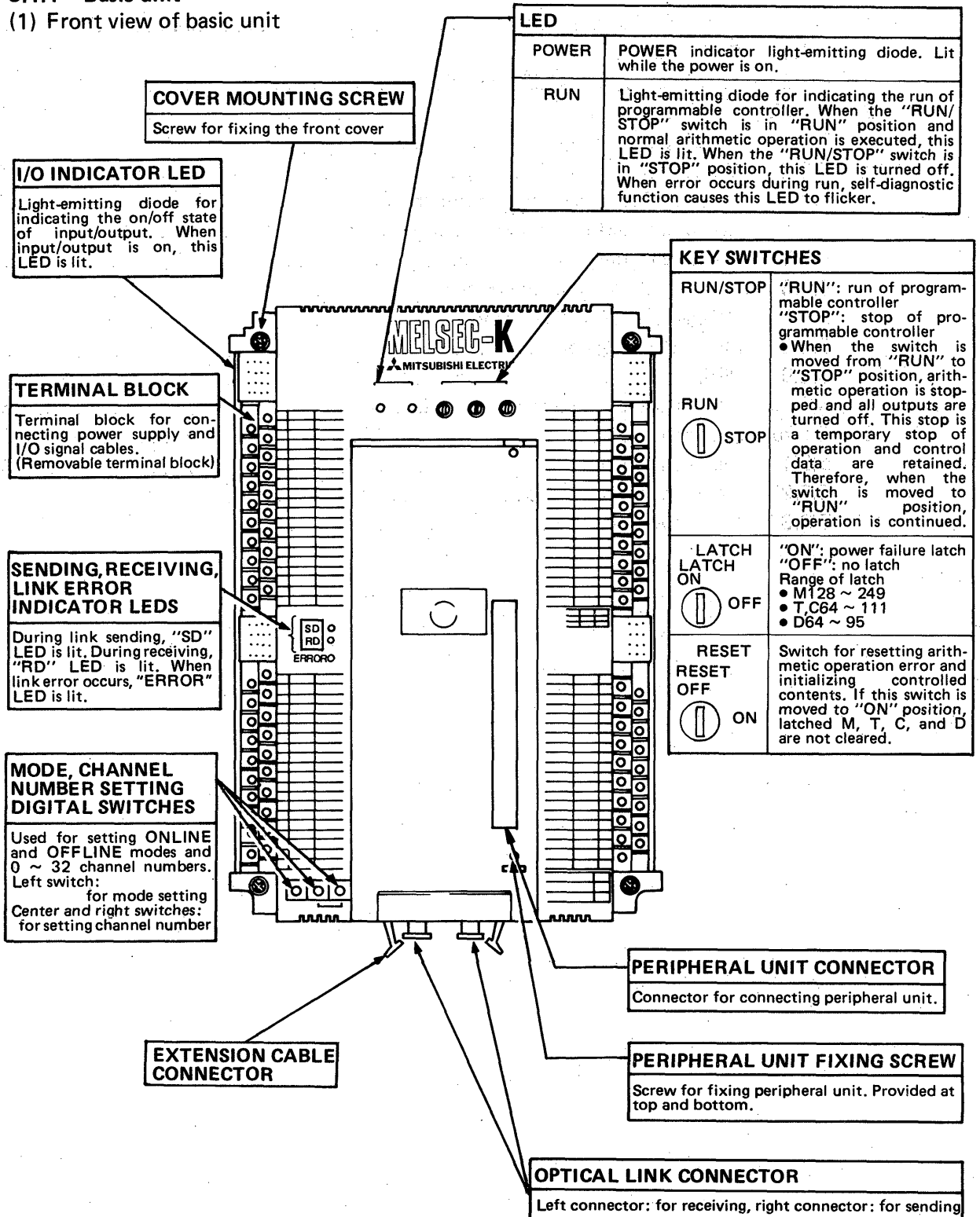
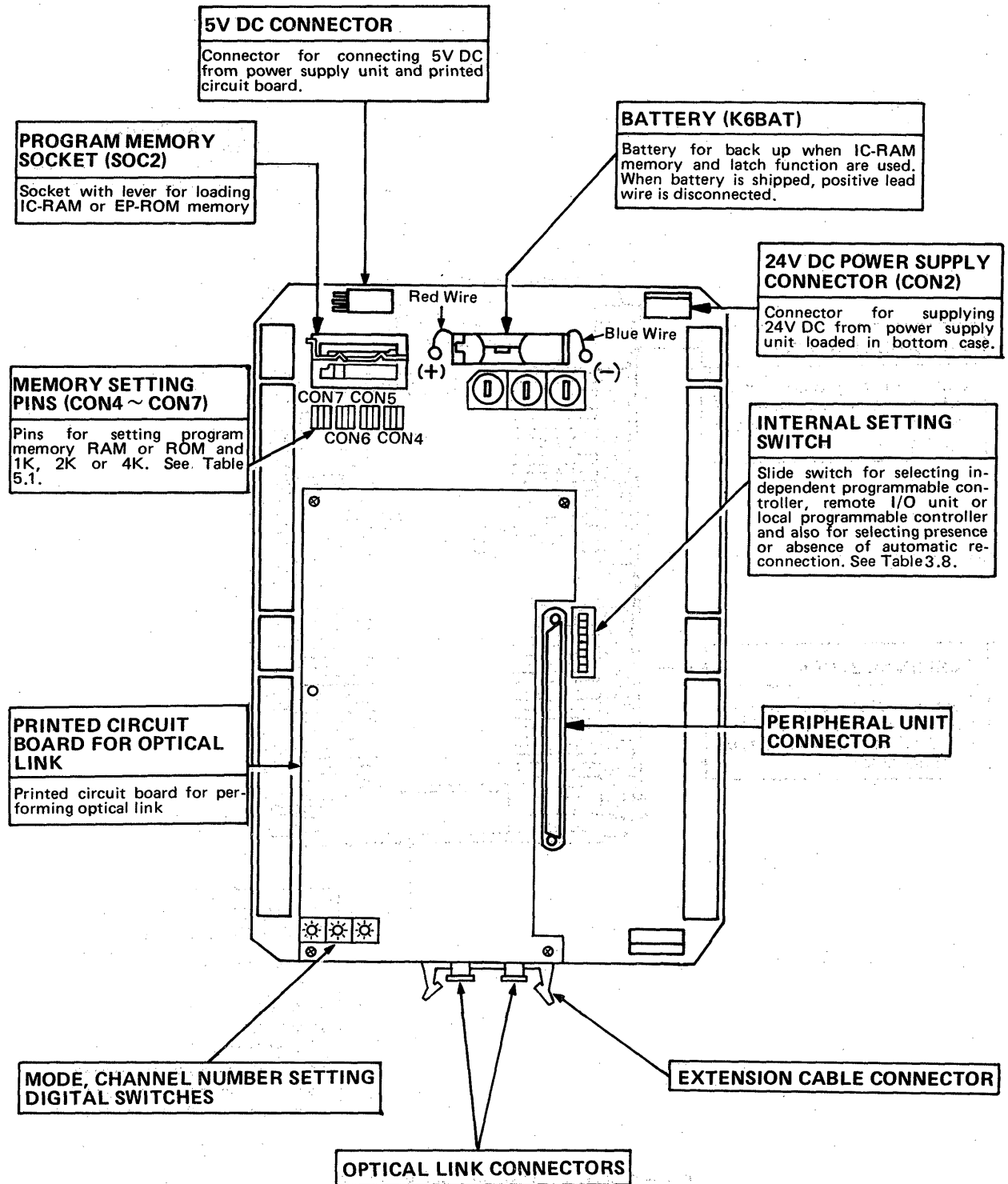


Fig. 5.1 External View of Basic Unit

5. HANDLING

(2) Internal Configuration of Basic Unit



5. HANDLING

MELSEC-K

5.1.2 Extension units (K0J2-E56, K0J1-E32)

(1) External view of Type K0J2-E56

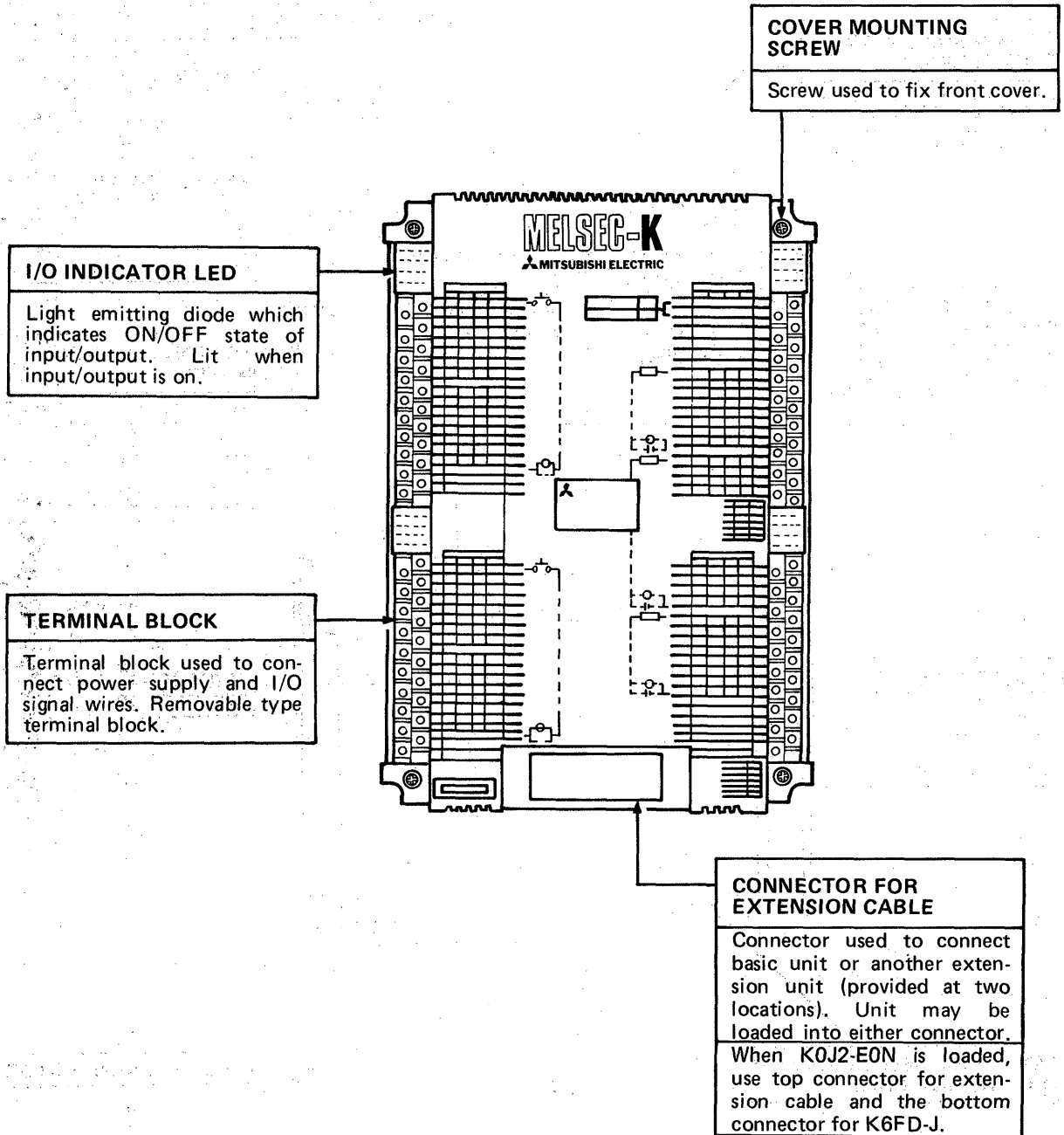


Fig. 5.3 External View of Type K0J2-E56

(2) Internal view of Type K0J2-E56

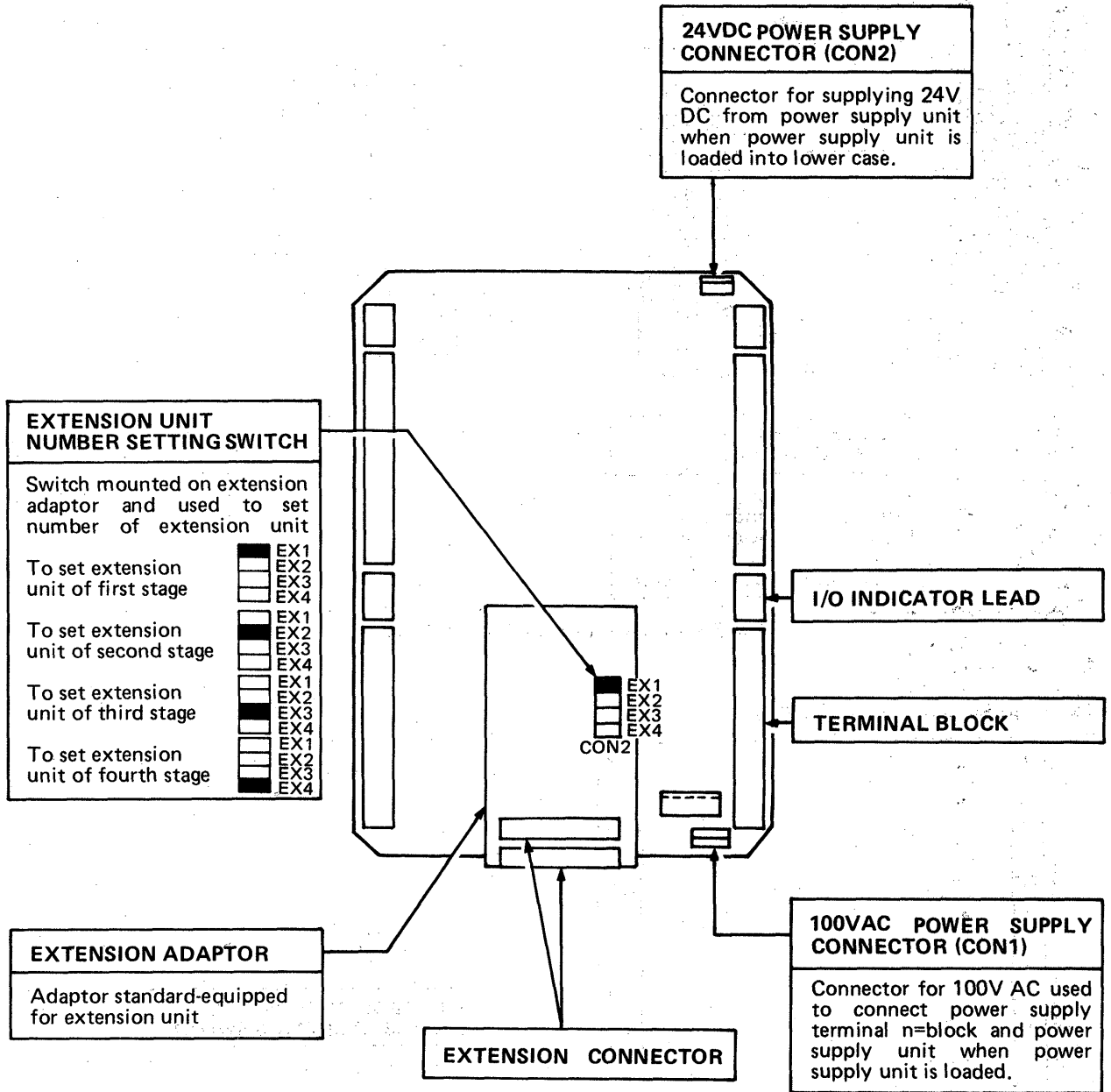


Fig. 5.4 Internal View of Type K0J2-E56

(3) External view of Type K0J1-E32

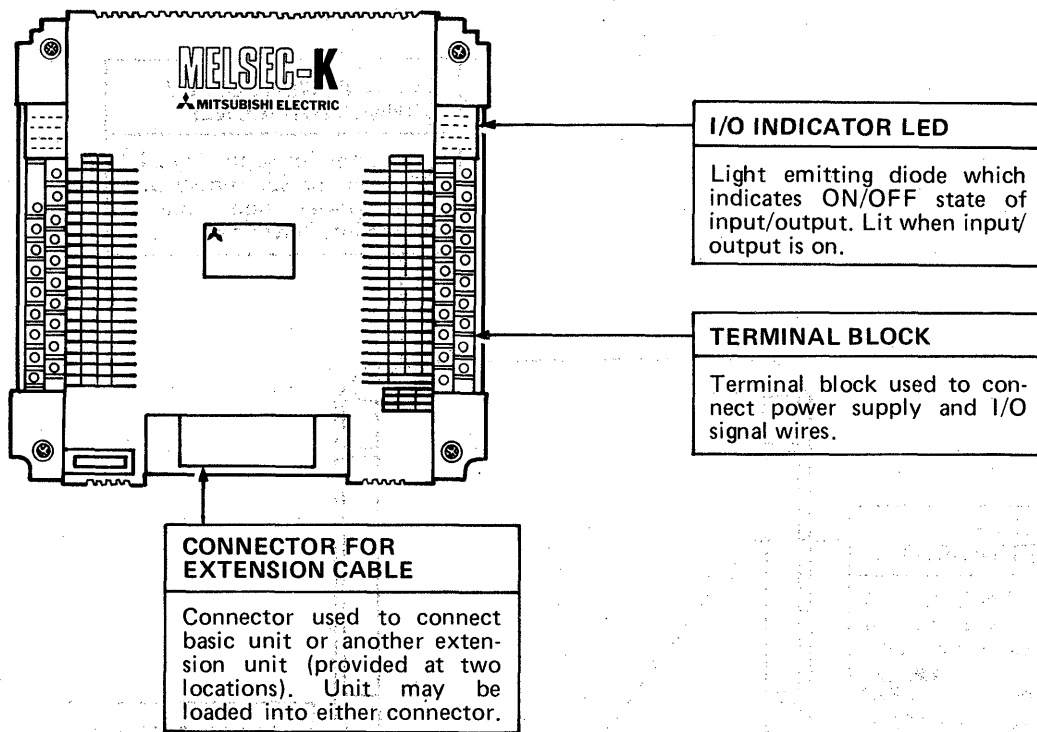
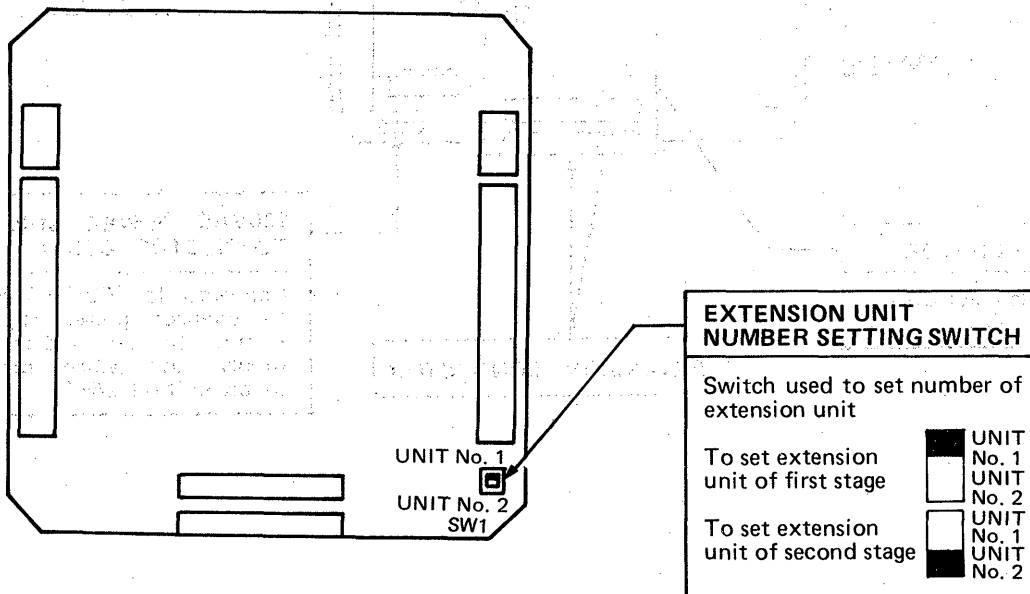


Fig. 5.5 External View of Type K0J1-E32

(4) Internal view of Type K0J1-E32

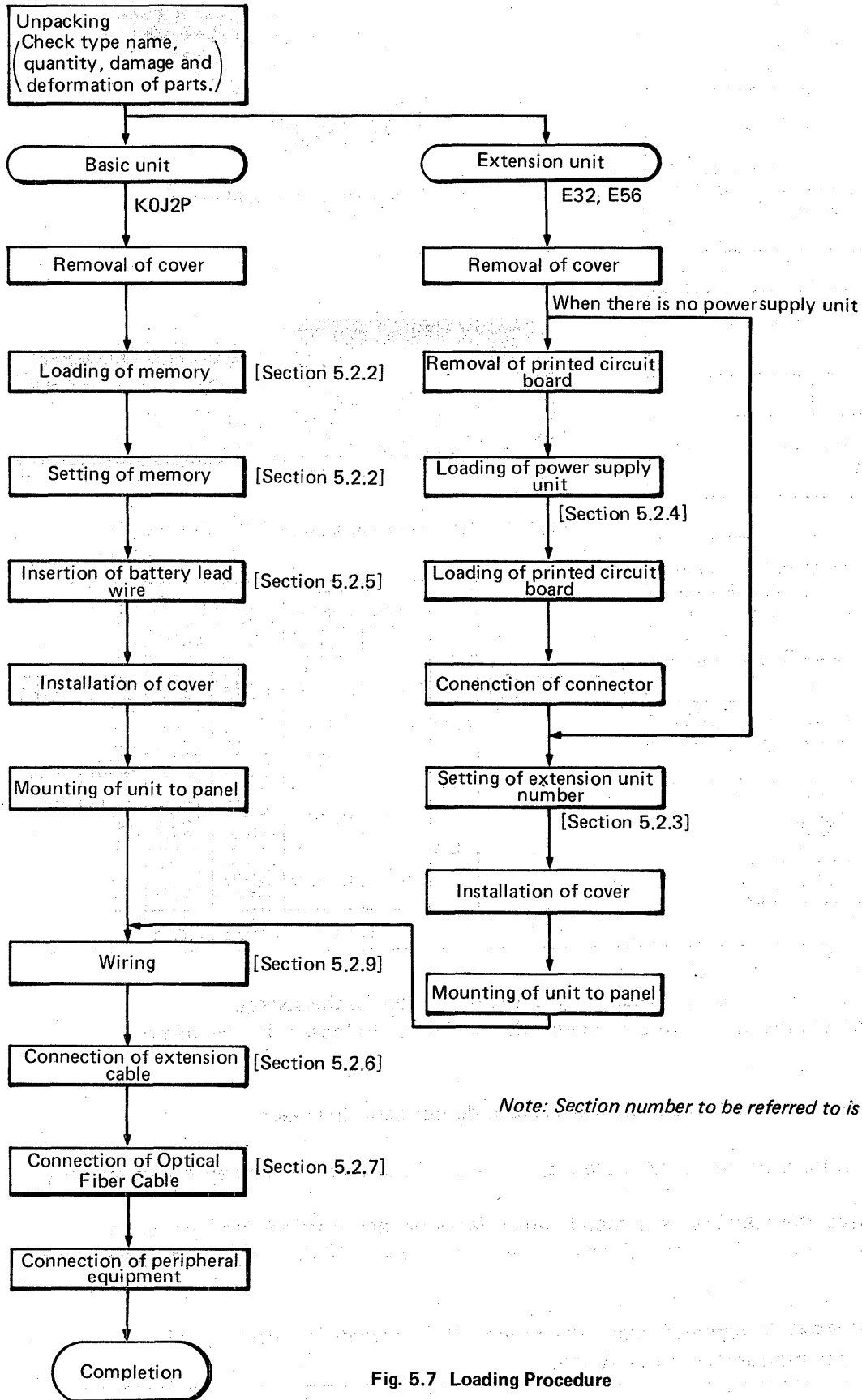


*The position of extension unit number setting switch depends on I/O specifications. (The figure shows the switch position for Type "AR".)

Fig. 5.6 Internal View of Type K0J1-E32

5.2 Loading

5.2.1 Loading procedure



Note: Section number to be referred to is shown in brackets.

Fig. 5.7 Loading Procedure

5.2.2 Memory loading and setting

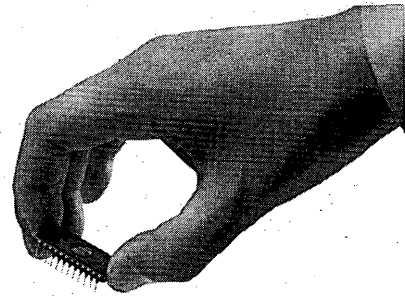
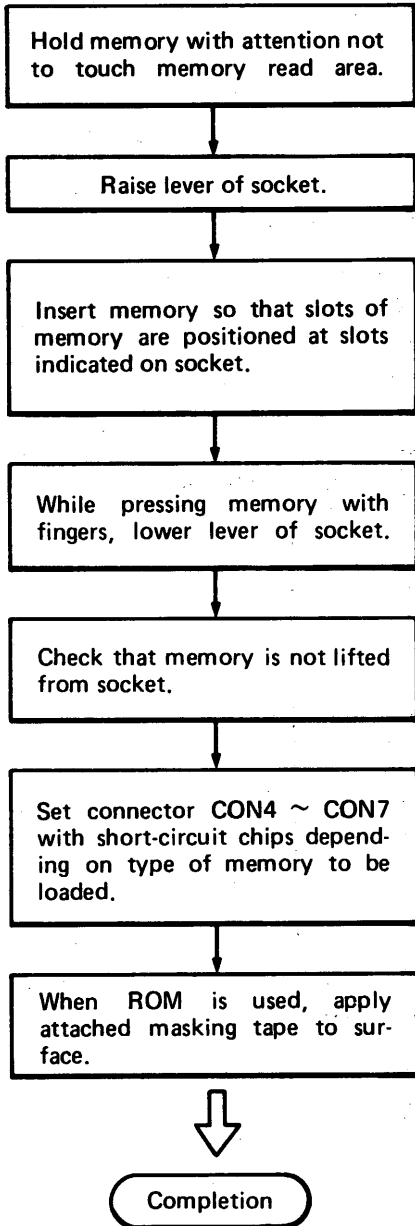


Fig. 5.9 How to Hold Memory

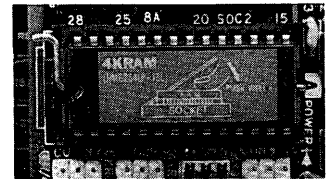
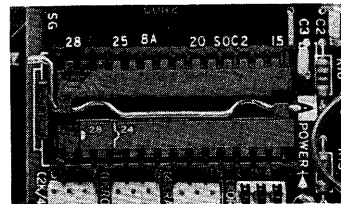


Fig. 5.10 Before Loading Memory Fig. 5.11 After Loading Memory (4KRAM)

	Number of Steps	Memory Loaded into Socket	Connector Type and Setting			
			CON7	CON6	CON5	CON4
RAM	1024	Standard-equipped RAM for 1K step				
	4096	4KRAM				
ROM	2048	2KROM				
	4096	4KROM				

(*Factory-set position)

Table 5.1 Setting of Memory

CAUTION

1. Be sure to load the memory according to the indication on the socket. Snugly fit the memory into the socket. Be careful not to loosely fit the memory into the socket.
2. Do not touch the read area of memory. Also, do not bend the reads.
3. Be sure to store the memory in the case which has been used for the delivery of memory.
4. Never place the memory on a metal, which leaks or may possibly leak, or on an object which is charged with static electricity, such as wood, plastic, vinyl, fiber, cable, and paper.
5. If the IC-RAM is removed from the socket, the contents of memory will be erased. Therefore, caution should be exercised.

5

5.2.3 Setting of extension unit number

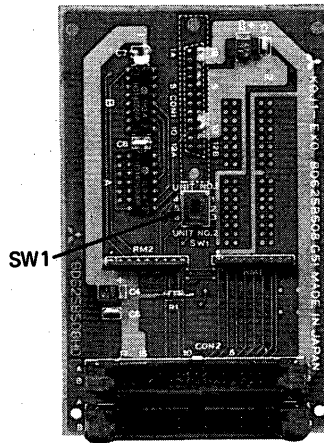
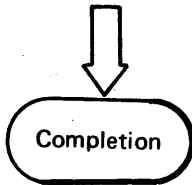
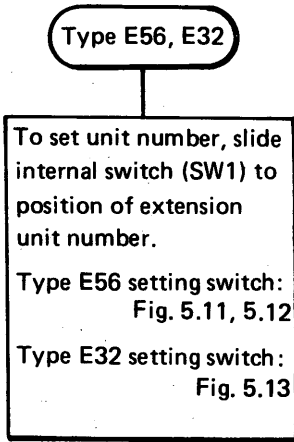


Fig. 5.11 Type K0J1-E56 Setting Switch

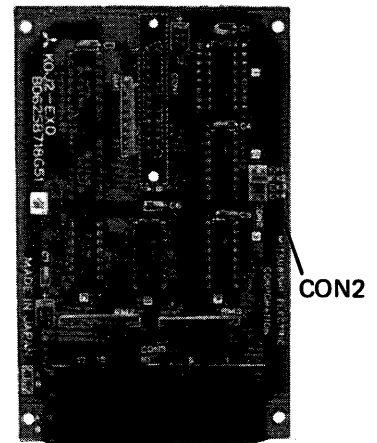


Fig. 5.12 Type K0J2-E56 Setting Switch

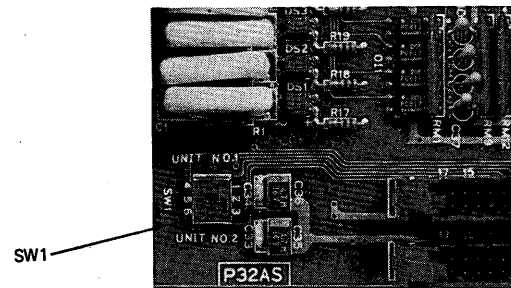


Fig. 5.13 Type K0J1-E32 Setting Switch

Setting of Extension Unit and Base Numbers

	Type K0J1-E56	Type K0J2-E56	Type K0J1-E32
Detail of setting switch	<p>UNIT No. 1</p> <p>UNIT No. 2</p>	<p>EX1</p> <p>EX2</p> <p>EX3</p> <p>EX4</p> <p>CON2</p>	<p>UNIT No. 1</p> <p>UNIT No. 2</p>
Setting	<p>For first extension stage</p> <p>UNIT No. 2</p> <p>For second extension stage</p> <p>UNIT No. 2</p>	<p>For first extension stage</p> <p>EX1</p> <p>For second extension stage</p> <p>EX2</p> <p>For third extension stage</p> <p>EX3</p> <p>For fourth extension stage</p> <p>EX4</p>	<p>For first extension stage</p> <p>UNIT No. 2</p> <p>For second extension stage</p> <p>UNIT No. 2</p>

*:Black area indicates the setting position of slide switch.

5.2.4 Loading of extension power supply unit

Load power supply unit into Type E56 extension unit case and tighten and fix it with four fixing screws.

Connect 24VDC connector with lead wire (Fig. 5.14 ①) to 24VDC/24GDC connector (CON2) of I/O printed circuit board so that red wire is located on 24VDC side.

Connect 5V DC connector with lead wire (Fig. 5.14 ②) to connector of power supply unit (CON1) so that blue wire is located on top side.

Connect 100VDC connector with lead wire to 100VAC/FG (Fig. 5.14 ③) connector (CON1) of I/O printed circuit board so that green wire is located on FG side.

Completion

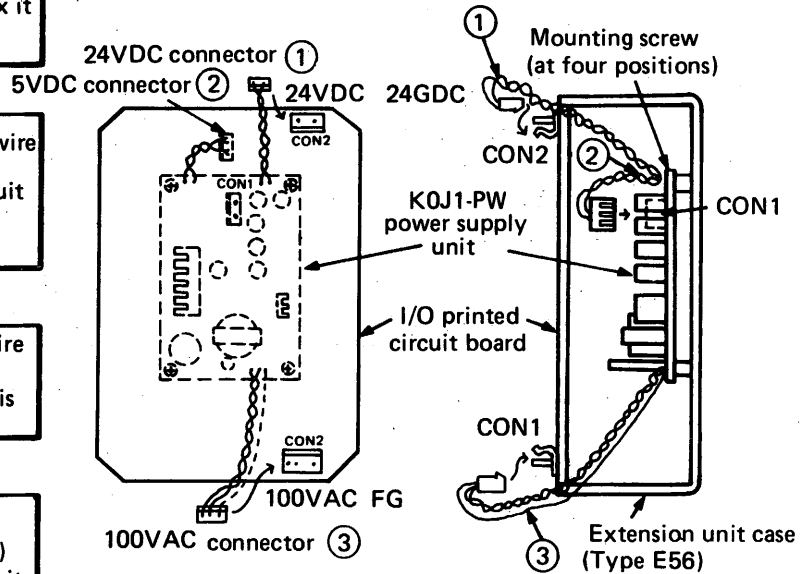


Fig. 5.14 Loading Procedure of Power Supply Unit to Type E56

5.2.5 Loading of battery

To newly use CPU

To change battery

Check polarity and load battery.

Insert lead wire, which is provided for positive pole of battery, into connector (CON3). (Positive red lead)

Insert lead wires, which are provided for battery, into connectors (CON2, CON3). (Positive red lead wire)

Completion

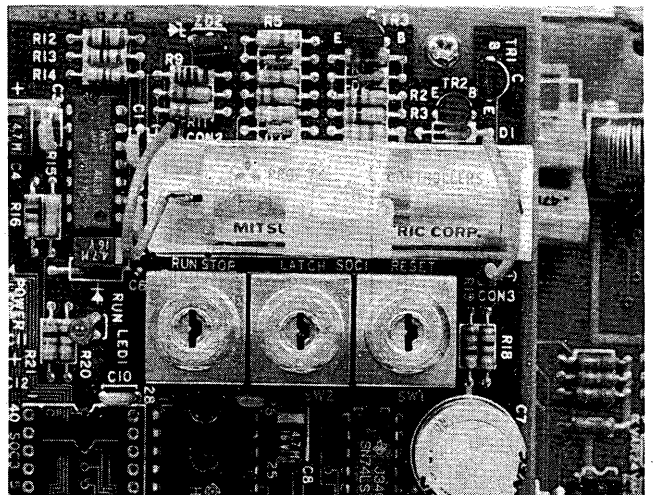
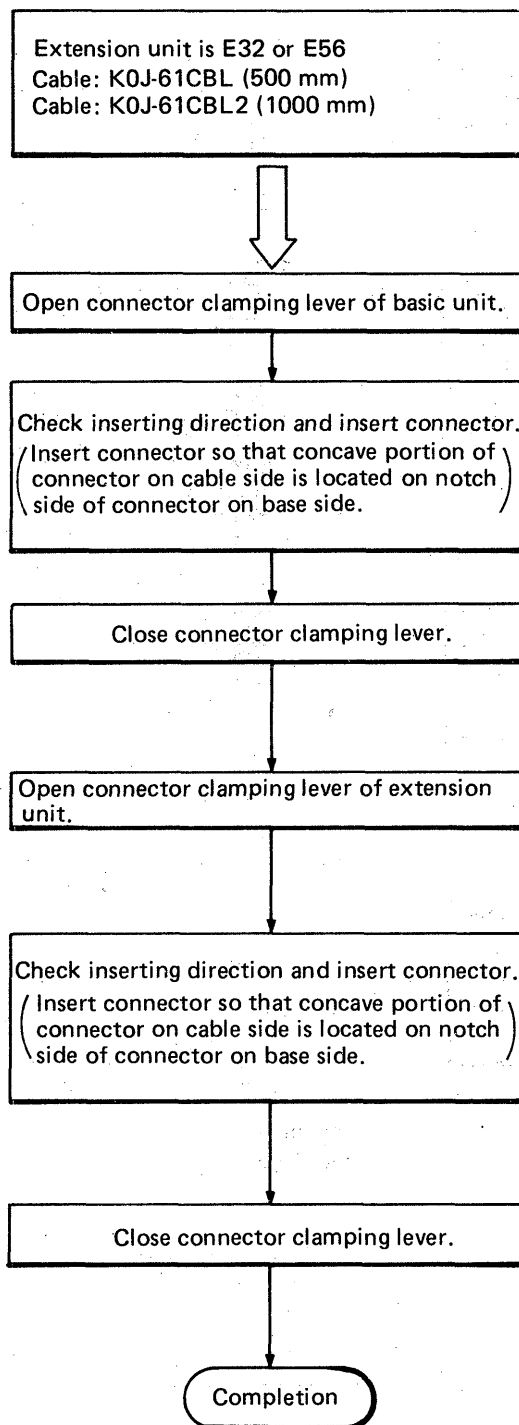


Fig. 5.15 Loading of Battery

CAUTION

- To prevent the battery from being consumed, the positive lead wire of battery is disconnected at the time of shipment. When the memory is IC-RAM or even when it is EP-ROM, connect the lead wire when power failure backup is required.
- Change the battery within 15 minutes.

5.2.6 Connection of extension cable

**CAUTION**

1. Although the extension unit and extension base have two connectors, respectively, the cable may be connected to either of the connectors.

5. HANDLING

MELSEC-K

5.2.7 Connection of optical cables

Remove the white cap mounted on the connector for optical link of KOJ2P.

Remove the white cap mounted on the connector of optical cable coming from master channel or another slave channel. (The white cap is of thread-in type.)

Insert the optical cable, which comes from the sending side of another channel, into the receiving side (left side) connector of KOJ2P and thread it in to fix it.

Insert the optical cable, which comes from the receiving side of another channel, into the sending side (right side) connector of KOJ2P and thread it in to fix it.

Completion

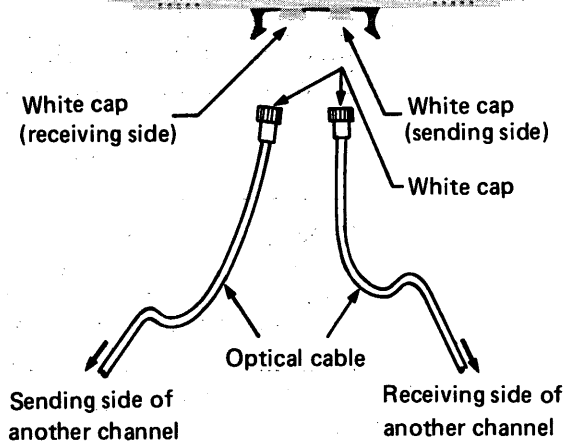
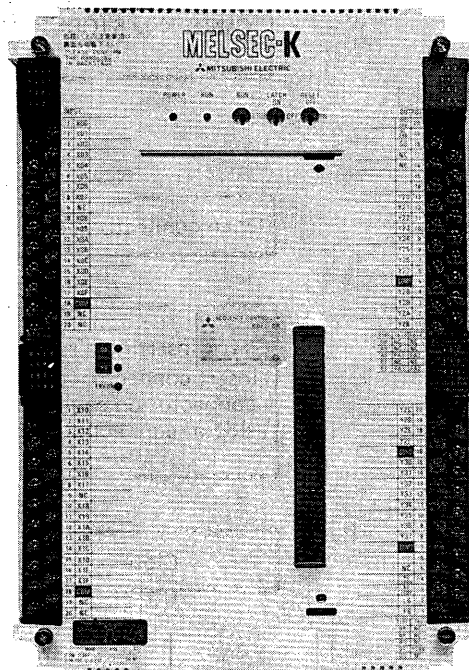


Table 5.16 Connection of Optical Cables

CAUTION

1. Do not directly touch the connecting portion of optical cable with finger.
2. Connect the optical cables with care not to mistake the sending side for the receiving side and vice versa.
3. Do not forcibly bend, compress, twist, pull or stamp the optical cable.

5.2.8 Mounting to panel

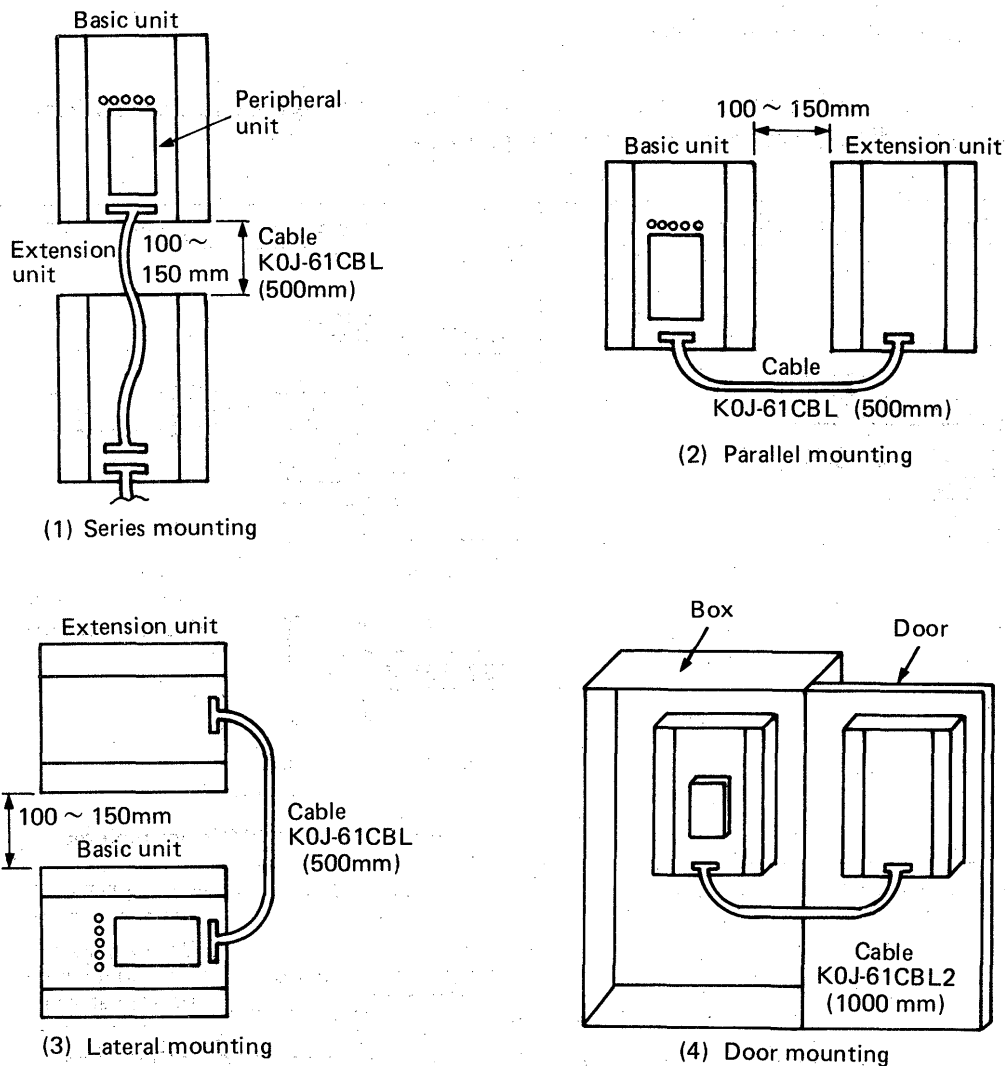


Fig. 5.17 Mounting Methods of K0J

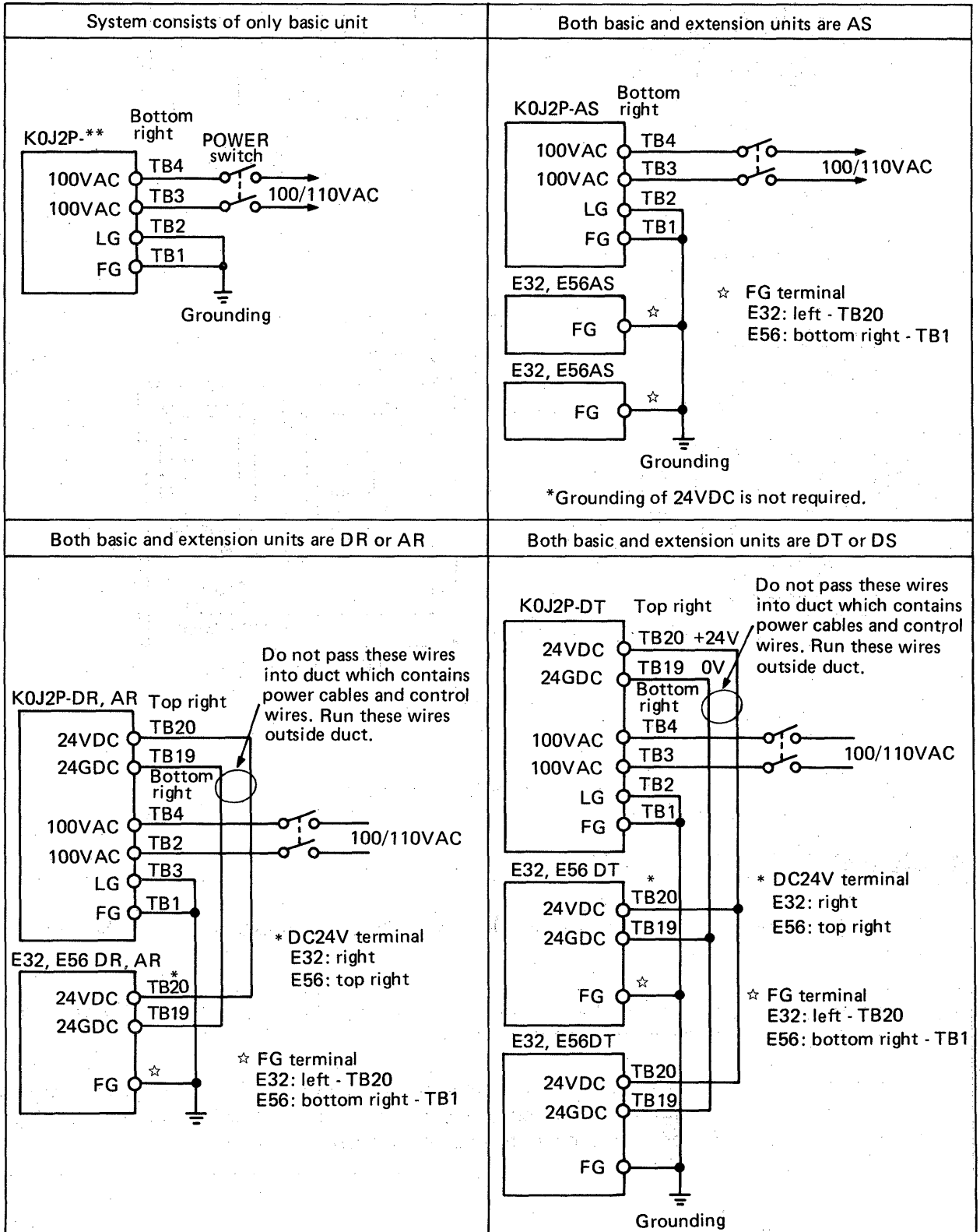
CAUTION

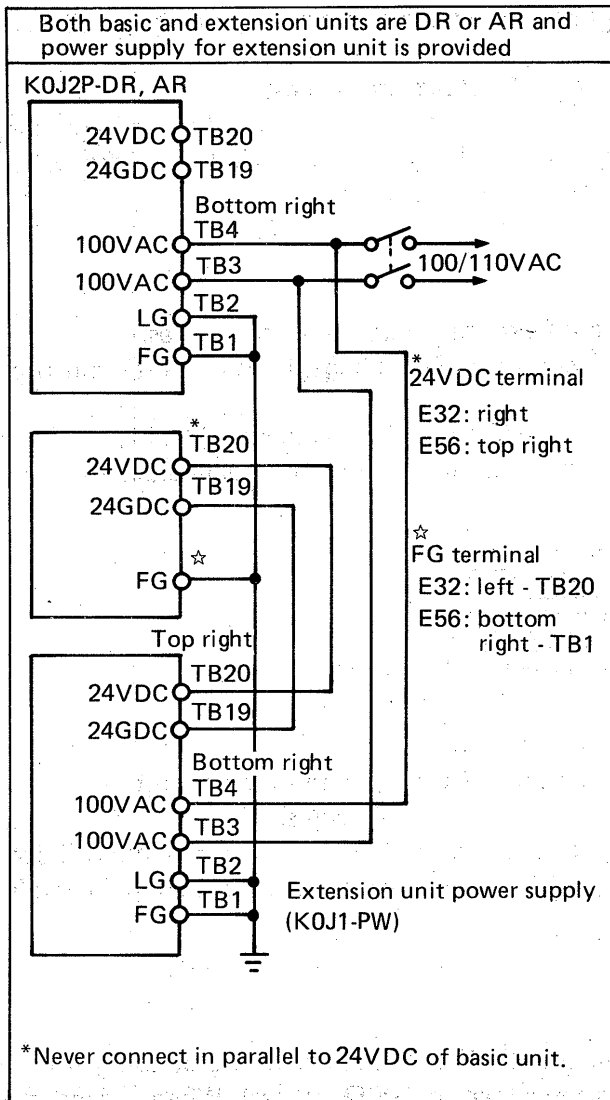
1. The positions of basic unit and extension unit or basic unit and extension base shown in the above figure may be reverse.
2. The K0J2P, K0J2-E56, K0J1-E56 and E53 units can be mounted horizontally on the bottom of operation panel. In this case, provide cooling means.
3. The mounting surface should be level and should not be uneven and distorted. When there are parts which generate vibration and shock (such as contactor and breaker), provide sufficient distance from such parts or mount the units on another panel.

5.2.9 Wiring

(1) Wiring of power supply and grounding

When the system consists of only basic unit or has been extended, perform the wiring of power supply and grounding in accordance with I/O type name.

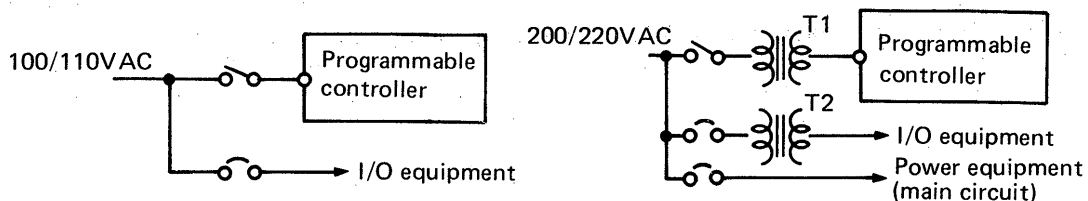




(2) Wiring instructions

Power supply

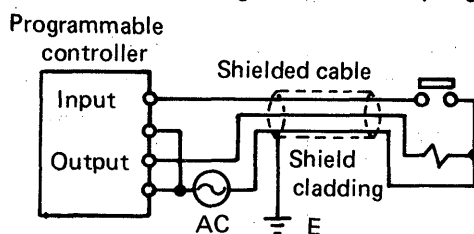
- 1) When voltage fluctuation is large, connect a constant-voltage transformer.
- 2) Use power supply, which generates minimal noise, across wires and across terminals and ground. When much noise is generated, connect an insulation transformer or filter.
- 3) When 200V AC is supplied, the capacity of voltage lower control transformer is as indicated below, and the transformer with shield is the most suitable.
 - System consists of only basic unit: 100VA
 - System is provided with extension power supply: 150VA
- 4) Separate the route of power supply of programmable controller from the routes of I/O equipment and power equipment as shown below.



- 5) Twist the 100VAC cable and the 24VDC cable to extension unit as closely as possible, and connect the units at the shortest distance.
- 6) Do not use 24VDC of K0J as the power supply of output equipment.
- 7) Do not bundle both 100VAC and 24VDC cables with main circuit (high-voltage, large-current) wire and I/O signal wire. Also do not wire the cables in the vicinity of the wires. If possible, separate the cables at least 100 mm away from the wires.

I/O equipment

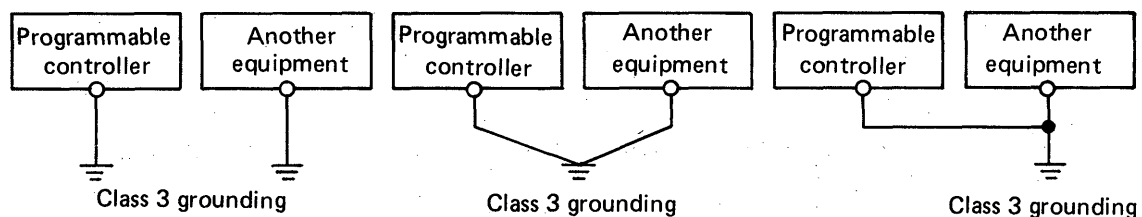
- 1) If possible, wire the I/O equipment separately from the input and output wires.
- 2) Wire the I/O signal wires at least 100 mm away from high-voltage, large-current main circuit cable.
- 3) When it is impossible to separate the I/O signal wires from the main circuit cable and power cable, use batch-shielded cables and ground on the programmable controller side.



- 4) When wiring has been conducted by use of conduit, securely ground the conduit.
- 5) Separate the I/O wires of 24VDC from the 100VAC and 200V wires.
- 6) When wiring has been conducted at a long distance more than 200 mm, trouble will occur due to leak current caused by line capacity. Take preventive means described in Example 4 of Section 5.2.10 (1) or Example 2 of (2).

Grounding

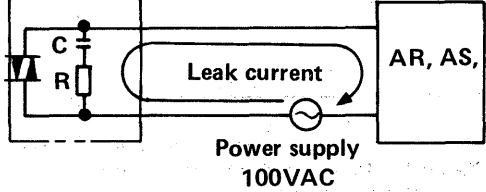
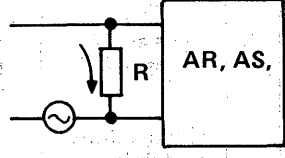
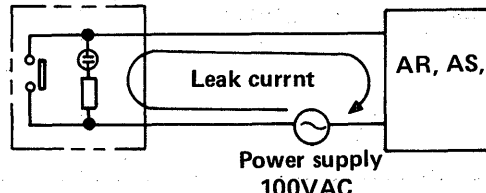
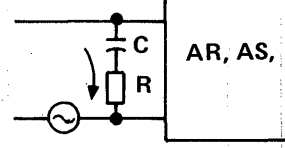
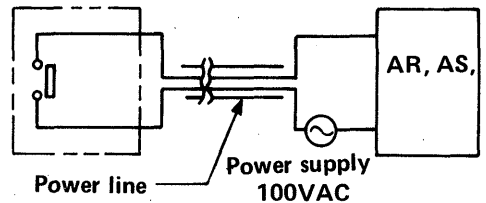
- 1) Ground the programmable controller independently if possible. Perform grounding work by way of Class 3 grounding (with grounding resistance of 100Ω or less). When independent grounding cannot be performed, use the joint grounding method (2) shown below.



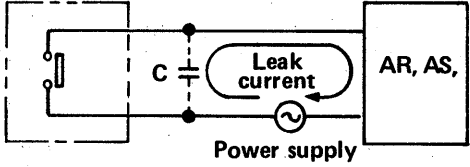
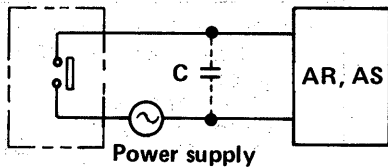
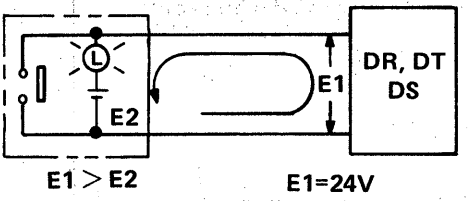
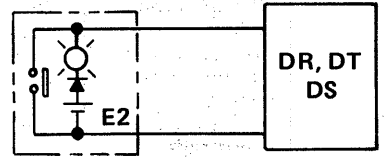
- (1) Independent grounding - best
 - (2) Joint grounding - good
 - (3) Joint grounding - not allowed
- 2) Use 2 mm² or larger grounding cable.
 - 3) Grounding point should be closest possible to the programmable controller and the length of grounding cable should be minimal.
 - 4) Should malfunction occur due to grounding, disconnect either or both of the grounding terminals (LG and FG) of base unit from the ground.
 - 5) Since this programmable controller is fully provided with measures against noise, it can be used without grounding except when there is especially much noise.

5.2.10 Troubles and corrective actions of I/O circuits

(1) Troubles and corrective actions of input circuit

Ex.	Condition	Cause	Corrective Action
1	Though triac is not on, input turns on. Though triac is turned off, input fails to turn off.	<p>Input is turned on by leak current from the CR absorber used to protect triac from surge.</p> <p>AC 2-wire type proximity switch, etc.</p>  <p>Power supply 100VAC</p> <p>AR, AS,</p> <p>This occurs in AR or AS when leak current exceeds 4 mA.</p>	<p>Connect resistor or series combination of resistor and capacitor as shown below in order to reduce input impedance so that voltage across input terminals of input unit is lower than input operation "off" voltage.</p>  <p>AR, AS,</p> <p>Example: R: 15KΩ 2W</p>
2	Though limit switch is not on, turns on. Though limit switch is turned off, input fails to turn off.	<p>When limit switch is provided with neon lamp, input is turned on by leak current caused by neon lamp.</p> <p>Limit switch with neon lamp</p>  <p>Power supply 100VAC</p> <p>AR, AS,</p>	 <p>AR, AS,</p> <p>Example: CR: 0.5μF + 50Ω DCR2-1203-5041 (Matsuo Electric make)</p>
3	Same as example 2.	<p>In case input signal line is wired long distance in parallel to other power line, etc., input turns on because voltage is induced by induced voltage from power line.</p>  <p>Power line</p> <p>Power supply 100VAC</p> <p>AR, AS,</p>	<p><i>Note: Determine R and CR values depending on leak current values. When only resistors is used, more heat is generated. If possible, use the combination of resistor and capacitor. This combination produces an effect also on large surge.</i></p>

5

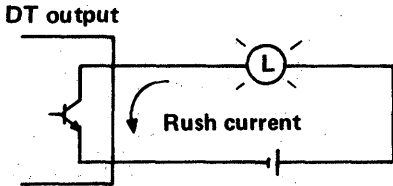
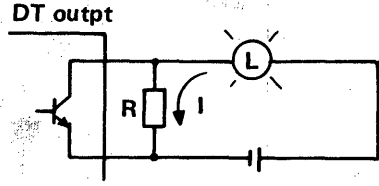
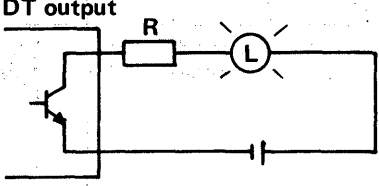
Ex.	Condition	Cause	Corrective Action
4	Same as example 2.	<p>Input is turned on by leak current caused by line-to-line capacity across wired cable.</p> 	<p>(a) Same as examples 1, 2, and 3. (b) As shown below, provide power supply on limit switch side.</p> 
5	<p>Same as example 2.</p> <p>Though limit switch is not on, lamp turn on.</p>	<p>With 2 power supplies used, since E1 voltage is larger than E2 voltage, unidentified flowing current flows as show below.</p> 	<p>(a) Use 1 power supply. (b) Take action so that $E1 \leq E2$ is established. (c) Connect snake path prevention diode as shown below.</p> 

5

(2) Troubles and corrective actions of output circuit

(Varistor with * mark is provided for only AS and DS.)

Ex.	Condition	Cause	Corrective Action
1	When output off, excess voltage is applied to load.	<ul style="list-style-type: none"> ○ Load is half-wave rectified internally (seen in some solenoids) <p>AR, DR, AS, DS</p> <p>○ When power supply polarity is as shown by ①, C is charged. When polarity is as shown by ②, voltage charged in C plus line voltage are applied across D1. Max. voltage is approx. $2\sqrt{2}E$.</p>	<ul style="list-style-type: none"> ○ Connect resistor of several ten K across load. <p><i>Note: When resistor is used in this way, it does not offer problem to output element, but may sometimes cause the diode, which is built in the load, to deteriorate or burn.</i></p> <p>Several ten ~ Several hundred KΩ</p>
2	Load does not turn off.	<ul style="list-style-type: none"> ○ Leak current caused by built-in snubber. This is especially liable to occur in the case of small-capacity load. <p>AR, DR, AS, DS</p>	<ul style="list-style-type: none"> ○ Connect resistor of approx. several ten K across load. <p><i>Note: In case wiring distance from output card to load is long, take care because there may exist leak current due to line-to-line capacity.</i></p> <ul style="list-style-type: none"> ○ Connect C and R across load. <p>CR: 0.1 ~ 0.47μF + 47 ~ 120 Ω</p>
3	When motor type or C, R type timer is used as load, time limit fluctuates.	<p>AR, DR, AS, DS</p>	<ul style="list-style-type: none"> ○ After driving relay, drive timer at the same contact. ○ Connect C and R across CR timer. <p><i>Note: Since some timers are half-wave rectified internally, caution described in Example 1 is required.</i></p>
4	Load fails (for direct current)	<ul style="list-style-type: none"> ○ Circulation occurs because 2 power supplies are used. <p>DT</p> <p>○ +24V < E, circulation occurs.</p>	<ul style="list-style-type: none"> ○ Use load power supply of 24V DC. ○ Connect circulation preventive diode. (See note.) <p><i>Note: In case relay or the like is used as load, it is necessary to connect reverse voltage absorbing diode (shown in dotted line in figure at left) with load.</i></p>

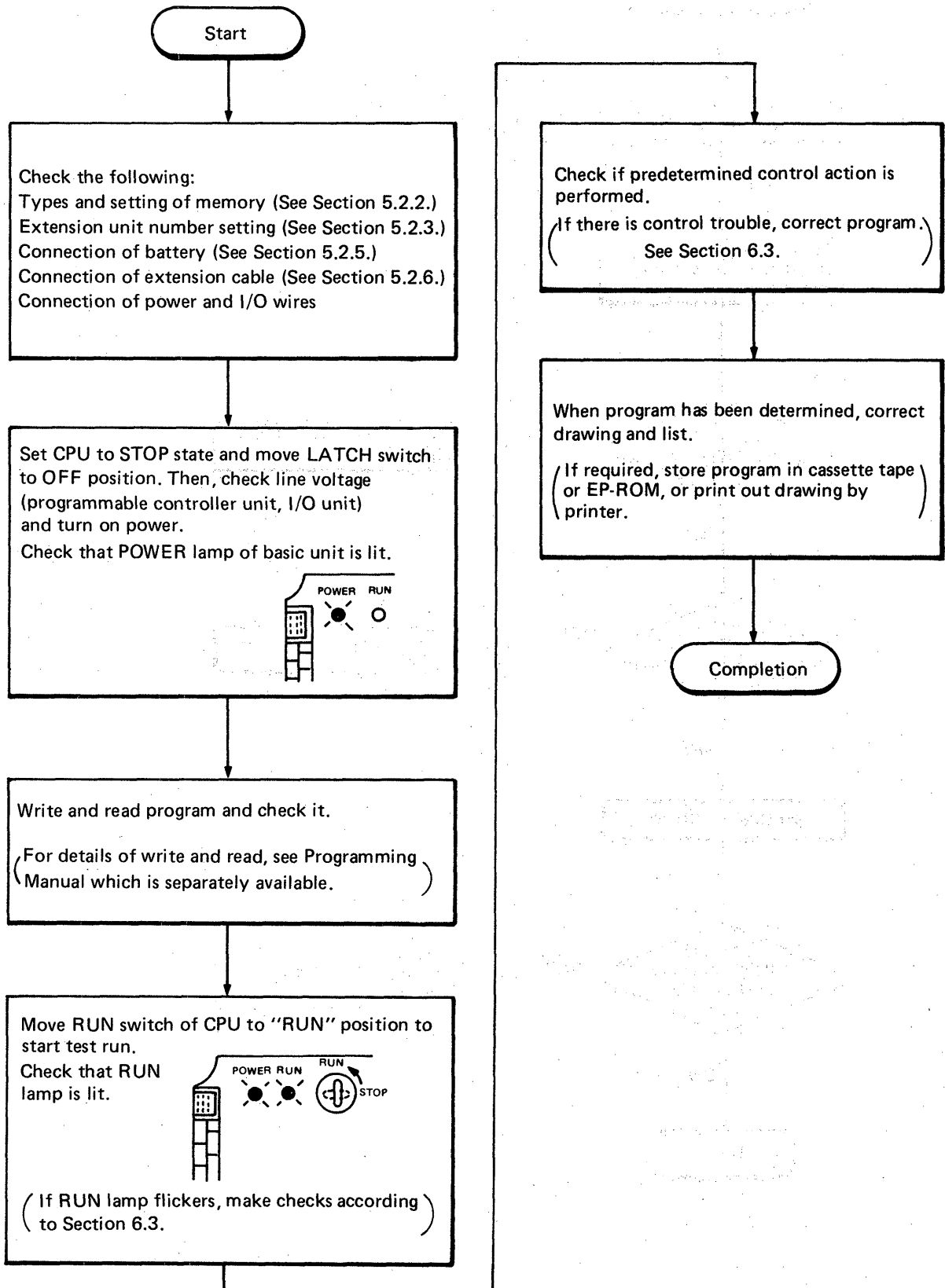
Ex.	Condition	Cause	Corrective Action
5	Output transistor is destroyed.	<p>In case transistor is used for output and lamp is used as load, since inrush current flows through lamp when transistor turn on, output transistor is destroyed.</p>  <p>Since DT has max. withstand rush current or 1.5A (50mS), rush current for lamp should be below this value.</p>	<p>(a) Provide resistor as shown below so that small current, which will not turn on the flows at all times, in order to prevent rush current from generating.</p> <p>Example I : rush current x 1/3 ~ 1/4</p>  <p>(b) Provide resistor as shown below to restrict rush current.</p> 

5

5.3 Operating Procedures

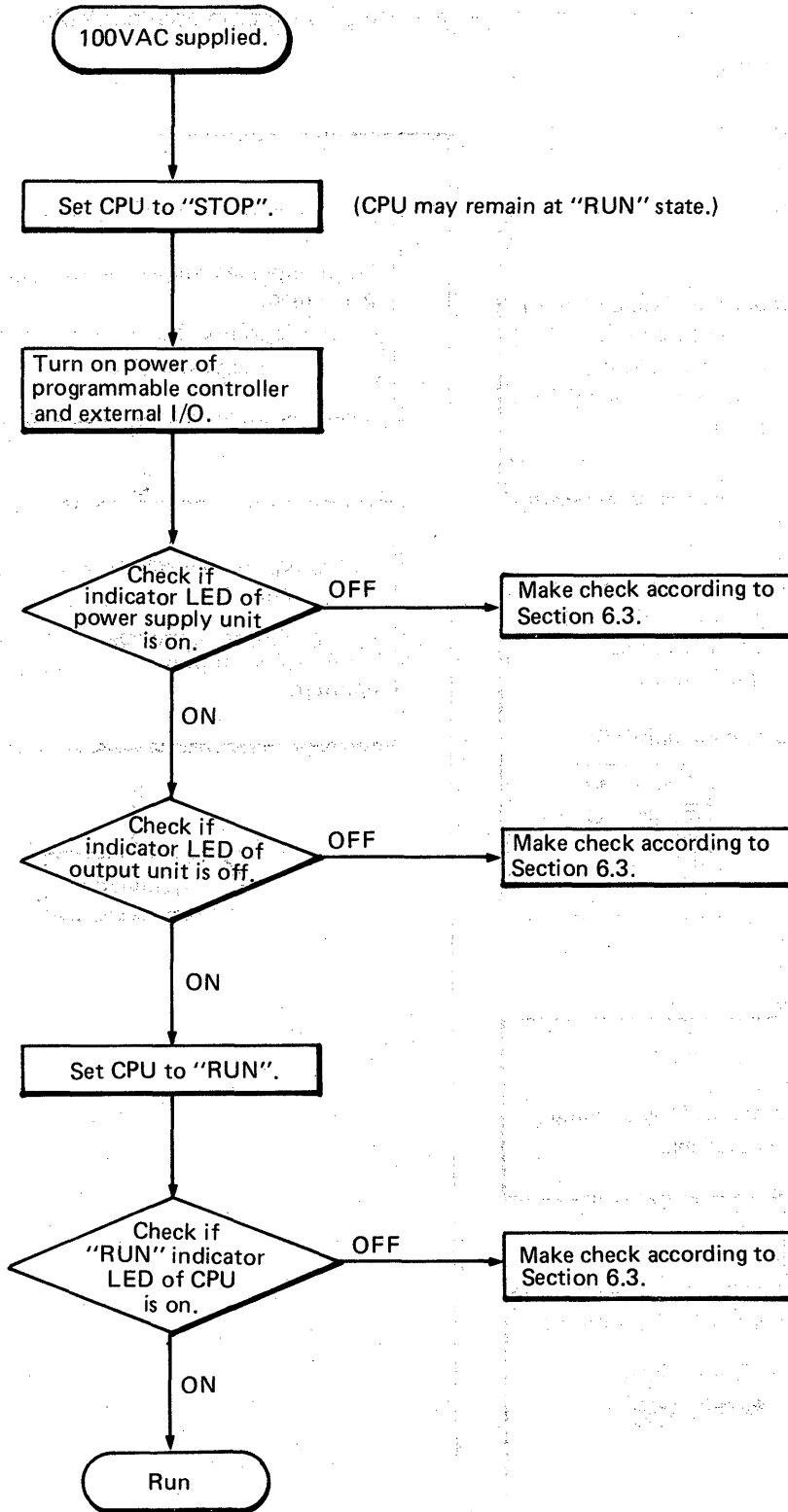
5.3.1 Test run flow chart

This section shows the test run flow chart after completion of programmable controller installation.



5.3.2 Daily operation

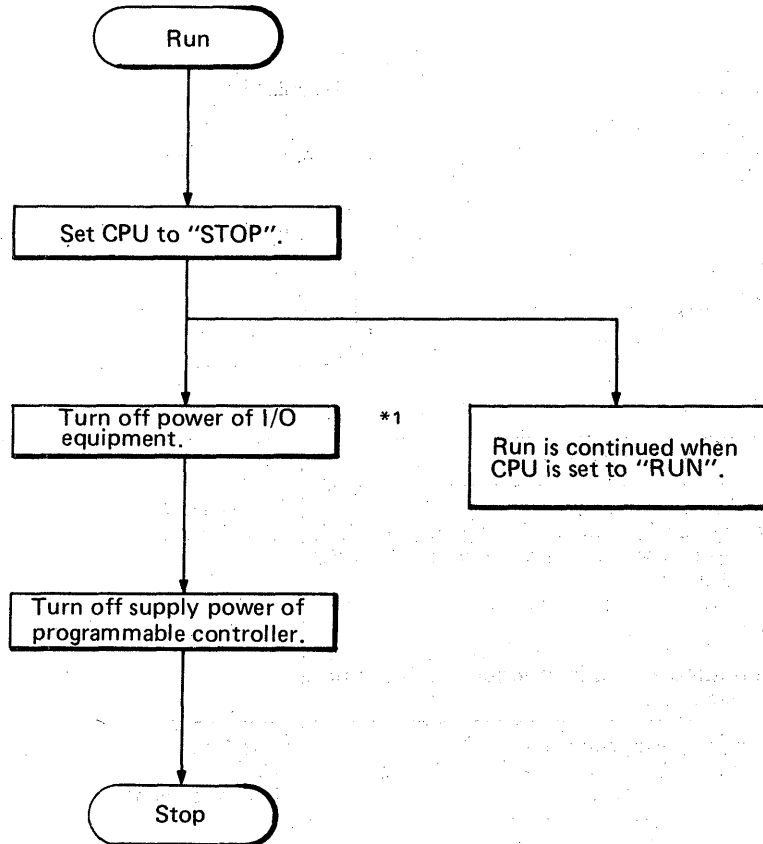
(1) Operation start



5

(2) Operation stop

Stop operation when operation can be stopped, judging the controlled state of controlled unit.

**CAUTION**

1. If only the power supply of I/O equipment is turned off in the step indicated by *1, arithmetic operation is performed with all inputs off.
2. When the "RESET" switch is moved on ON position during run or stop of CPU, the interior of CPU is set to initial state. If the "RESET" switch is moved to ON position during run when the latch function is not used, all outputs are reset and the temporary values of timers/counters are also cleared.

5.3.3 Error code list

When error has been detected as a result of self-diagnosis by turning on the RUN switch of KOJ2P, the error code can be read by the test function of programming unit (PU) or graphic programming panel (GPP).

Example: 1) PU



2) GPP

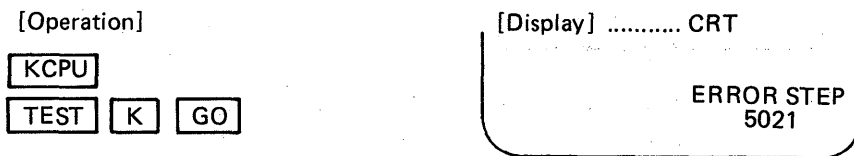


Table 5.2 shows the error code types and corrective actions.

Error Display	Content	Corrective Action
0 ~ 4095	Display of error step number (1) The instruction code of program, which is being processed, has a code which the CPU cannot decode. (2) The result of conversion into BCD exceeds "9999". (3) Since the program has jumped to a step below END by CJ instruction, END has not been executed.	The step indicated by error display has a program error. Correct the program.
1024	The program is not provided with END. (Error number differs depending on the capacity of loaded memory.) Standard-equipped 1KRAM: 1024 2KROM: 2048 4KRAM, ROM: 4096	Write END in the program. (When END instruction is not provided, GPP cannot display a circuit mode.)
2048		
4096		
5008	KOJ83 is not loaded when remote I/O or local programmable controller is selected (the internal setting switch 3 or 4 is set to ON position).	Check if the built-in optical data link card (KOJ83) is loaded. When the KOJ83 is loaded, also check its loading condition.
5021	The process time of program has exceeded 200mS.	Reduce the process time of program by using a CJ instruction, for example.
5031	Jump instruction (CJKn) to END, which is specified at the end of low-speed processing program, or return instruction (RST F126), which is specified at the end of high-speed processing program, has not been written.	Correctly write the instruction, referring to the programming manual.
5032	The format of high-speed processing program has error.	Modify the format of high-speed processing program as shown below.

Table 5.2 Error Code List

6. MAINTENANCE AND INSPECTION

6. MAINTENANCE AND INSPECTION	73 ~ 86
6.1 Daily Inspection74
6.2 Periodic Inspection75
6.3 Troubleshooting76
6.3.1 Troubleshooting flow chart76
6.3.2 Flow chart used when program cannot be written77
6.3.3 "POWER" LED is not lit78
6.3.4 Flow chart used when "RUN" LED is not lit80
6.3.5 Flow chart used when "RUN" LED flickers81
6.3.6 Flow chart for I/O section82
6.4 Change of Battery83
6.4.1 Life of battery83
6.4.2 Battery changing procedure84
6.5 Change of Fuse85

6. MAINTENANCE AND INSPECTION

6.1 Daily Inspection

Check the items in Table 6.1 when the power is turned on or the door of panel is opened.

Item	Checking Item	Checking Point	Judgement	Corrective Action
1	Unit mounting conditions	Check for looseness and play of mounting, looseness of cover, disconnection of terminal cover.	Unit should be mounted firmly.	Retighten screws.
2	Connecting conditions	Looseness of terminal screw.	Screws should not be loose.	Retighten terminal screws.
		Closeness of solderless terminals.	Terminals should be tightened parallel to each other.	Retighten terminal screws.
		Connector of extension cable.	Connectors should be connected firmly.	Latch connectors.
3	Unit indicator lamp			
	1) "POWER" lamp	Check that lamp is on.	On. Off is error.	See Section 6.3.3.
	2) "RUN" lamp	Check that lamp turns on when switch is moved to "RUN" position.	On. Off or flicker is error.	See Section 6.3.4 and Section 6.3.5.
	3) Input lamp	Check that lamp is turned on or off.	On when input is on. Off when input is off. State other than above is error.	See Section 6.3.6.
	4) Output lamp	Check that lamp is turned on or off.	On when output is on. Off when output is off. State other than above is error.	See Section 6.3.6.
4	When external indicator lamps are provided			
	1) "Run" check by M255	Check that lamp turns on when "RUN" switch is moved to ON position.	On. Off is error.	See Section 6.3.4 and Section 6.3.5.
	2) "Battery error" check by M254	When lamp is on, battery capacity has reduced.	When lamp is off, battery is normal.	Change battery.

Table 6.1 Daily Inspection Items

6.2 Periodic Inspection

Check the items in Table 6.2 once six months. Also check the items when the facility has been moved, modifications have been made, or wiring has been changed.

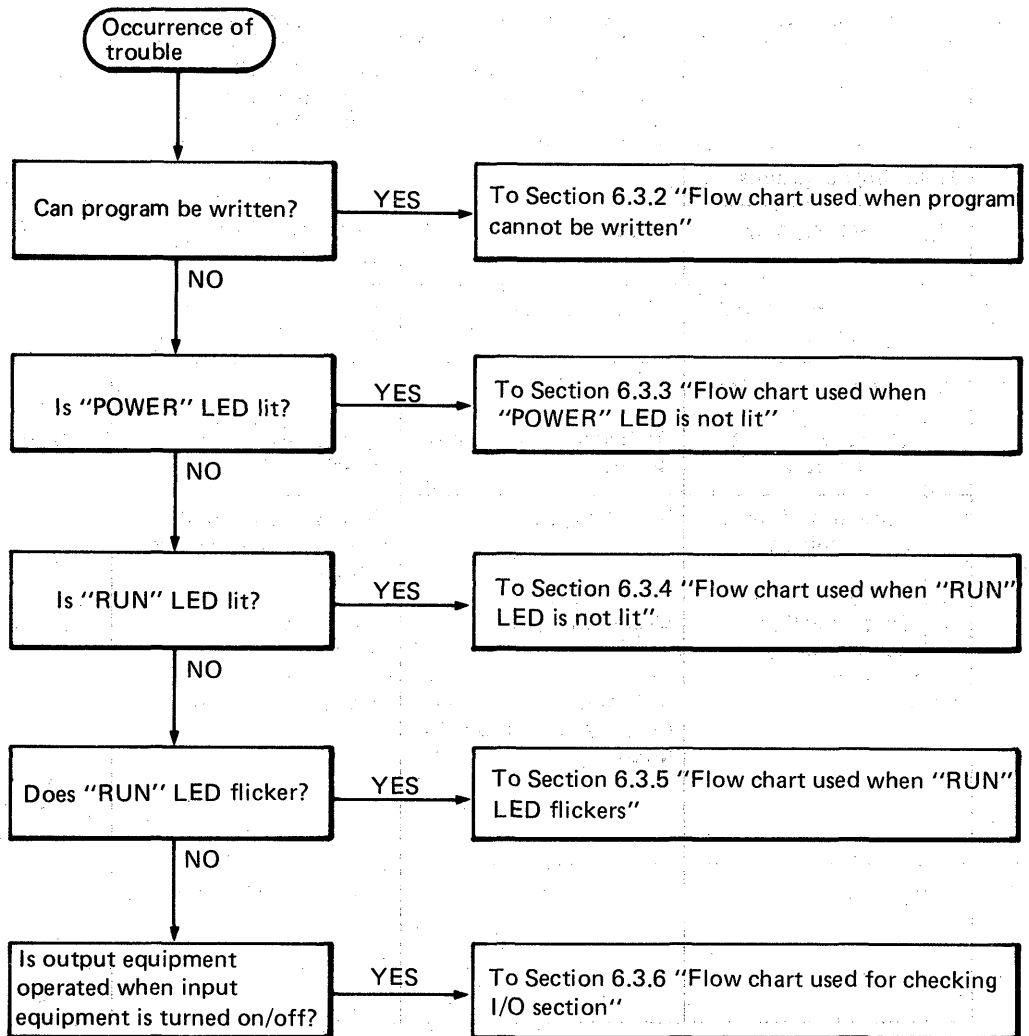
Item	Checking Item	Checking Point	Judgement	Corrective Action
1	Line voltage check	Measure voltage across 100VAC terminal.	85 ~ 121VAC Approximately 95 ~ 110VAC is desirable.	Change supply power. Change transformer tap.
2	Mounting conditions	Move unit.	Unit should be mounted firmly.	Retighten screws.
	1) Looseness, play			
	2) Adhesion of dust or foreign matter	Visual inspection	Free of dust or foreign matter.	Remove and clean.
3	Connecting conditions	Retighten by screw-driver.	Screws should not be loose.	Retighten.
	1) Looseness of terminal screw			
	2) Closeness of solderless terminals			
	3) Disconnection of connector	Visual inspection	Connectors should be connected firmly.	Latch connectors.
4	Battery	Indication of battery capacity reduction by M254.	(Preventive maintenance)	If battery capacity reduction is not indicated, change battery when predetermined life has exceeded. It is also desired to change battery periodically.
5	Fuse		(Preventive maintenance)	If fuse is not melted, it is desired to change fuse periodically because element may be worn due to rush current.

Table 6.2 Periodic Inspection Items

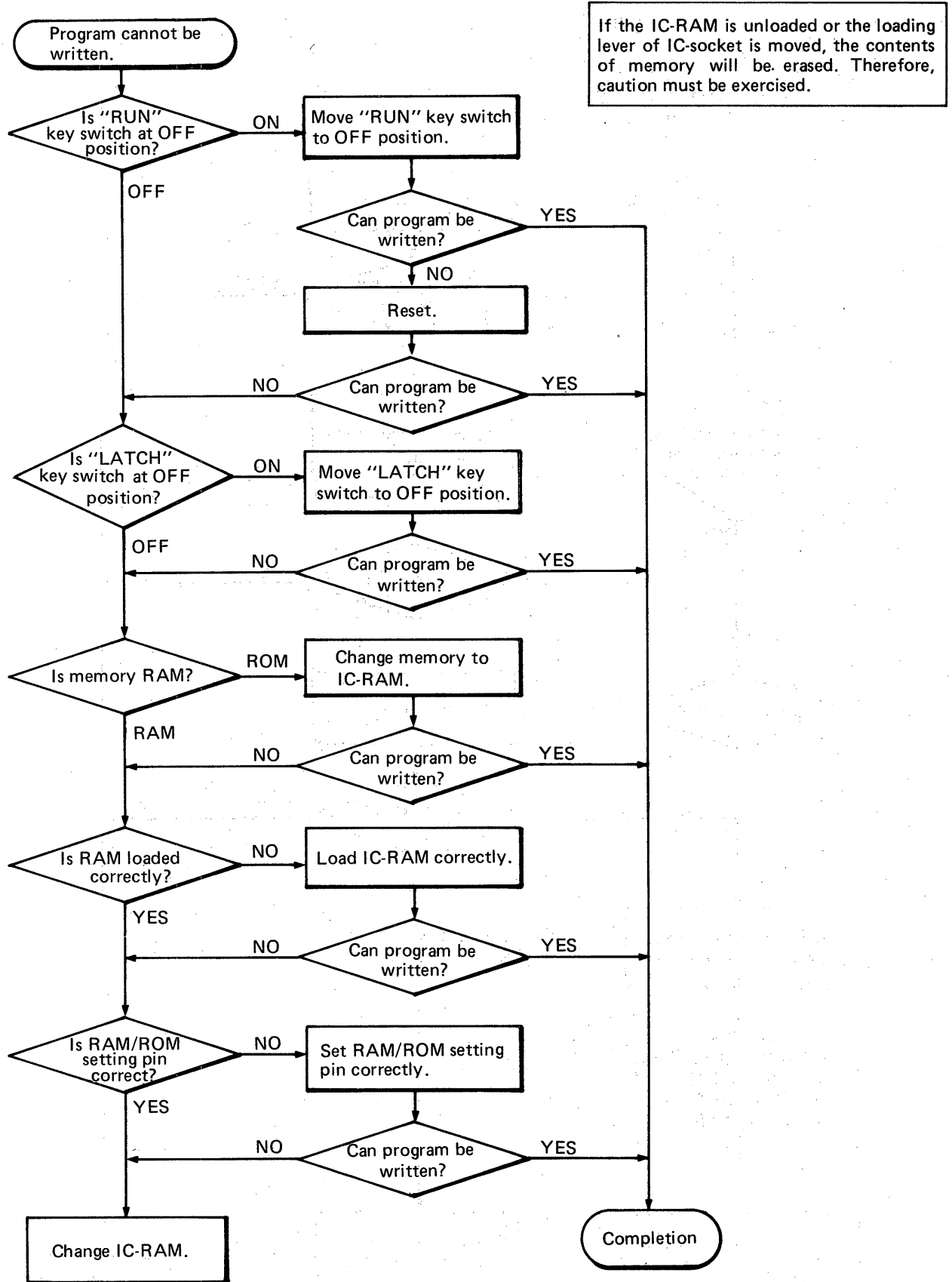
6.3 Troubleshooting

This section explains simple troubleshooting procedures.

6.3.1 Troubleshooting flow chart

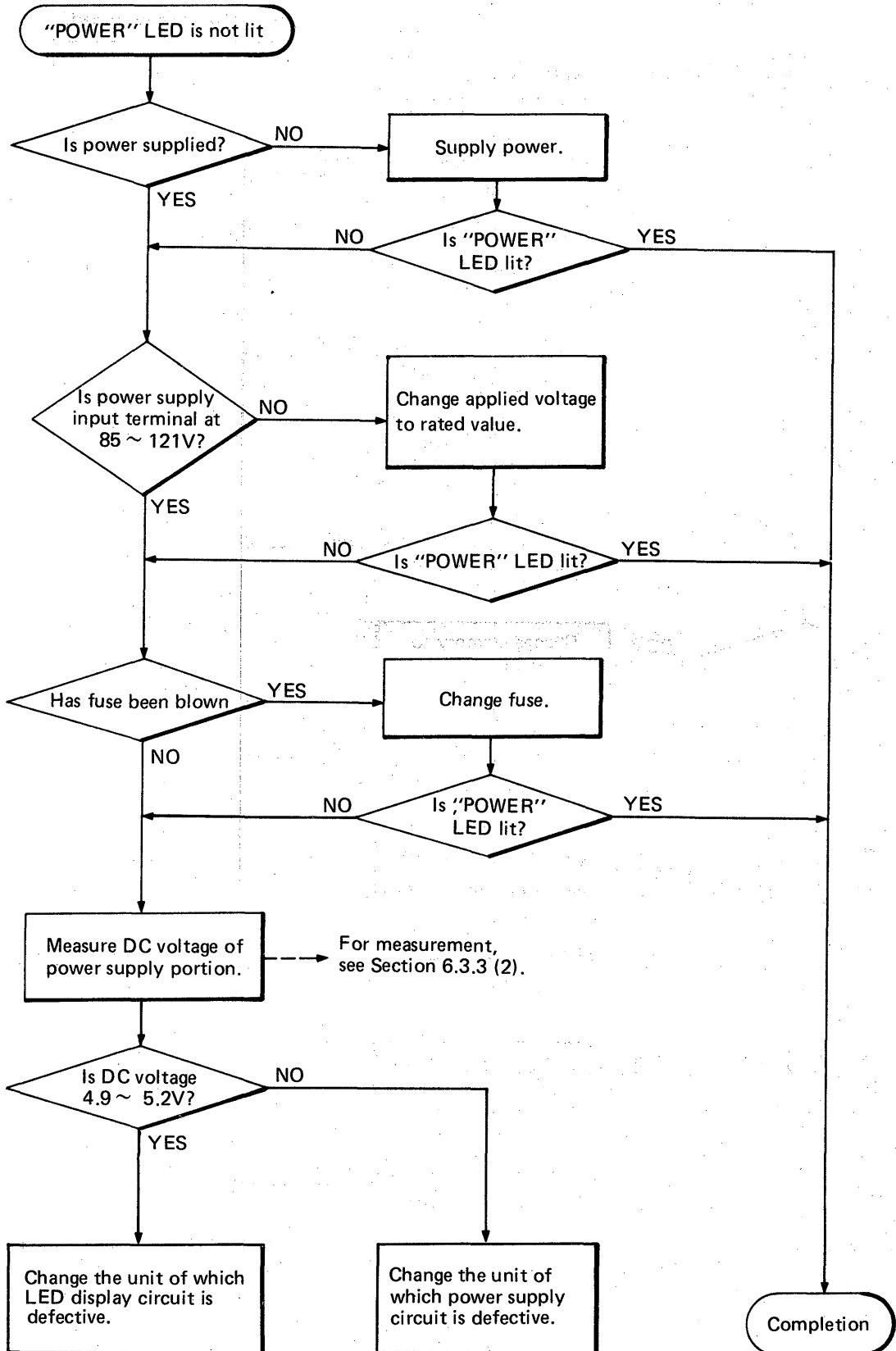


6.3.2 Flow chart used when program cannot be written



6.3.3 "POWER" LED is not lit

(1) Flow chart used when "POWER" LED is not lit



6

(2) Measurement of direct current power supply

1) Basic unit

- a. Measure 5V at 5V of CON2 and SG. (Fig. 6.1)
- b. Measure 24V across terminals TB19 (-) and TB20 (+).

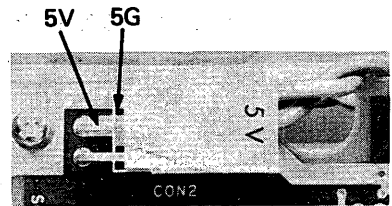


Fig. 6.1 Voltage Measuring Points of Basic Unit

2) Type E56 extension unit

- a. Measure 5V at the pin of IC as shown in Fig. 6.2. (5V may be measured at any IC if it is a 16-pin IC.)
- b. Measure 24V across terminals TB19 (-) and TB20 (+).

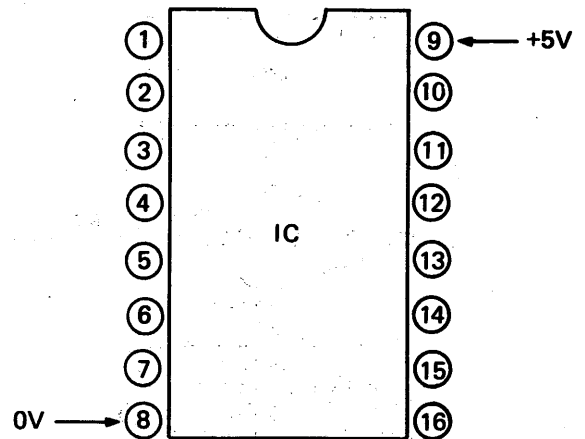
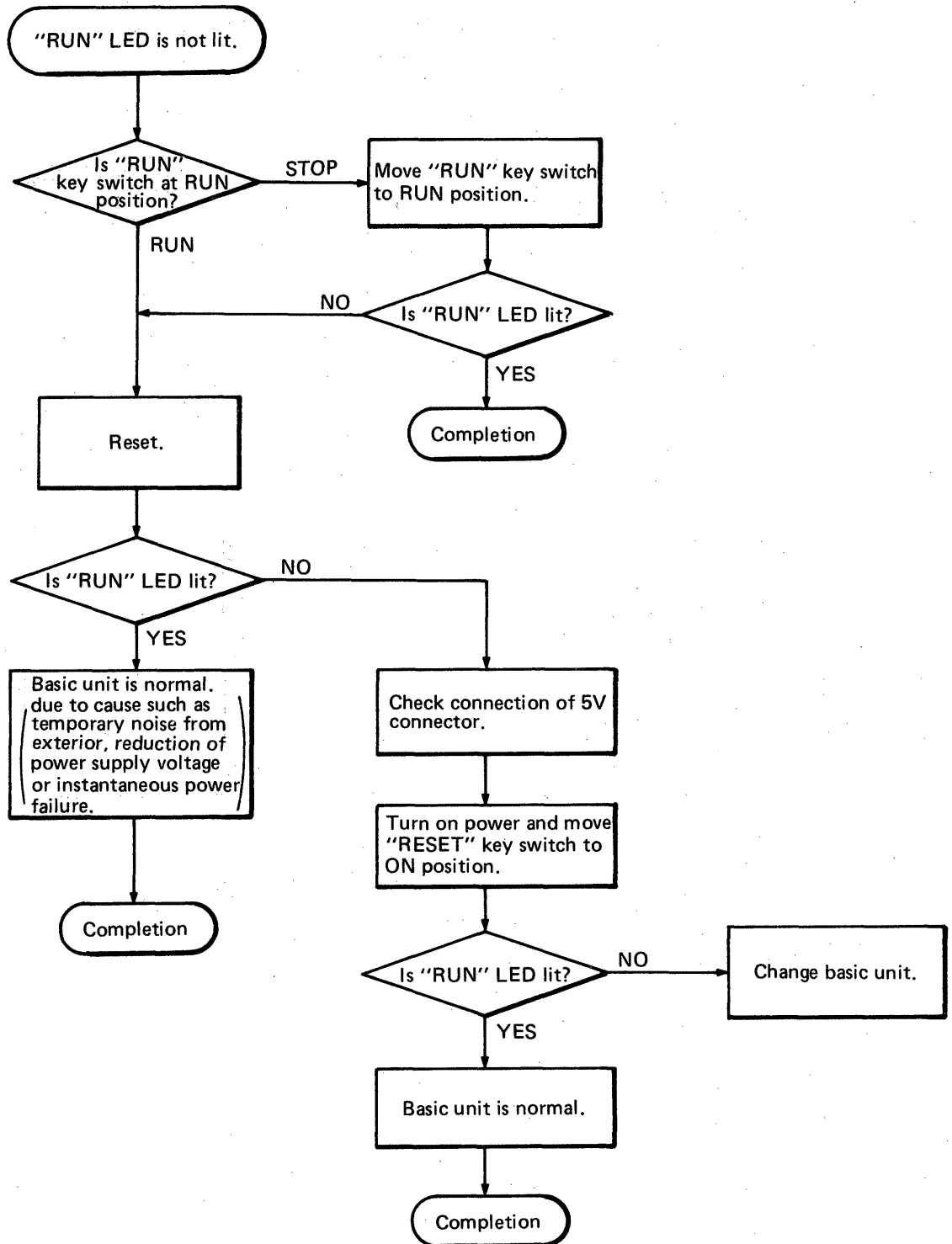


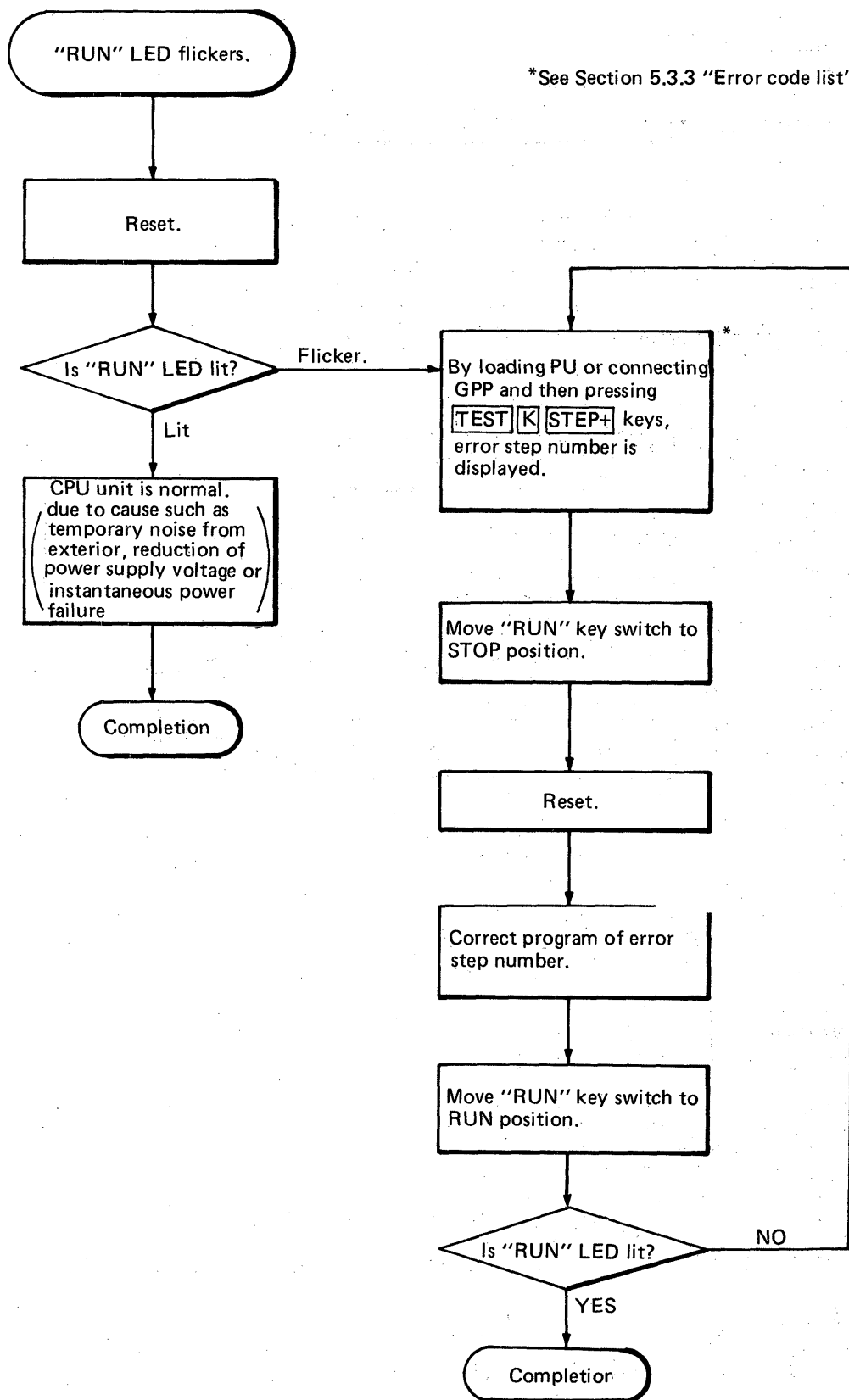
Fig. 6.2 Voltage Measuring Points of IC

6.3.4 Flow chart used when "RUN" LED is not lit



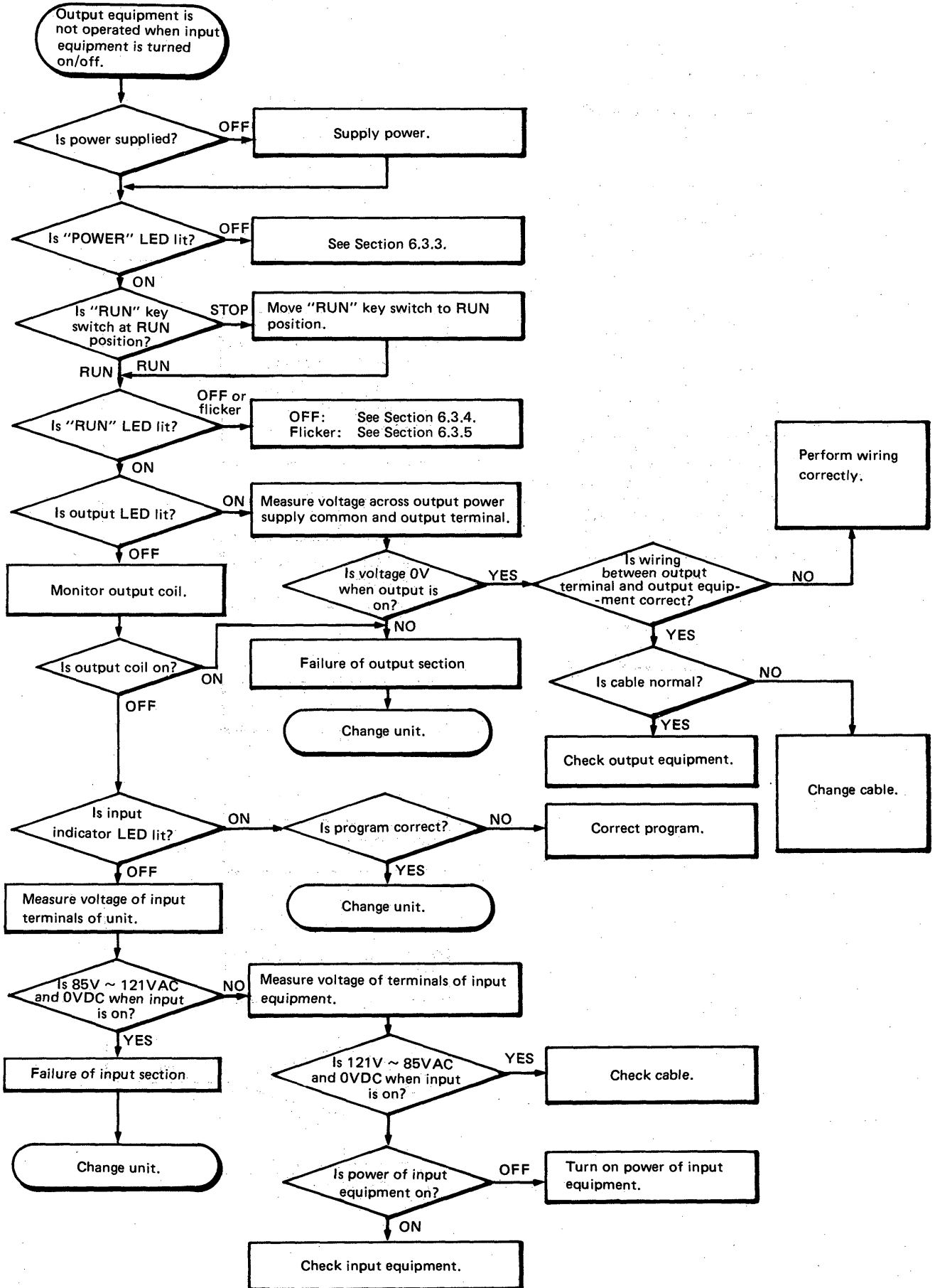
6

6.3.5 Flow chart used when "RUN" LED flickers



6

6.3.6 Flow chart for I/O section



6

6.4 Change of Battery

6.4.1 Life of battery

The battery for backup of IC-RAM and power failure gives alarm (M254) when the battery voltage (capacity) reduces. The battery can provide back up for power failure for approximately one month after this alarm is given. However, the alarm may escape the operator's notice. Therefore, it is recommended to change the battery as soon as possible.

The guides of preventive maintenance are as follows:

- 1) When the battery is guaranteed within five years and the total power cut time is less than 300 days (7200 hours), change the battery in four to five years.
- 2) When the battery is guaranteed within five years and the total power cut time has exceeded 300 days (7200 hours), calculate the day when the total power cut time will exceed 7200 hours, in terms of the operating hours during one day or one week, and also the power cut time, thus obtaining the time to change the battery.

Example: If the operating time is 10 hours a day (i.e. power is stopped for 14 hours a day) and the power is stopped for two days (i.e. 24 hours) a week,

$$14 \text{ hours} \times 5 = 70 \text{ hours}$$

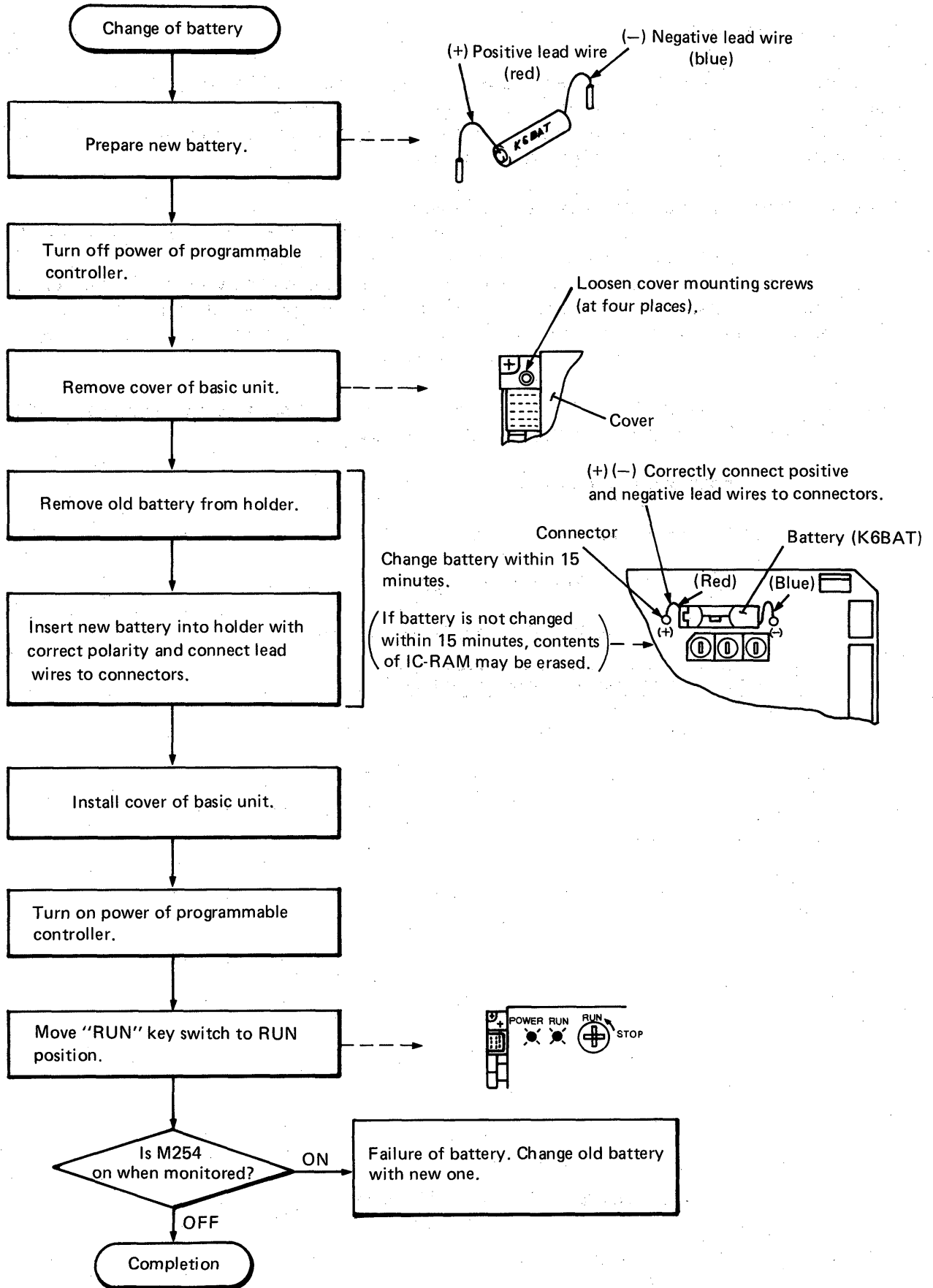
$$24 \text{ hours} \times 2 = 48 \text{ hours}$$

$$7200 \text{ hours} / (70 + 48) \text{ hours} = 61 \text{ weeks}$$

$$61 \text{ weeks} \times 7 \text{ days} / 30 \text{ days} = \text{approx. } 14 \text{ months}$$

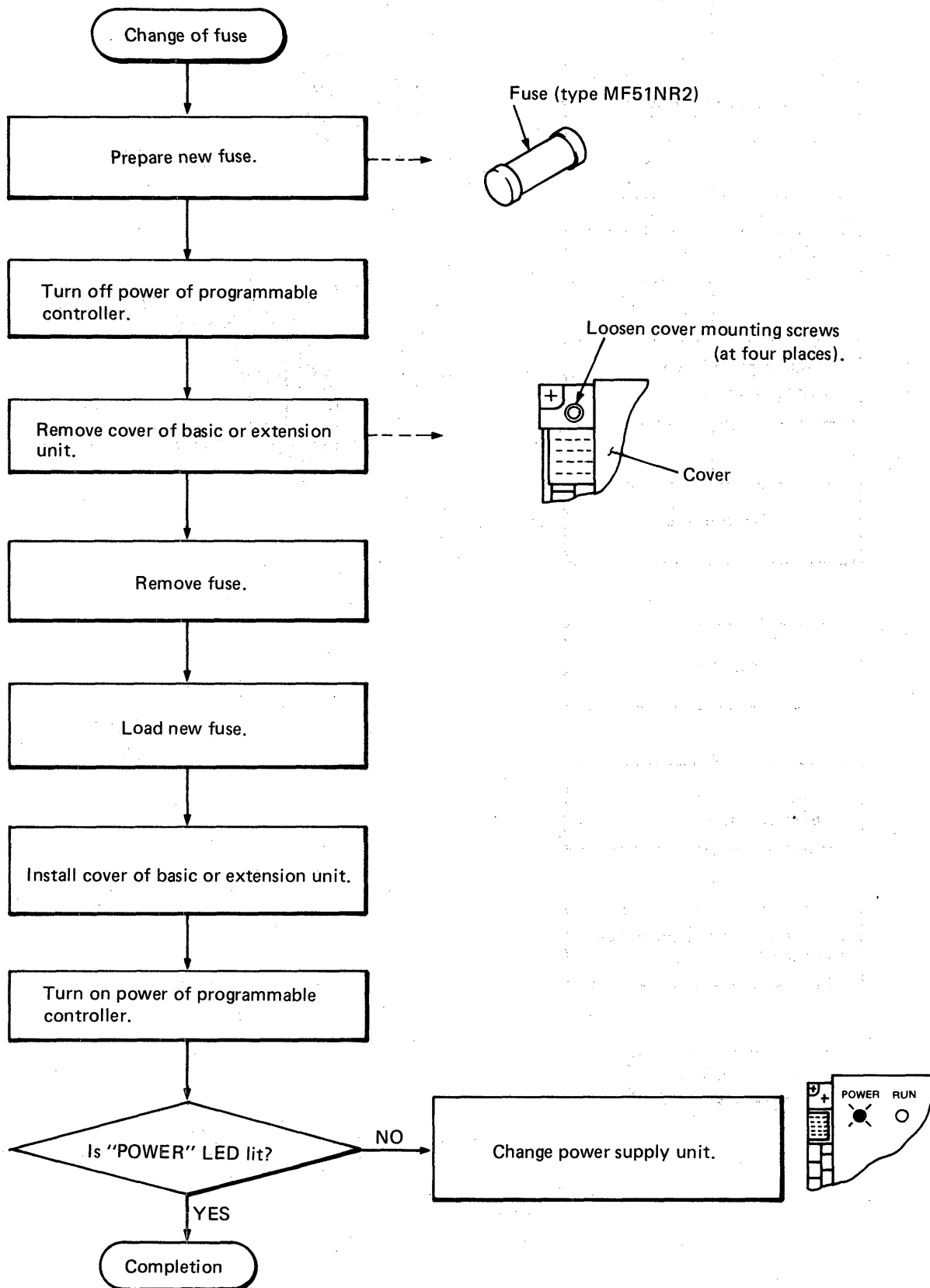
Therefore, change the battery every 14 months.

6.4.2 Battery changing procedure

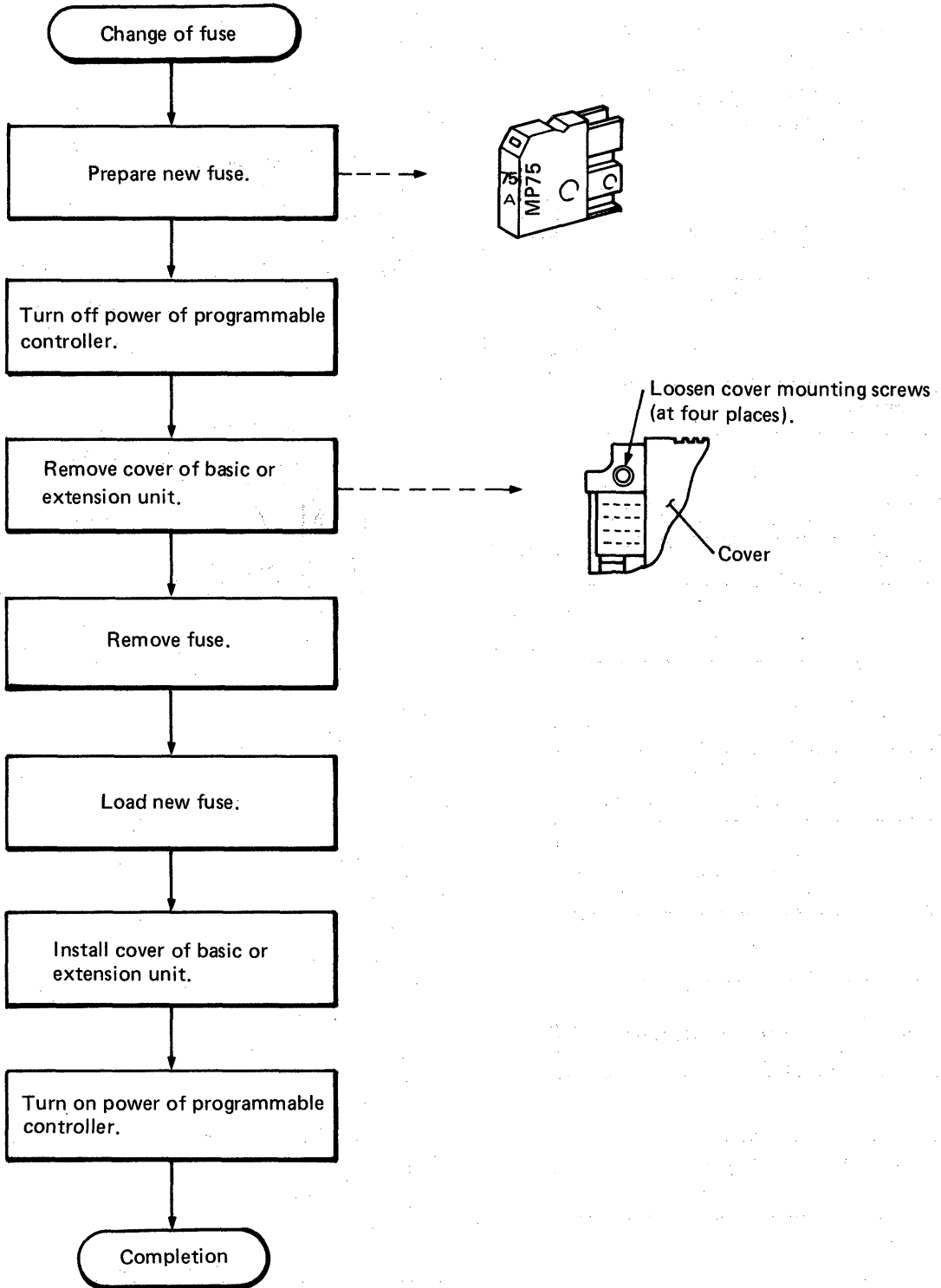


6.5 Change of Fuse

(1) Change of power supply fuse



(2) Change of fuse for triac output



6

7. INSTRUCTIONS FOR SPECIFICATIONS

7. INSTRUCTIONS FOR SPECIFICATIONS	87 ~ 92
7.1 Watch DOG Timer (WDT)88
7.2 Accuracy of Timer89
7.3 Maximum Counting Speed of Counter90
7.4 Latch Function91

7. INSTRUCTIONS FOR SPECIFICATIONS

7.1 Watch DOG Timer (WDT)

(1) The watchdog timer is the self-diagnostic function of hardware and detects the following:

- The predetermined period of one program cycle (scan time) has been exceeded. (Software)
- Failure of component or memory, stop of arithmetic operation due to noise. (Hardware)

(2) The watchdog timer is set to 0.2 second by the hardware.

(3) When WDT error has been detected, the display of "RUN" LED and the cause of error are as follows:

"RUN" LED	Cause
Flicker	Scan time has exceeded 0.2 sec. *1
Off *2	<ul style="list-style-type: none"> ● Due to failure of component or memory, WDT error has been detected and arithmetic operation has been stopped. ● Due to noise, WDT error has been detected and arithmetic operation has been stopped.

Note: *1 The "RUN" LED also flickers when program error occurs, namely:

- END is not written.
- Instruction is abnormal.

*2 When the "RUN" LED has turned off due to the cause indicated above, the error code "5021" is not displayed.

7.2 Accuracy of Timer

The accuracy of timer depends on scan time (timer accuracy = \pm scan time). Fig. 7.1 shows an example in which the 10mS timer, T127, is used with a set value of 6 seconds (K 600) for a program with 25mS scan time.

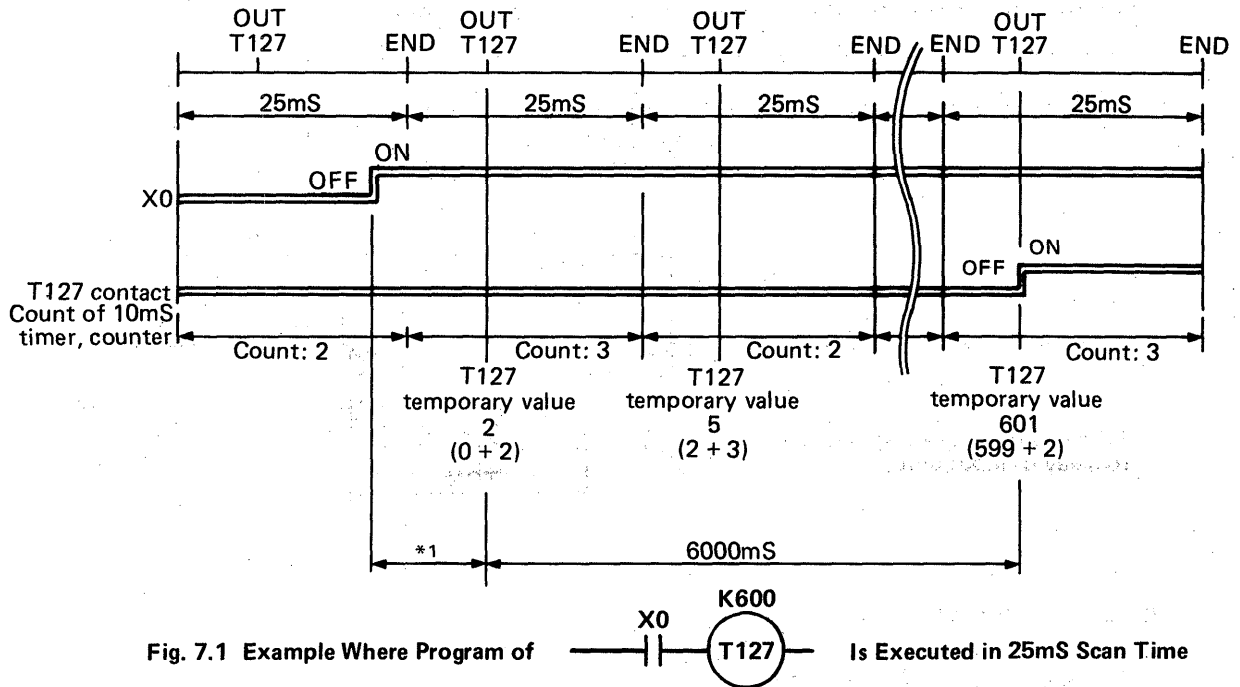
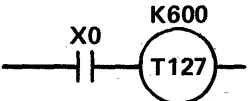


Fig. 7.1 Example Where Program of  Is Executed in 25mS Scan Time

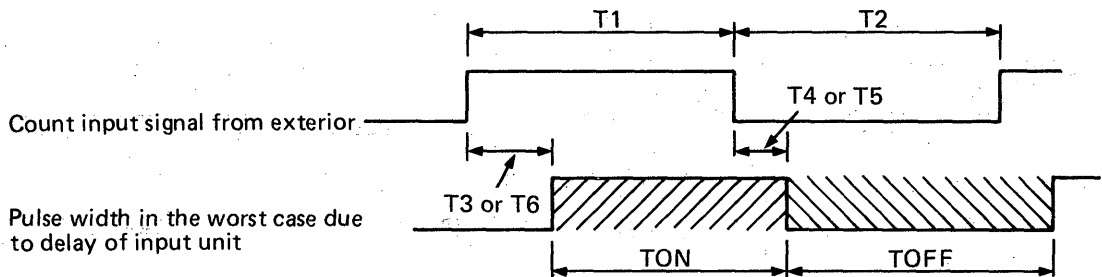
The interval of time until when the 10mS timer times up includes the counting error of 10mS timer ($\pm \text{scan time}$) and also the error produced depending on where the timer start condition has been set in the program*1 ($\pm \text{scan time}$). Therefore, the accuracy of timer is \pm (scan time). Accordingly, the accuracy of timer in the above example is \pm 0.025 second in relation to the set value of 6 seconds.

7.3 Maximum Counting Speed of Counter

The maximum counting speed of counter depends on the arithmetic operation time of one program cycle (scan time) and the response time of input unit. Counting is possible only when each of TON and TOFF is greater than scan time in the following figure.

Calculation expression of the maximum counting speed of counter

$$\text{Maximum counting speed } C_{\max} < \frac{1000}{\frac{1}{n} \cdot ts + \alpha} \quad (\text{counts/second})$$



where, n = ON/OFF ratio of count input signal ($n = \frac{T_1}{T_1 + T_2}$)

$$\left\{ \begin{array}{l} \text{When } n = \frac{T_1}{T_1 + T_2} \leq 0.5, n = \frac{T_1}{T_1 + T_2} \\ \text{When } n = \frac{T_1}{T_1 + T_2} \geq 0.5, n = 1 - \frac{T_1}{T_1 + T_2} \end{array} \right\}$$

ts = scan time (mS)

α = response time constant of input unit

$$\alpha = T_3 + T_4 - T_5 - T_6$$

$$\left\{ \begin{array}{l} T_3 = \text{maximum ON response time of input unit (mS)} \\ T_4 = \text{minimum OFF response time of input unit (mS)} \\ T_5 = \text{maximum OFF response time of input unit (mS)} \\ T_6 = \text{minimum ON response time of input unit (mS)} \end{array} \right\}$$

[Exercise]

Calculate the maximum counting speed under the following conditions:

$$\left\{ \begin{array}{l} \text{Scan time} = 100 \text{ mS} \\ \text{ON response time of input unit} = \text{max. } 20 \text{ mS, min. } 5 \text{ mS} \\ \text{OFF response time of input unit} = \text{max. } 30 \text{ mS, min. } 10 \text{ mS} \\ \text{ON/OFF ratio} = 40\% \end{array} \right.$$

$$\alpha = 20 + 10 - 30 - 5 = -5 \text{ (mS)}$$

$$C_{\max} < \frac{1000}{\frac{100}{40} \times 100 + (-5)} \quad \text{Consequently, the maximum counting speed is 4 (counts/second) or lower.}$$

7.4 Latch Function

The retention of control data at the time of power failure is referred to as the latch function (power failure latch). Retained at the time of power failure are timers (T), counters (C), data registers (D) and temporary memories (M).

(1) Selection of latch

When the "LATCH" key switch on the front panel of basic unit is in "ON" position, data is retained at the time of power failure. When the switch is in "OFF" position, data is not retained.

(2) All clear of latched contents

When it is desired to clear all of latched contents, move the "LATCH" key switch to "OFF" position and move the "RESET" key switch to "ON" position.

(3) Latch range

LATCH switch	Unlatch Range			Latched Range		
	Temporary memory	Timer, counter	Data register	Temporary memory	Timer, counter	Data register
OFF	M0 ~ 249	T.C0 ~ 127	D0 ~ 95	None	None	None
ON	M0 ~ 127 M254, M255	T.C0 ~ 63 T112 ~ 127	D0 ~ 63	M128 ~ 253	T.C64 ~ 111	D64 ~ 95

LATCH Setting Range

(4) Caution for program

To latch the temporary memory, do not use a self-holding circuit but use a set-and-reset circuit. This circuit is used to prevent the latched signal from being cleared, when the power is restored, by the difference of time between the rise of power of programmable controller and the rise of power of input signal.

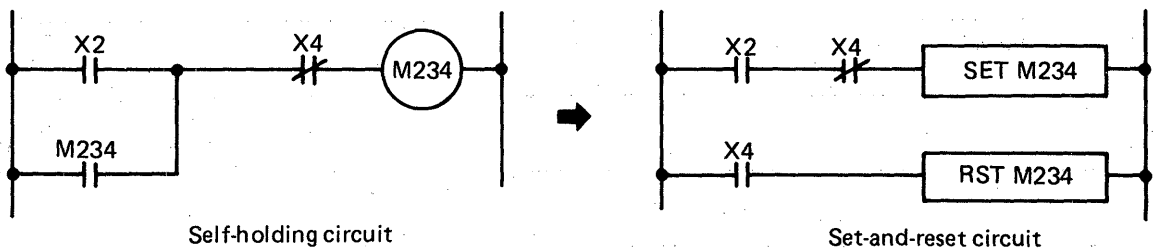


Fig. 7.2 Latch Circuit Example

MEMO

A series of horizontal dashed lines for writing a memo.

8. HANDLING INSTRUCTIONS

8. HANDLING INSTRUCTIONS	93 ~ 94
8.1 Programmable Controller Unit94
8.2 Memory94
8.3 Battery94
8.4 Optical Fiber Cable94

8. HANDLING INSTRUCTIONS

8.1 Programmable Controller Unit

- (1) Since the case of this programmable controller is made of plastic, do not drop or give strong shock.
- (2) At the time of wiring, take care to prevent the entry of conductive matters, such as wire chips and drill chips, into the unit. If such matters have entered, remove them.
- (3) Be sure to mount the front cover.
- (4) When the unit for K1 or K2 is used, do not overtighten the unit fixing screws.
- (5) Do not overtighten the terminal screws.

8.2 Memory

- (1) When loading the memory to the socket, securely press the memory against the socket and lock it with the lever. Check if the memory is lifted from the socket.
- (2) In regards to the handling of memory, be sure to follow Section 5.2.2.
- (3) If the IC-RAM, which stores program, is unloaded from the socket, the program will be erased immediately. Therefore, never unload the IC-RAM from the socket.

8.3 Battery

- (1) Do not let the battery short-circuited.
- (2) Do not disassemble the battery.
- (3) Do not put the battery into flame.
- (4) Do not heat the battery.
- (5) Do not solder the poles of battery.
- (6) Do not measure voltage with a circuit tester.

8.4 Optical fiber cable

The optical fiber cable is glass of approximately 125 μ m diameter which is coated with resin. Since various reinforcements have been provided for the optical fiber for use as a cable, it can be handled like the general cables. However, avoid the following extreme handling because the optical fiber cable will be damaged.

- (1) Bending the cable extremely forcibly.
- (2) Compressing the cable with a sharp, rigid body.
- (3) Twisting the cable extremely.
- (4) Pulling the cable by holding the optical connector and cord portion.
- (5) Pulling the optical cable extremely forcibly.
- (6) Stamping the optical cable.
- (7) Placing an object on the optical cable.

APPENDIX

APPENDIX	95 ~ 106
1. COMPARISON BETWEEN KOJ1, KOJ1H and KOJ2, KOJ2P	96
2. PROCESS TIME	99
3. CONTACT LIFE OF RELAY CONTACT OUTPUT	103
4. USAGE OF EXTERNAL FAILURE MONITOR UNIT (KOJ1-EX0N)	104

APPENDIX

1. COMPARISON BETWEEN KOJ1, KOJ1H and KOJ2, KOJ2P

1.1 Comparison of Specifications

ITEM \ TYPE		KOJ1		KOJ2	
		KOJ1	KOJ1H	KOJ2	KOJ2P
Instruction	Number of standard Instructions	26 types (18 types of sequence instructions + 8 types of data instructions) *1			
	Number of application instructions	15 types		19 types *2	
	Word length	16 bits (two bytes)/step, 1-, 2-, 3-step instruction			
Program capacity		Maximum 2048 steps		Maximum 4096 steps	
Sequence instruction execution time		30μs/step on average	5.6μs/step *3		30μs/step on average
Data instruction execution time		100 ~ 500μs/instruction (one instruction consists of three steps.)			
Program memory	IC-RAM	1024 steps – standard-equipment 2048 steps		1024 steps – standard-equipped 4096 steps	
	EP-ROM	1024 steps } 2048 steps } Selectively loaded		2048 steps } 4096 steps } Selectively loaded	
Number of I/O points		Maximum 184 points		Maximum 280 points	
Number of temporary memories		254 points (M0 ~ 253)			250 points (M0 ~ 249)
Shift register	Number of usable points	253 bits (M1 ~ M253) excluding those used for temporary memory.			249 bits (M1 ~ 249)
	Specifications	Constructed by temporary memories combined in units of one bit combined Used for SFT instruction and application instruction.			
Power failure latch (latched range) (Power failure latch is possible by LATCH key switch of basic unit.)		M128 ~ 253 T.C64 ~ 111 D64 ~ 95		M128 ~ 249 T.C64 ~ 111 D64 ~ 95	
Watchdog timer		100mS		170mS	200mS
10mS timer program		Inserted into high-speed processing program which is operated per 10ms	Possible by the same method as 100mS timer program.		
Data link function		Not provided			Provided (Optical data link, slave channel of local programmable controller system, slave channel of remote I/O system)
Type of RUN, LATCH and RESET switches		Toggle switch		Key switch	
Extension	Number of extended stage of 32-points (E32) and 56-points (E56) extension units	Two stages		Four stages (When KOJ2-E56 extension units are used. For other units, see Section 1, 2 of APPENDIX.)	
	Usability of K65B and K68B extension bases	Usable			Not usable
	Requirement of extension adaptor	Required for extension KOJ1-EX1 (for E32 and E56) extension units KOJ1-EX2 (for K65B and K68B) extension bases		Required for extension KOJ2-EX1 KOJ2-EX2	Not required Adaptor equivalent to EX1 is incorporated.
Usability of special units (High-speed counter – KD61 Positioning – KD71 Analog I/O – KA62A, KA63A)		Usable (loaded into K65B or K68B extension base)			Not usable

9

Note:

- (*1) S and D combinations of data instructions have been greatly increased.

K0J1, K0J1H

D \ S	K	D	T	C	X	Y	M
K		○ ●					
D		○ ● ▲ ▲	○	○		○	○
T		○ △					
C		○ △					
X		○ ▲					
Y							
M		○					

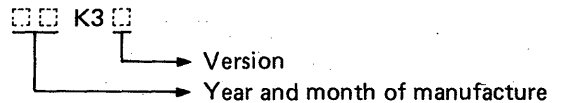
K0J2, K0J2P

D \ S	K	D	T	C	X	Y	M
K	●	○ ●	○ ●	○ ●	●	○ ●	○ ●
D	●	○ ●	○ ●	○ ●	●	○ ●	○ ●
T	●	○ ●	○ ●	○ ●	●	○ ●	○ ●
C	●	○ ●	○ ●	○ ●	●	○ ●	○ ●
X	●	○ ●	○ ●	○ ●	●	○ ●	○ ●
Y	●	○ ●	○ ●	○ ●	●	○ ●	○ ●
M	●	○ ●	○ ●	○ ●	●	○ ●	○ ●

MOV..... ○
 BCD △
 BIN ▲
 >, <, =, +, - ●

MOV, BCD, BIN }..... ○
 +, - }..... ○
 >, <, = ●

Note that when programming is performed by use of PU or GPP with a legend plate which does not indicate "DATE" as shown below, the S and D combinations of data instructions are the same as those of K0J1 and K0J1H.



- (*2) Four instructions, i.e. addition, subtraction, multiplication and division of BCD six digits, have been added to the application instructions of K0J2 and K0J2P.
- (*3) The sequence instruction execution time of K0J1H and K0J2 is 5.6 μS/step for the E32 and E56 extension units and 7.0 μS/step for the K65BN and K68BN extension bases.

1.2 Comparison of System Configurations

Number of I/O Points	Basic and Extension Units and I/O Numbers	
<p>1</p> <p>Input: 32 points</p> <p>Output: 24 points</p> <p>Total: 56 points</p>	<p>Basic unit</p>	
<p>2</p> <p>(Maximum number of points)</p> <p>Input: 64 points</p> <p>Output: 48 points</p> <p>Total: 112 points</p>	<p>Extension cable</p> <p>Extension switch</p> <p>*1 Extension adaptor: K0J1, K0J1H-K0J1-EX1 K0J2-K0J2-EX1 K0J2P-Not required</p> <p>K0J1-E32: 32-point extension unit <i>Note: Number for E56 is shown in parenthesis.</i> K0J1-E56: K0J2-E56 } 56-point extension unit Extension cable K0J-61CBL - 0.5 m (provided on extension unit) K0J-61CBL2 - 1 m</p>	
<p>3</p> <p>(Maximum number of points)</p> <p>Input: 96 points</p> <p>Output: 72 points</p> <p>Total: 168 points</p>	<p><i>Note: Number for E56 is shown in parenthesis.</i></p>	
<p>4</p> <p>(Maximum number of points)</p> <p>Input: 128 points</p> <p>Output: 96 points</p> <p>Total: 224 points</p>	<p><i>Note 1: Number for E56 is shown in parenthesis.</i> <i>Note 2: Cannot be used as remote I/O channel of optical data link.</i></p>	
<p>5</p> <p>(Maximum number of points)</p> <p>Input: 128 points</p> <p>Output: 96 points</p> <p>Total: 224 points</p>	<p><i>Note: Number for E56 is shown in parenthesis.</i></p>	
<p>6</p> <p>Input: 128 points</p> <p>Output: 96 points</p> <p>Total: 224 points</p>		
<p>7</p> <p>Input: 160 points</p> <p>Output: 120 points</p> <p>Total: 280 points</p>		
<p>8</p> <p>Input: 32+16n points</p> <p>Output: 24+16n points (m+n = 8)</p> <p>Total: 184 points</p>	<p>Extension cable</p> <p>K65BN } Extension base commonly used for K1 ~ K3 K68BN }</p> <p>Extension cable for K65BN/K68BN { K0J-62CBC ... 0.5m K0J-62CBL2 ... 1m</p> <p>Extension adaptor (*2) { K0J1, K0J1H.....K0J1-EX2 K0J2K0J2-EX2</p>	

IMPORTANT

In extension systems 4 and 5 in above table, the setting of extension switches and the allotment of I/O numbers differ depending on extension order. Therefore caution should be exercised.

2. PROCESS TIME

(unit : μ s)

Instruction	Condition	Process time	Instruction	Condition	Process time			
LD	X, Y	30	MC	—	75			
	M, T, C, F	30	MCR	—	65			
LDI	X, Y	30	SET	Y	Non execution	30		
	M, T, C, F	30			Execution	45		
AND	X, Y	30		M	Non execution	30		
	M, T, C, F	30			Execution	50		
ANI	X, Y	30		F	Non execution	25		
	M, T, C, F	30			Execution	95		
OR	X, Y	30	RST	Y	Non execution	30		
	M, T, C, F	30			Execution	45		
ORI	X, Y	30		M, F	Non execution	25		
	M, T, C, F	30			Execution	50		
ANB	—	30		C	Non execution	30		
ORB	—	30			Execution	45		
OUT	Y	120	SFT	M	Non execution	30		
		M			30	Execution	45	
	T	Non execution *1		CJ	K	Non execution	25	
		Execution *2	Before time-up			50	Execution	65
			After time-up	35	PLS	M	Non execution	35
			Per 0.1 second	K			85	Execution
				D	65	NOP	—	20
		C	Non execution		END	—	110	
	Execution		Non-count		Note 1: *1 Non execution means that arithmetic operation condition is off.	 (When X1 is off)		
			After count-up				35	
			Count	K	110			
				D	110			
F	Non execution		Note 2: *2 Execution means that arithmetic operation condition is on.	 (When X1 is on)				
	Execution				270			

(Unit: μ s)

	S	D						
		K	D	T	C	X	Y	M
Process Time of MOV Instruction	K	—	133	133	133	—	199	189
	D	—	133	133	133	—	199	189
	T	—	133	133	133	—	199	189
	C	—	133	133	133	—	199	189
	X	—	292	292	292	—	357	347
	Y	—	282	292	269	—	337	327
	M	—	282	292	269	—	337	327
Process Time of > Instruction	K	165	165	165	165	277	265	260
	D	165	165	165	165	277	265	260
	T	165	165	165	165	277	265	260
	C	165	165	165	165	277	265	260
	X	322	322	322	322	437	420	417
	Y	340	340	340	340	407	397	392
	M	340	340	340	340	407	397	392
Process Time of = Instruction	K	160	160	160	160	275	262	255
	D	160	160	160	160	275	262	255
	T	160	160	160	160	275	262	255
	C	160	160	160	160	275	262	255
	X	317	317	317	317	427	417	407
	Y	297	297	297	297	410	397	392
	M	297	297	297	297	410	397	392
Process Time of + Instruction	K	—	167	167	167	—	347	332
	D	—	167	167	167	—	347	332
	T	—	167	167	167	—	347	332
	C	—	167	167	167	—	347	332
	X	—	327	327	327	—	507	487
	Y	—	305	305	305	—	487	467
	M	—	305	305	305	—	487	467

Note 1: The process time of each data instruction shown in the tables is the time required when the instruction is executed. When the instruction is not executed, process time is 30 μ s.

Note 2: The process time of X, Y and M is the time required when four digits are specified.

9

(Unit: μ s)

	$\begin{matrix} & D \\ S & \end{matrix}$	K	D	T	C	X	Y	M
Process Time of - Instruction	K	-	215	230	230	-	695	640
	D	-	235	230	230	-	710	660
	T	-	230	230	230	-	710	660
	C	-	230	230	230	-	710	660
	X	-	480	480	480	-	800	750
	Y	-	440	430	440	-	790	740
	M	-	430	430	430	-	790	740
Process Time of < Instruction	K	165	165	165	165	277	267	260
	D	165	165	165	165	277	267	260
	T	165	165	165	165	277	267	260
	C	165	165	165	165	277	267	260
	X	365	365	365	365	467	424	417
	Y	345	345	345	345	445	402	397
	M	345	345	345	345	445	402	397
Process Time of BIN Instruction	K	-	302	302	302	-	435	372
	D	-	302	302	302	-	435	372
	T	-	302	302	302	-	435	372
	C	-	302	302	302	-	435	372
	X	-	457	457	457	-	547	537
	Y	-	437	457	437	-	527	517
	M	-	437	437	437	-	527	517
Process Time of BCD Instruction	K	-	617	617	617	-	710	697
	D	-	204	204	204	-	295	275
	T	-	287	287	287	-	377	367
	C	-	249	249	249	-	340	327
	X	-	467	467	467	-	557	547
	Y	-	337	337	337	-	430	417
	M	-	337	337	337	-	430	417

Note 1: The process time of each data instruction shown in the tables is the time required when the instruction is executed. When the instruction is not executed, process time is 30 μ s.

Note 2: The process time of X, Y and M is the time required when four digits are specified.

9

Application Instruction

(Unit: μ s)

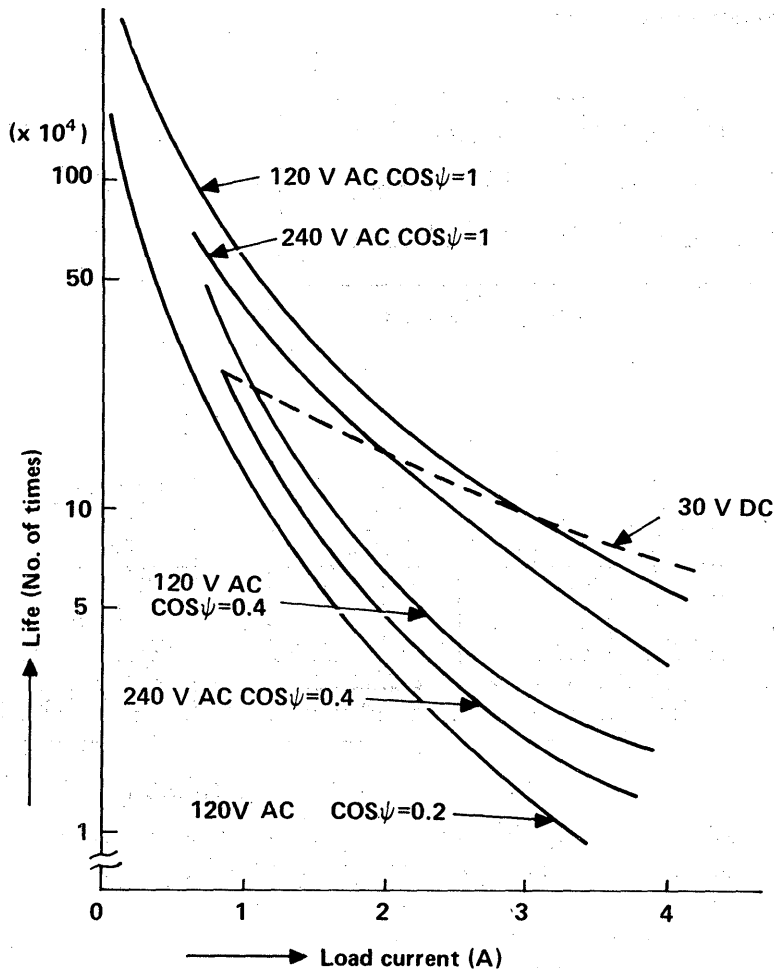
Instruction	Condition		Process Time	Instruction	Condition	Process Time
OUT F100			100	OUT F113		160
OUT F101	6 digits + 6 digits		273	OUT F114	10 bits 100 bits 200 bits	250 1120 2160
OUT F102	6 digits - 6 digits		2258	OUT F115	5 data 10 data 50 data	240 320 960
OUT F103	6 digits X 6 digits		2518	OUT F116	10 data 30 data 90 data	300 520 1220
OUT F104	6 digits \div 6 digits		2778	OUT F117		207
				OUT F118		208
OUT F108	4 \leftrightarrow 16	Decode	250	OUT F119		308
		Encode	310			
OUT F109			280			
OUT F110			130			
OUT F111			150			
OUT F112			160			

Note: The above process time is the time required when the instruction is executed. When the instruction is not executed, process time is 30 μ s.

9

3. CONTACT LIFE OF RELAY CONTACT OUTPUT

The following chart shows the life curve of output relay used for Type DR and AR. If a high-capacity DC load is driven by relay contact, the contact will be extremely worn and its life will be shortened.



Contact life curve

4. USAGE OF EXTERNAL FAILURE MONITOR UNIT (K0J1-EX0N)

4.1 General Description

The external failure monitor unit (K0J1-EX0N) is loaded into the K0J2P 56-point extension unit (Type K0J1-E56) located in the last stage of extension units, and has interface with the basic unit and also the output function of failure display.

The K0J1-EX0N outputs display signals for displaying the failure type of external equipment (such as limit switch and solenoid) and the failure number as shown in Fig. 1. It is required for the user to program the failure detecting circuit.

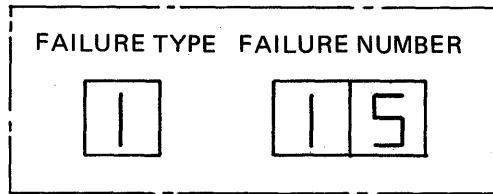
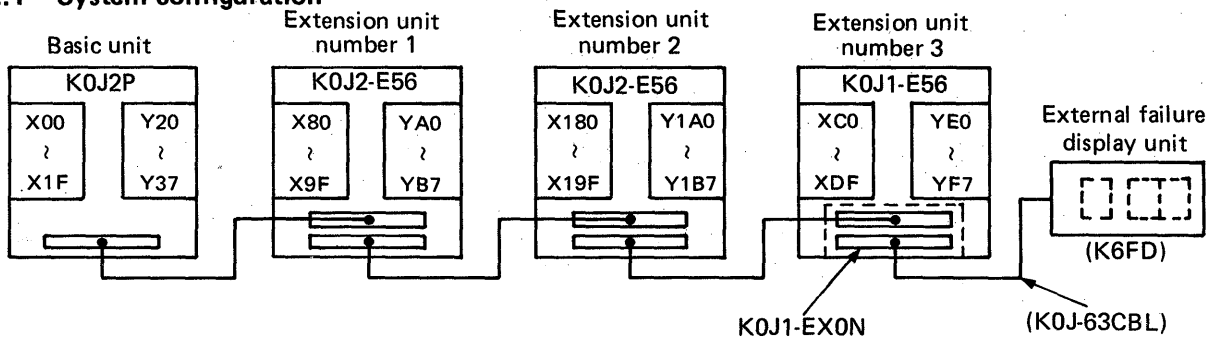


Fig. 1 Example of Display Unit

4.2 Specifications

4.2.1 System configuration



The K0J1-EX0N is loaded into the 56-point extension unit. As shown above, the upper connector is connected to the extension unit number 2 and the lower connector is connected to the external failure display unit.

For the system configuration to which the external failure monitor unit can be loaded, see Section 4 "SYSTEM CONFIGURATION" in page .

4.2.2 Output signals and number of signals

(1) Failure number:	BCD two digits	4 signals x 2 = 8 signals
(2) Failure type:	BCD one digit	4 signals x 1 = 4 signals
(3) Blanking signal:	One point	1 signal
(4) Common wire (— side of 24VDC):		14 signals
Total:		27 signals

9

4.2.3 Output signal specifications

Item	Specifications
Insulation system	Photocoupler
Output form	Transistor, open collector output ("L" level of signal is 2V or lower (at rated load).)
Rated load voltage	24VDC
Maximum load current	0.1A

4.2.4 Input signals and number of signals

(1) Reset signal:	1 signal
(2) Common wire (+ side of 24VDC):	2 signal
Total:	3 signals

4.2.5 I/O signal specifications

Item	Specifications
Insulation system	Photocoupler
Rated input voltage	12/24VDC
Rated input current	10mA

4.2.6 Type K6FD failure display unit

- (1) The types of failures should be 1 ~ 9 and the failure type "0" cannot be used.
- (2) Use active "LOW" for the failure display unit. The failure display unit should be blanked (turned off) when the failure type is "0" and the failure number is "00".
The blanking signal can be used to blank the display unit.
When there is no failure, the blanking signal can be used by switching it to either "L" or "H" by the chip switch in the substrate.

4.3 Failure Output Circuit Example

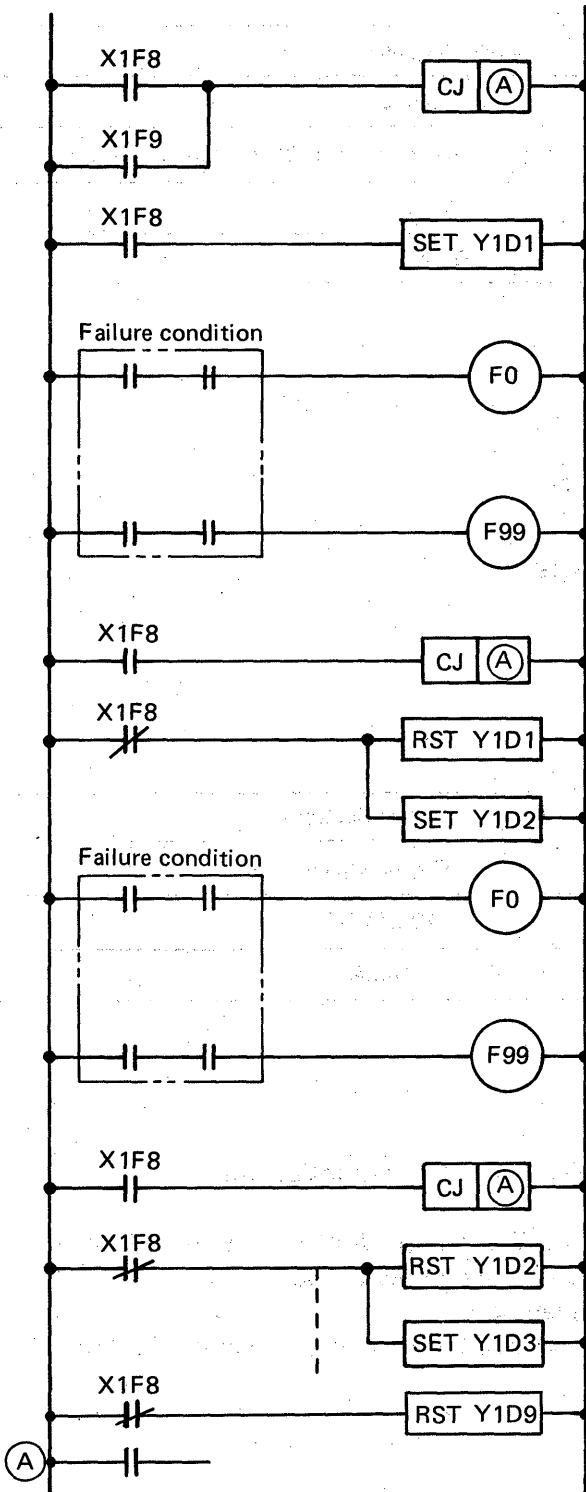


Fig. 2 Failure Output Circuit Example

Note:

1. X1F8 is a fixed number. This signal turns on when either failure occurs.
2. (A) is a jump destination step number. Set a step number which is located next to the failure output circuit.
3. Y1D1 ~ Y1D9 are fixed numbers and indicate failure types.
4. X1F9 is a fixed number and turns on when a reset signal is input.
When inputting the reset signal, be sure to insert it into the circuit as shown in the example of Fig. 2.

9



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